Manual No.: M501-E332 Revision : First Edition

X-RAY HIGH-VOLTAGE GENERATOR FOR DIAGNOSES (X) UD150B-30 / L-30 TECHNICAL DOCUMENT DESCRIBES

SHIMADZU CORPORATION

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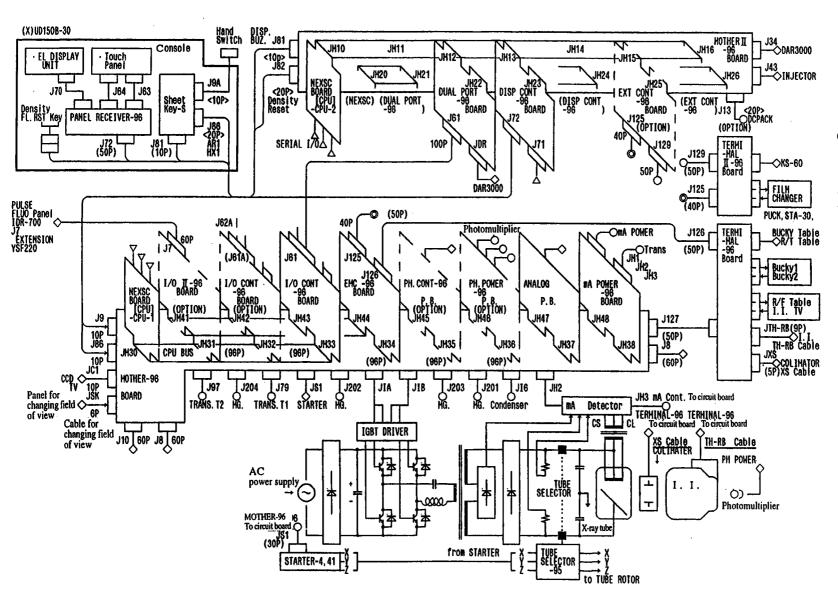
1. Introduction

This technical document describes an X-ray high-voltage generator for diagnoses (X) UD150B-30 / L-30. Use this document to help understand the performance of the generator and assist repair works in case of failure of the generator.

Also, refer to relevant documents such as connection diagrams, installation manual, photo-timer installation manual, and photo-timer technical descriptions as well.

Outline of circuit board configuration

Schematic diagram of (X) UD150B-30 / L-30 is shown below.



1

2.2 Outline of circuit board functions

- (1) Circuit boards in control cabinet
 - (a) Control circuit boards connected with MOTHER-96

Board	Functions Remark	
MOTHER-96	O Charging voltage detection	
board	O Supply voltage detection, power ON/OFF, and 24-V supply for	
	relays	
	O Control of each magnet in main circuit	
NEXSC board	O Memory of operation method, X-ray tube No., radiographic	
(BASE)	method, focusing, radiographic conditions, fluoroscopic condi-	
	tions, etc.	
	Memory communication with extended NEXSC board	
	O Overload estimation, and HU calculation	
	Fluoroscopic and radiographic timer count	
	O Signal input/output condition control for radiography, operation	
	method, and faults	
I/O CONT-96	O Set signal output of operation method, X-ray tube No., radi-	
· board	ographic method, focusing, radiographic conditions (RkV, RmA,	
	FVR), fluoroscopic conditions (FkV, FVF), etc.	
	O Iris value signal output	
	O Radiography timer	
	O RS422 I/F circuit with DUAL PORT RAM board	
EMC-96 board	X-ray radiation control for radiography	
	General radiography GR	
	BUCKY radiography BUCKY1, BUCKY2	
	Tomography PLANI	
	Auto-changer radiography OX	
	Spot filming FSP	
	• I.I. indirect spot filming IFG, CRS	
	Film changer radiography SER	
	• DSA DSP	
	Radiography backup timer	
	O X-ray radiation control for fluoroscopy (including pulsed fluo-	
	roscopy)	
}	○ I.I. field-of-view control	
	O Lower extremity step control	
	O 3-tube system processing	

Board	Functions	Remark
ANALOG-96	O Tube voltage control	
board	(1) Set tube voltage input	
	(2) Measured tube voltage input	
	(3) Fluoroscopic tube voltage control	
	(4) Radiographic tube voltage control	
	(5) Tube voltage measurement	
	○ IBS control	
	Abnormality detection circuit	
	• Reset circuit (for resetting at power ON)	Kut - Grasuma Tube Village
	○ "KVT" detection	1 who betrage
mA POWER-96	O Power circuit	
board	(1) Power supply and smoothing circuit	
	(2) Inverter circuit	
	(3) Focus switching circuit	
	O Filament heater control	
	(1) Filament current setting circuit	
	(2) Filament current measuring circuit	
	(3) Heater confirmation circuit	
	(4) Abnormality detection circuit	
	(5) Reset circuit (for resetting at power ON)	
	Fluoroscopic tube current control	
	O Tube current measurement	
	Over current protection	
	O Tube current drop compensation	
TERMINAL-96	O Interfaces with externally connected devices (Relays, etc.)	
board	BUCKY radiography BUCKY1, BUCKY2	
	Tomography PLANI	
	Auto-changer radiography OX	
	• Spot filming FSP	
	I.I. indirect spot filming IFG, CRS I.I. field of view circul input/output (connectors)	
	O I.I. field-of-view signal input/output (connectors) O 3 tube system signal output	
I/O II-96 board	3-tube system signal output Operation method, and APP signal input/output (18 finterlocked)	
1	Operation method, and APR signal input/output (J8 [interlocked	
[Option]	with fluoroscopic bed]) O Interfacing with YSF220 (J7)	
	EEPROM (32 kbyte) extension (currently unused)	
	Pulse-related signal outputs	
	CINE backup timer (currently unused)	
	CINE-related signal outputs (currently unused)	
		<u> </u>

Board	Functions	Remark
I/O CONT-96	O Signal output for setting a high voltage for photomultiplier (PH-	
board	HVS)	
[Option]		
PH CONT-96	O Photo-receptor selective circuit and photo-pickup selective circuit	
board	Current-voltage conversion circuit for photomultiplier signal	
[Option]	Integrating circuit for photomultiplier signal	
	Reference voltage comparator circuit for photomultiplier signal	
	O Cutoff signal generating circuit	
	Reference voltage generating circuit	
PH POWER-96	O High voltage generating circuit for photomultiplier	
board	O Photo-receptor selective circuit	
[Option]	Integrating circuit and comparator cutoff circuit	
	Reference voltage generating circuit and reference voltage switch-	
ing circuit		
	Compensation circuit for contrast medium covering ratio	
	O Pulsed fluoroscopy IBS circuit	

(b) Control boards connected with MOTHER II-96

Board	Functions	Remark
MOTHER II-96	O Whereas connectors for various devices are mounted, no circuits	
board	are installed.	
NEXSC board	○ Memory communication with basic NEXSC board (CPU-1)	
(EXT)	O EL display control (for DISPCONT-96 board as well)	
	O Touch-panel reading control (for DISPCONT-96 board as well)	
O Reading of density knob position on X table and fluoroscop		
	timer reset key status (for DUAL PORT-96 board as well)	
	O Buzzer sound for sheet-key-small, and Ready and X-ray display	
	(for DUAL PORT-96 board as well)	;
	Communication with DAR300 (JDA connector)	·

Board	Functions	Remark
DUAL PORT-96	O Memory communication between basic NEXSC board (CPU-1)	4%
board	and extended NEXSC board through J61 cable of I/O CNT-96	(Chymen catio
	 Memory communication between basic NEXSC board (CPU-1) and extended NEXSC board through J61 cable of I/O CNT-96 board 	Firet
	O Communication between extended NEXSC board (CPU-2) and	
	DAR300 (JDA)	
	• Reading of density knob position on X table and fluoroscopy	
	timer reset key status, and display of the fluoroscopy timer reset	
1	key through J82 cable of MOTHER II -96	
	O Buzzer sound for sheet-key-small, and Ready and X-ray display	
	through J81 cable of MOTHER II-96 board	
	O A following optional function is available when added to JM11	
	and 21 side.	
	Memory communication between extended NEXSC board	
	(CPU-2) and optional NEXSC board (CPU-3) (added to JM20)	
	through MOTHER II -96 board	
DISP CONT-96	O EL display control through PANEL RECEIVER-96 board and	
board	panel signal cable [RS422 I/F] (for NEXSC board as well)	
	O Touch panel reading control through PANEL RECEIVER-96	
	board and panel signal cable [RS232C] (for NEXSC board as	
	well)	
EXT CONT-96	 X-ray radiation control function in accordance with DAR3000 	To J38, J41, J42,
board	O Connection to film changer [PUCK, and others]	J43 through J34 of
[Option]	Connection to stereo controller [STA-30]	MOTHER II-96
	O Connection to injector [MARK V, and others]	
	O Connection to examination table [KS-60]	
TERMINAL II-96	O Interface with externally connected devices (relays, etc.)	Through J41, J42,
board	Film changer	J34
Option] • Stereo controller [STA-30]		
	• DAR-1200]
	Old CINE carneras [Contact point output of each X-ray radia-	
	tion timing]	
	Connection to examination table [KS-60]	

(2) Circuit boards in console

Board	Functions	Remark	
PANEL	O Relays EL display control signals from DISP CONT-96 to EL dis-	[422 I/F circuit]	
RECEIVER-96	play unit.	J72, J70, [RS232C	
board	O Relays touch panel control signals to DISP CONT-96, and	signal line] J72,	
	NEXSC (EXT).	J63, J64	
SHEET KEY	O Buzzer (according to control signals from DUAL PORT-96 board)	J81	
SMALL	 Ready, and X-ray switch display (same as above) 	J81	
board	Relaying of hand switches		

2.3 Brief description of software

2.3.1 Functions

- (1) Outline of software processing in the basic NEXSC board (CPU-1)

 Software processing in the basic NEXSC board (CPU-1) is as follows.
 - (a) Memory communication with the extended NEXSC board (CPU-2) (I/O CONT-96 board)
 - (b) HU calculation and X-ray prohibition in excessive HU value (*LOVE, *NOX) (I/O CONT-96 board)
 - (c) Time counter and cutoff signal output for fluoroscopy (*FOVE) (I/O CONT-96 board)
 - (d) Overload check of radiography condition and radiography prohibition in overload (I/O CONT-96 board)
 - (e) Signal input/output of radiography, operation method, and faults (I/O CONT-96 board)
 - (f) Signal input/output on J7 EXTENTION board and PULSE I/F-94 board (I/O II-96 board)
 - (g) Timer count setting according to radiography time setting (Subtraction and cutoff signal output (*SOF) are controlled by hardware timer IC.) (I/O CONT-96 board)
 - (h) Reading of measured time for taking radiography (I/O CONT-96 board)
 - (i) Analog outputs (RkV, RmA, FVR, LMT, FkV, FVF, IRIS, Photo-s, Photo-s [high-vol.])

In ordinary fluoroscopy, the real FVF is determined by a feedback control to the tube current corresponding to a measured tube voltage in reference to a FVF value derived from the filament heater output at the start of fluoroscopy. In pulsed fluoroscopy, FVF value is output in accordance with a measured tube voltage during fluoroscopic operation. IRIS and Photo-s [high-vol.] are switched for either fluoroscopy or radiography according to KC signal input. (I/O CONT-96 board)

Photo-s [high-vol.] (I/O CONT-96 option board)

(j) Reading analog values (PkV, TmA)

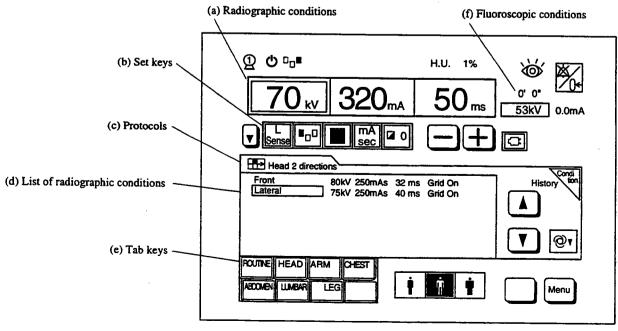
PkV is read as a measured FkV value during fluoroscopy and as a measured RkV value during radiography.

TmA is read as a measured FmA value during fluoroscopy and as a measured RmA value during radiography.

- (2) Outline of software processing in the extended NEXSC board (CPU-2) Software processing in the extended NEXSC board (CPU-2) is as follows.
 - (a) Memory communication with the basic NEXSC board (CPU-1) (DUAL PORT-96 board)
 - (b) EL display (DISP CONT-96 board)
 - (c) Reading touch panel output (DISP CONT-96 board, NEXSC board)
 - (d) Reading a position of the density adjusting knob on the X table and a status of the fluoroscopy timer reset key (DUAL PORT-96 board)
 - (e) Buzzer sound for sheet-key-small, and display of Ready and X-ray (DUAL PORT-96 board)
 - (f) Communication with DAR3000 (DUAL PORT-96 board)

2.3.2 Reference data on software

NEXSC. BASE NEXSC. EXT S-RAM - S-RAM Radiographic conditions currently Radiographic conditions currently set • Information on input and output Information on input and output signals signals Information on various initial settings - EE-PROM -- EE-PROM -Radiographic conditions on each APR • Radiographic conditions on each Information on various initial settings **APR** Information on various adjusting modes Data for calculation on tubes Data for each memory shot



(a) Radiographic conditions

The radiographic condition data are stored in each S-RAM in the basic NEXSC board (CPU-1) and extended NEXSC board (CPU-2).

CPU-1 Sets analog outputs and timer count values according to the data.

CPU-2 Shows the radiographic conditions on EL display.

(b) Set keys

The set key data are stored in each S-RAM in the basic NEXSC board (CPU-1) and extended NEXSC board (CPU-2).

CPU-1 Outputs data signals and analog signals according to the data.

CPU-2 Shows the set keys on EL display.

(c) Protocols

The data on operation method are stored in each EE-PROM of CPU-1 and CPU-2.

CPU-1 Outputs data signals and analog signals according to the data.

CPU-2 Shows the protocols on EL display.

The character string data of "Head 2 directions" are stored in the EE-PROM of CPU-2 and shown on EL display.

(d) List of radiographic conditions

The number of steps in each protocol (c) is stored in each EE-PROM of CPU-1 and CPU-2.

The character string data of "Front", "Lateral", and "Grid ON" are stored in the EE-PROM of CPU-2 and shown on EL display.

The data of radiographic conditions such as RkV and RmA are stored in the EE-PROM of CPU-1. When a protocol is selected, the data are read from the EE-PROM of CPU-1 and written in each S-RAM of CPU-1 and DPU-2. CPU-2 displays the data list. The radiographic conditions are changed in the S-RAM.

(e) Tab keys

The character string data of "Head, etc." are stored in the EE-PROM of CPU-2 and shown on EL display.

(f) Fluoroscopic conditions

The fluoroscopic condition data are stored in each S-RAM of CPU-1 and CPU-2.

CPU-1 Outputs analog signals and calculates fluoroscopy time according to the data.

CPU-2 Shows the fluoroscopic conditions on EL display.

2.3.3 Examples of the software operation

- Example 1) Changing a radiographic condition (when selecting RkV and pressing "+" key.)
- (1) The data flow on RS232C from the touch panel to the extended NXSC board (CPU-2) through the panel receiver, J71 cable, and DISP CONT-96 board. The CPU-2 reads by interruption handling which portion of the touch panel (coordinate) has been depressed.
- (2) The CPU-2 increases a current set RkV value by 1, writes the increased value in a calculation data area, and sends it to CPU-1 through the memory communication.
- (3) The CPU-1 receives the data and checks whether the radiographic condition is an overload or not.
- (4) If the condition is an overload, the CPU-1 terminates the data processing. If not, the CPU-1 copies the received data onto the previous data as a new radiographic condition.
- (5) The CPU-1 outputs analog signals and sets timer count values according to the new radiographic condition.
- (6) The CPU-1 sends the new radiographic condition to the CPU-2 through the memory communication.
- (7) The CPU-2 copies the received photographic condition data onto the previous data.
- (8) The CPU-2 displays the newly set radiographic condition.

Example 2) Selecting a protocol (when selecting a protocol from protocol list.)

- (1) The data flow on RS232C from the touch panel to the extended NXSC board (CPU-2) through the panel receiver, J71 cable, and DISP CONT-96 board. The CPU-2 reads by interruption handling which portion of the touch panel (coordinate) has been depressed.
- (2) The CPU-2 selects the new protocol and changes the display to a list of radiographic conditions.
- (3) The CPU-2 reads from the EE-PROM and displays a operation method, title, body orientation, and remarks of the newly selected protocol.
- (4) The CPU-2 sends the new protocol to the CPU-1 through the memory communication.
- (5) The CPU-1 reads the list of the new radiographic conditions from the EE-

PROM according to the received new protocol and copies the new conditions onto the previously set conditions.

- (6) According to the new radiographic conditions, the CPU-1 checks an overload, outputs analog data, sets timer count values, and outputs necessary data signals.
- (7) The CPU-1 sends the new radiographic conditions and the overload information to the CPU-2 through the memory communication.
- (8) The CPU-2 copies the received radiographic condition data onto the previously set data.
- (9) The CPU-2 displays the newly set radiographic conditions and the overload information.

2.3.4 Protection for X-ray tube rating

In (X) UD150B-30/L-30, a microcomputer determines whether set radiographic conditions are overloads or not. In case of an overload, the computer comes to OVER, thus protecting the generator. The determination depends on two large factors, a short-time rating and device rating of X-ray tube. The permissible loads for the short-time rating differ in setting methods of radiographic conditions, a 2-control method (kV, mAs) and 3-control method (kV, mAs, sec).

(1) 2-control method

(a) The short-time rating of X-ray tube is generally shown in Fig. 2.4.1. This is the 100% rating. By eliminating the parameter of kV, this figure can be modified to Fig. 2.4.2 where a single curve is shown with a vertical axis of kW. The figure means that a permissible power is determined with a given exposure time.

Fig.2.4.2 can be further modified to Fig.2.4.3 that has a vertical axis of kWs. Multiplying a sec by the corresponding kW in Fig.2.4.2 derives this figure.

(b) In 2-control method, when a radiographic condition is given by kVo and

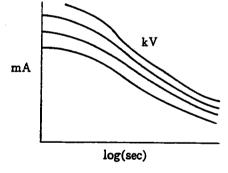


Fig. 2.4.1

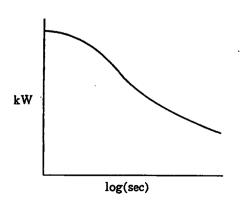
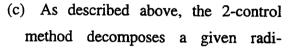


Fig. 2.4.2

mAso, the product of the two gives kWso. The sec0 corresponding to the kWso on the vertical axis in Fig. 2.4.3 means the permissible shortest radiographic exposure time for a given kVo \times mAso (= kWso). Further, dividing the given mAso by the sec0 gives mAso / sec0 = mA0, which is the maximum permissible tube current.



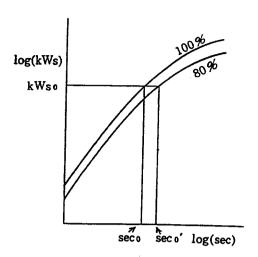


Fig. 2.4.3

- ographic condition (kV, mAs) into the maximum permissible tube current and the shortest radiographic time. Any combination of kV and mAs hold the same relation as described above and a tube is always used under a constant load factor. In the above example the load factor is assumed to be always 100%. In actual cases, an operation method specifies its load factor. For example, if the specified load factor is 80%, the derived time is sec'0 as shown in Fig.2.4.3, which is longer than that for the load factor of 100%.
- (d) In the 2-control method, the X-ray tube rating is stored in the form of Fig.2.4.3 and decomposed into the shortest time sec and the maximum current mA in considering the specified load factor.

(2) 3-control method

In the 3-control method, the short-time rating of X-ray tube is also stored in the same form of Fig.2.4.3 as in the 2-control method. A product of three values for a specified radiographic condition, kVo, mA0, and sec0, gives a value kWso, and the kWso derives the shortest radiographic time sec1 from Fig.2.4.3. If the derived time sec1 is shorter than the specified time sec0, the radiographic operation is possible under the specified condition. That is:

if sec0≥ sec1, the operation is possible, and

if sec0 = sec1, this means an overload for the tube.

2.3.5 Protection for a emission characteristics

When a tube voltage is low, an emission from the filament of the X-ray tube will be insufficient, and a large current will not be able to flow.

This characteristic is shown in Fig.2.4.4. When a current that exceeds the curve is set for a given tube voltage, the radiographic operation is made OVER (3-control

method). Or, a tube current that does not exceed the curve in Fig.2.4.4 is automatically set for a given tube voltage (2-control method).

2.3.6 Amount of heat accumulated on anode

(1) Unit of loaded heat amount "HU"

An amount of heat that is generated when a load is applied to an X-ray tube is proportional to a tube voltage [kV] × tube

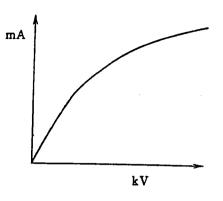


Fig. 2.4.4

current [mA] × loaded time [sec]. It is convenient for the X-ray tube to take the value as a unit of loaded heat amount. The unit is HU, which is defined as follows:

$$HU = 1.41 \times kV \times mA \times sec$$

$$HU/S = 1.41 \times kV \times mA$$

(2) Amount of heat accumulated on anode

For example, the amount of heat that is accumulated on anode when a fluoroscopic photograph is taken for a condition, 80 kV, 420 mA, and 1.4 sec, is:

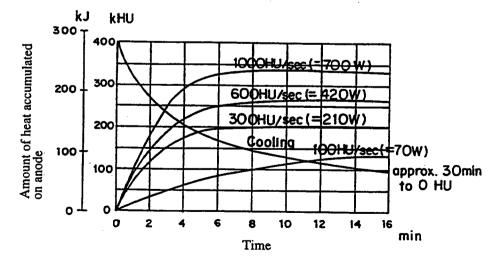
$$1.41 \times 80 \times 420 \times 1.4 = 66326$$
 [HU].

That is, an about 66 kHU is accumulated.

(3) Cooling diagram

This shows a cooling diagram for a heat of 400 kHU in P-type CIRCLEX.

Accumulated heat in terms of load parameter



In computation of heat accumulation in a fluoroscopic or radiographic operation, the amount of heat dissipated according to the cooling curve in the figure is taken into account.

3. Main circuit

3.1 Outline of inverter circuit

3.1.1 Introduction

(X) UD150L-30/B-30 is an X-ray high-voltage generator, which uses an inverter of the same series resonance type as that used in conventional L/B-10 series. While using the same IGBT as a switching element, the operational frequency of the inverter is increased up to 50 kHz by improving the drive circuit and high voltage transformer for the inverter.

3.1.2 Features

The 50-kHz inverter has:

- (a) A small size and lightweight the high voltage transformer is stored in a cabinet,
- (b) Low operation noise,
- (c) A kV waveform corresponding to a constant voltage,
- (d) A constant kW from 80 kV to 150 kV, and
- (e) A high-frequency filament heater (20 kHz).

3.1.3 Series resonance type inverter

(X) UD150L-30/B-30 uses an inverter of the same series resonance type as that used in conventional L/B-10 series.

Because, the series resonance inverter can decrease the switching loss due to its sinusoidal current waveform, facilitate high frequency operation, and lower electromagnetic wave noise.

(1) Principle of operation of series resonance circuit

Fig.3.1.1 shows a circuit where a power source E, load R, inductance L, and capacitor C, are connected in series.

The impedance of the circuit seen by the source Z is

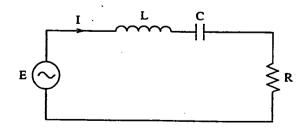


Fig. 3.1.1 LCR series resonance circuit

$$Z = R + j \left(\omega L - \frac{1}{\omega C}\right) \dots \qquad (1)$$

Its absolute value is

$$|Z| = \sqrt{R^2 + (\omega L - \frac{1}{\omega C})^2}$$
.....

When $\omega=\omega_0=\frac{1}{\sqrt{LC}}$, Z=R. Here, the impedance Z becomes its minimum value R and the maximum power is supplied to the load R.

The power dissipated in the resistor is

$$P = R |I|^{2}$$

$$= R \cdot (\frac{E}{|Z|})^{2}$$

$$= \frac{R \cdot E^{2}}{R^{2} + (\omega L - 1/\omega C)^{2}}$$
(3)

The equation 3 is graphed in Fig.3.1.2, where L and C are assumed to be a constant, and R is a parameter. It is understood from Fig.3.1.2 that varying the frequency ω enables control of the power dissipated in the load R.

This principle of operation is applied to the series resonance inverter of the X-ray high-voltage generator.

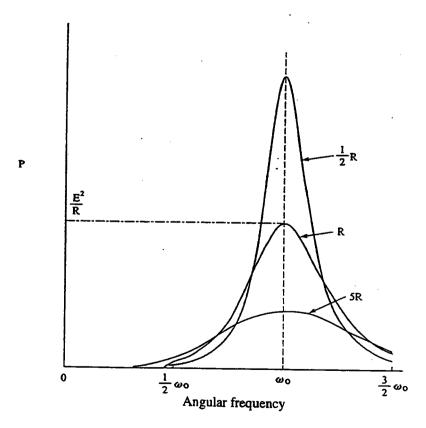


Fig. 3.1.2 Relation between power and frequency in series resonance circuit

(2) Circuit configuration of series resonance inverter

The main circuit configuration of the device is shown in Fig.3.1.3. The resonance circuit of Fig.3.1.1 is shown on the top in contrast to L and C of the main circuit.

In Fig.3.1.3 the circuit from the high voltage transformer to X-ray tube corresponds to the load R, and AC/DC converter and the full-bridge inverter correspond to the power source E.

As described in section (1), varying the frequency while keeping L and C fixed controls the output power. To vary the frequency, the oscillation frequency of the full bridge inverter is varied.

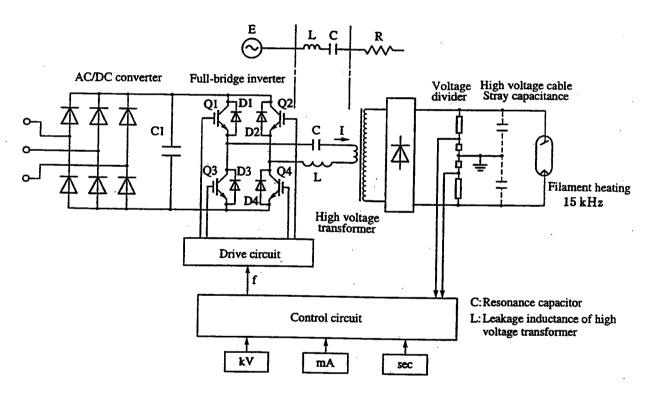


Fig. 3.1.3 Main circuit configuration

(a) Principle of operation

The three-phase or single-phase supply voltage is rectified by AC/DC converter and smoothed by C1. The smoothed DC voltage is constant.

When an X-ray exposure signal turns on IGBT Q1 and Q4, switching elements of the inverter, a current shown in Fig.3.1.4 ① flows through the resonance capacitor C, the primary winding of the high voltage transformer, and resonance inductance L. The current waveform is sinusoidal and the value is $\pi \sqrt{LC}$ for a period of to ~ t1. During the next period t1 ~ t2, the energy stored in

L and C is discharged through D1 and D4.

For a heavy load, the inverter frequency is increased, and while the discharge current is flowing through the diode D1 and D2, other IGBT Q2 and Q3 are turned on, so that the primary current has a continuous waveform.

Whereas the resonance frequency of this device is about 50 kHz, the maximum operational frequency is limited to about 45 kHz, taking a switch-off delay time of IGBT into account.

The tube voltage builds up in a frequency corresponding to the load condition. When the voltage reaches a value close to a set voltage (94%), the frequency is switched to another memorized value and after that controlled so that and the feedback value is equal to a set value.

This device does not use a high voltage capacitor in the secondary circuit, but uses only a stray capacity of the high voltage cable for smoothing the tube voltage supply.

For a light load

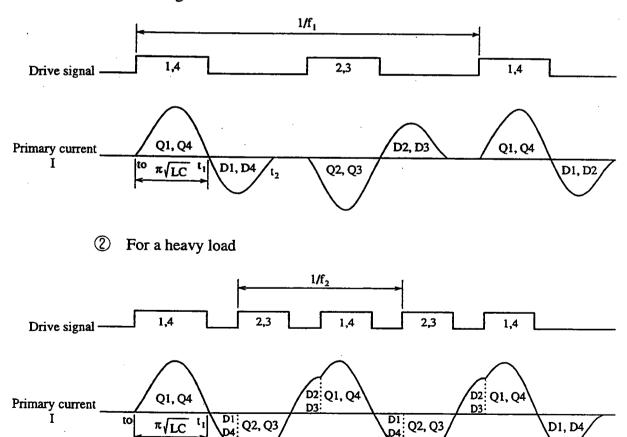


Fig. 3.1.4 Primary current for each load

(b) Performance characteristics

Fig. 3.1.5 shows examples of the tube voltage waveform. ① shows short-time characteristics and ② shows long-time characteristics for different tube currents.

The rise time of the voltage is $0.5 \sim 1$ msec, because the high voltage capacitor is not applied. The voltage is substantially constant with small ripple due to the high frequency operation.

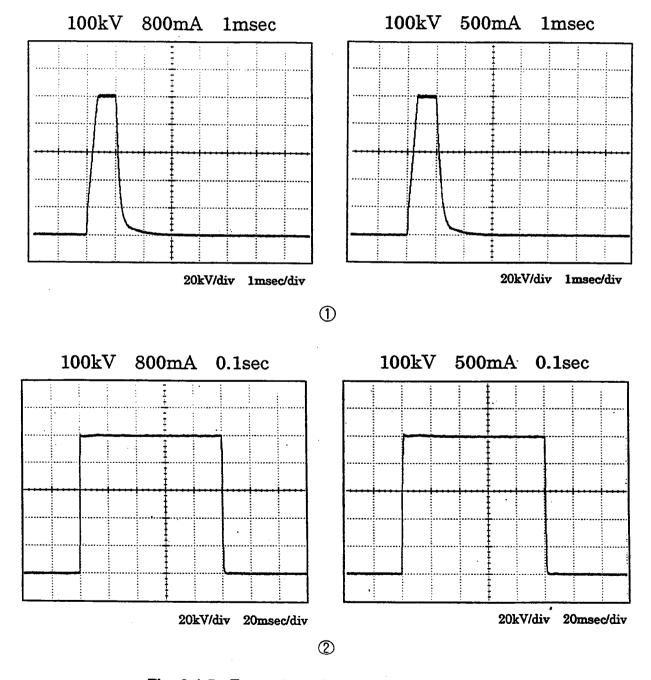


Fig. 3.1.5 Examples of tube voltage waveform

3.2 DC power circuit

(1) Rectifying and smoothing circuit

Refer to Table 3.2.1.

When the generator is turned on, a power is supplied to MGRS terminals 2, 4, 6 of the inverter unit (terminals 4, 6 for single phase power).

The power goes through resistors RSU, RSV, and RSW, and is full-wave rectified by a diode module and charges electrolytic capacitors C₁ ~ C₄. The charged voltage depends on the supply voltage as shown in Table 3.2.1.

 Supply voltage
 Voltage across electrolytic capacitor

 $3 \phi 380V \pm 10\%$ DC537 ± 54V

 $3 \phi 400V \pm 10\%$, $1 \phi 200V_{-}^{+} \frac{10\%}{5\%}$ DC566 ± 57V, DC566 $_{-}^{+} \frac{57V}{28V}$
 $3 \phi 415V \pm 10\%$ DC587 ± 59V

 $3 \phi 440V \pm 10\%$ DC622 ± 62V

 $3 \phi 480V \pm 10\%$, $1 \phi 240V \pm 10\%$ DC679 ± 68V

 $3 \phi 240V$, 220V, $20V \pm 10\%$ DC566 ± 57V

Table 3.2.1

Note) With a supply voltage 3 ϕ -240, 220, 200V, a voltage 3 ϕ -400V is supplied through an automatic transformer XAT-2.

A magnet switch MG-D becomes OPEN when power is turned ON. (Refer to section (3) for a detail.)

The resistors RSU, RSV, and RSW control the current charging electrolytic capacitors C₁ ~ C₄.

The charging time constant is (with 3 ϕ supply):

R =
$$10 \times 2 = 200 \text{ [ohm]}$$

C = $10 \times 2 \times \frac{1}{2} = 10 \text{ [mF]}$

time constant $CR = 20 \times 10 \times 10^{-3} = 0.2$ [sec].

Within about 1 second after power has been turned on, the magnet switch MG-RS will be switched ON and the resistors RSU, RSV, and RSW will be short-circuited.

(2) Discharging circuit for smoothing capacitor

After power is turned off for circuit inspection, electric charge may remain in the

smoothing capacitor. Because it is dangerous, this circuit discharges the remaining charge in the capacitor after power has been turned off.

Refer to Fig. 3.2.1.

When power is turned OFF, the magnet switch MG-D closes and the charges in the capacitor C₁ and C₂ are discharged through the resistor RD+.

The charges in the capacitor C₃ and C₄ are discharged through the resistor RD-.

The discharge time constant is:

$$CR = 10 \times 2 \times 10^{-3} \times 200 = 4 \text{ [sec]}$$

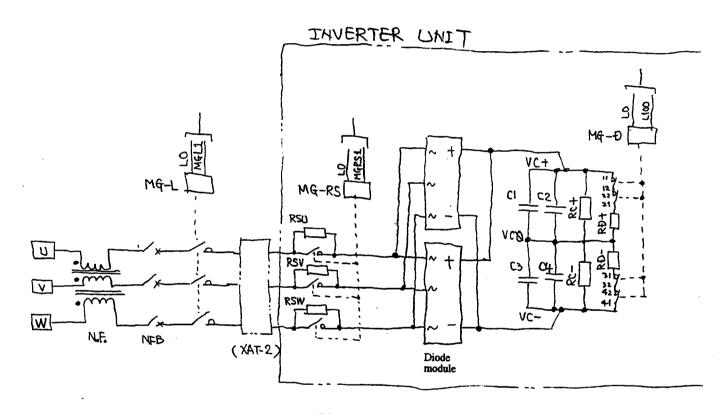


Fig. 3.2.1

(3) Charging voltage detection circuit

Refer to Fig. 3.2.2.

This circuit sends voltage signals that correspond to the charging voltages across C₁, C₂ and C₃, C₄ to ANALOG-96 board.

The voltage across capacitor C₁ and C₂ is supplied to terminal VC+ and VC0 on MOTHER-96 board and applied to the terminal 1, 2 of a photo-coupler M4 through resistors R₂₁, R₂₂, R₂₃, and LD₂. The output 3 of M4 enters the non-reversal input terminal of an operational amplifier A1. The output of A1 goes to a terminal VP₁ through the input terminal 1, 2 of a photo-coupler M10. The output 3 of M10 is fed back to the

reversal input terminal 2 of the operational amplifier A1.

The output current from VP₁, therefore, is proportional to the input voltage across the terminals VC+ and VC-. The two photo-couplers, M4 and M10, are selected as a pair to compensate their temperature dependent characteristics each other.

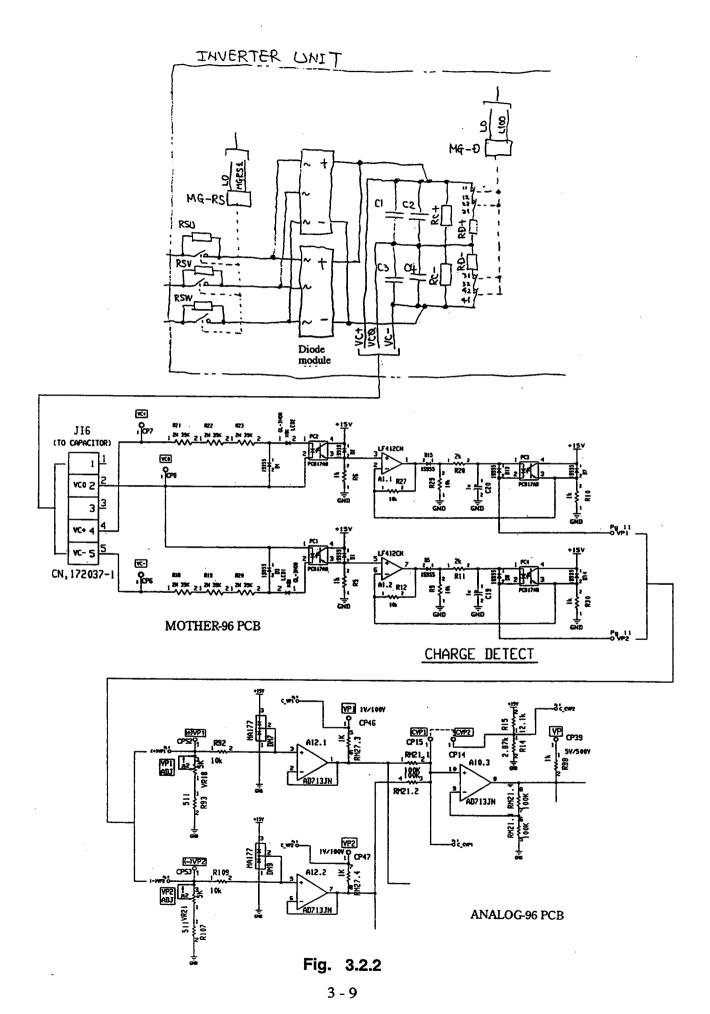
The input current to the terminal VP₁ on ANALOG-96 board produces a voltage across resistors VR₁₈ and R₉₃.

The voltage is output to a check terminal VP1 through a operational amplifier A12.

Similarly, a voltage that corresponds to the voltage across capacitors C₃, C₄ is generated at a check terminal VP₂.

At a check terminal VP, a voltage VP₁ + VP₂ is produced.

The output voltage from the terminal VP is input to a voltage control circuit for radiographic tube (refer to (4) in section 3. 4). The output voltages from VP₁ and VP₂ are input to a detection circuit of abnormal operation (refer to (1) in section 3.7).



3.3 Inverter circuit

(1) Oscillation circuit (ANALOG-96 board)

Refer to Fig. 3.3.1.

The oscillation circuit consists of a V/F converter M28 and a one-shot multivibrator M24.

When the radiographic operation is selected, the output signal from a voltage control circuit for radiographic tube (refer to (4) in section 3.4) is input to an input terminal 4 VIN of the V/F converter M28. When the fluoroscopic operation is selected, a voltage of about 2.9 V is input to VIN (refer to (3) in section 3.4).

The Relation between the input and output of M28 is determined in terms of the capacitor C connected between terminals 6 and 7 and the resistor between terminal 3 and GND by an equation,

$$F[Hz] = VIN[V] / 10 \times R[\Omega] \times C[F].$$

A variable resistor VF ADJ is adjusted so that 10V/109 kHz.

The output F of M 28 goes to the output terminal 10 of M 22 through M20, M21, and M22. The relation between the outputs of M28 and M22 is shown in Fig. 3.3.2. The table of truth value of M21 is shown in Fig. 3.3.2.

When the radiographic operation is selected, or READY is executed in the fluoroscopic operation, the input terminal of M23 becomes HIGH (except a case that LOW mA is selected and the tube current is lower than 50 mA). The signal from the output terminal 10 of M22 enters the terminal 12 of the one-shot multivibrator M24 through terminals 13 and 11 of M22, terminals 2 and 3 of M23, and terminals 5 and 4 of M13.

When fluoroscopic X-ray operation is executed, or LOW mA is selected, the signal from the output terminal 10 of M22 enters the terminal 12 of the one-shot multivibrator M24 through a voltage control circuit for fluoroscopic tube (refer to (3) in section 3.4), terminals 2 and 3 of M22, and terminals 5 and 4 of M13.

The output pulse width of M24 is adjusted by VR4 PULSE ADJ .

(2) Divider circuit (ANALOG-96 board)

Refer to Fig. 3.3.1.

An output signal from M24 in the oscillation circuit is divided by two pairs of flipflop of M11 and becomes an inverter drive signal.

The timing chart of the divider circuit is shown in Fig.3.3.4.

Fig. 3.3.3 shows the table of truth value of M11.

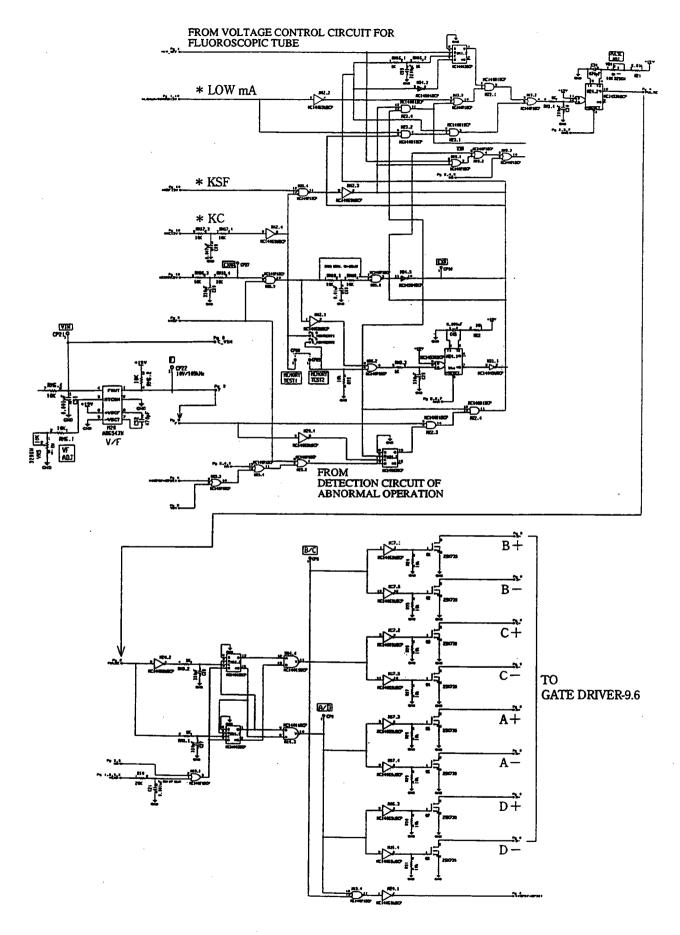


Fig. 3.3.1

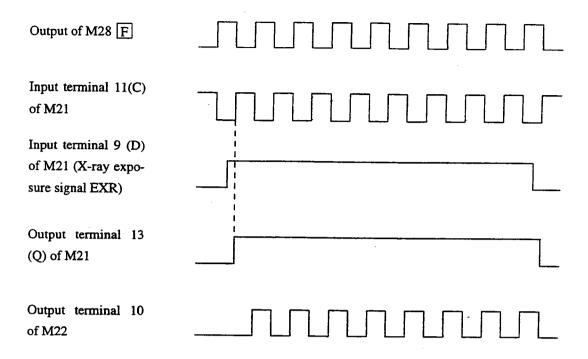


Fig. 3.3.2

TRUTH TABLE

IN PUTS				OUT	PUTS	
CLOCKt	DATA	RESET	SET	Q	Q	
	0	0	0	0	1	
	1	0	0	1	0	
	Х	0	0	Q	Q	NO Change
X	Х	1	0	0	1	Onlange
Х	х	0	1	1	0	
X	Х	1	1	1	1	

X = Don'tCare t = Level Change

MC14013 BP

Fig. 3.3.3

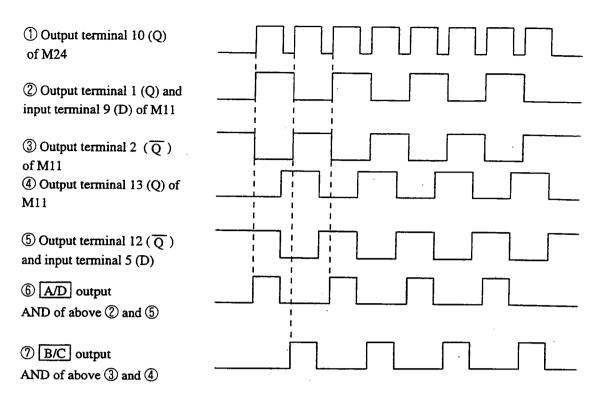


Fig. 3.3.4

(3) GATE DRIVER-96 board

Refer to Fig. 3.3.5.

GATE DRIVER-96 board receives the output signal from the divider circuit on ANALOG-96 board and supplies power to an IGBT gate.

In the inverter unit, a GATE DRIVER-96 board is mounted for each of four IGBT's and a circuit shown in Fig. 3.3.5 is included in the board.

GATE DRIVER-96 board uses two pulse transformers. One is used to drive the gate and the other is used to supply a negative bias for IGPT during its OFF period. These actions are described below about IGBT QA as an example.

The output from the oscillation circuit is supplied to A- (pin 1 of J1) and transformed by the transformer T2 and rectified by diodes D5 ~ D9. The rectified voltage is defined to about 8.2 V by a voltage regulating diode D9 and charges a capacitor C1. Because the capacitance of C1 is much larger than the input capacitance of the IGBT, a substantially ripple-free voltage is produced across C1. This voltage supplies the negative bias voltage for the IGBT.

To turn the IGBT on, the circuit works as follows.

When A+ (pin 5 of J1) is brought to LOW, a voltage of 24 V is generated at pin 3 of the pulse transformer T1. This voltage is applied to a path through D2, D1, R1, QA gate, QA emitter, and C1 to pin 4 of the T1. Because C1 is eventually charged to about

8.2 V, the voltage applied to the gate of the IGBT becomes about 15.8 V.

When the IGBT is turned off, the circuit works as follows.

Releasing the A+ (pin 5 of J1) generates a reverse voltage between pin 1 and 2 of the pulse transformer T1 and current flows through a path from pin 2 to pin 1 of T1 through D3 and D4. At the same time a reverse voltage occurs between pin 3 and pin 4 of T1, but this voltage does not cause the IGBT to be turned off – only resets magnetic flux in the core of the transformer –, because D2 blocks the reverse current. The IGBT is turned off when Q1 is switched on and the negative bias is applied to the gate of the IGBT by the voltage across the charged capacitor C1.

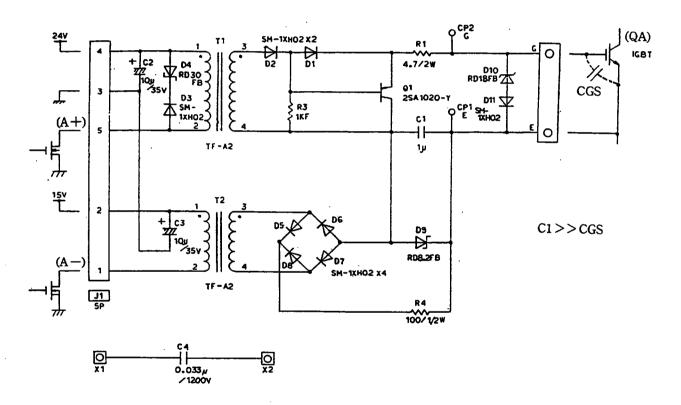


Fig. 3.3.5

Note

The 24 V to drive the gate is supplied from an independent switching power supply to the pin 4 of J1. So, do not connect the pin to the other 24-V sources.

3.4 Tube voltage control circuit (ANALOG-96 board)

(1) Signal input circuit for setting tube voltage Refer to Fig. 3.4.1.

Switching four signals for setting tube voltage, RKV, FKV, FKVA, PULKV, by signals, IBS, KSF, KC, PFLUO, generates PKV signal.

The ratio of the setting signal voltage to actual tube voltage is 5V /100kV. The PKV signal is used in a voltage control circuit for fluoroscoic tube (refer to (3) in section 3.5) and a detection circuit for abnormal operation (refer to (1) in section 3.5).

(2) Input circuit for measured tube voltage signal Refer to Fig. 3.4.2.

The tube voltage measured by tube voltage detecting resistors in the high voltage generator is supplied to KVFB+ and GND, and KVFB- and GND.

When the measured tube voltage is 100 kV, the voltage at a check terminal KVFB+ is

$$\frac{100 \times 10^{3}}{2} \times \frac{6.8 \times 10^{3}}{50 \times 3 \times 10^{6}} = \frac{6.8}{3} = 2.26 \text{ [V]}$$

and the voltage at a check terminal KVFB is -2.26 [V].

Variable resistors KV+ADJ and KV-ADJ are adjusted so that the voltages at check terminals KV+ and KV- are 2.5 [V].

At a check terminal \boxed{TKV} , a sum of the voltages at $\boxed{KV+}$ and $\boxed{KV-}$ appears. (5V when the tube voltage is 100 kV.)

Variable resistors WF ADJ+ or WF ADJ- makes the time constant including R95 or R110 equal to the time constant including the tube voltage detecting resistors (50 $M\Omega \times 3$), respectively.

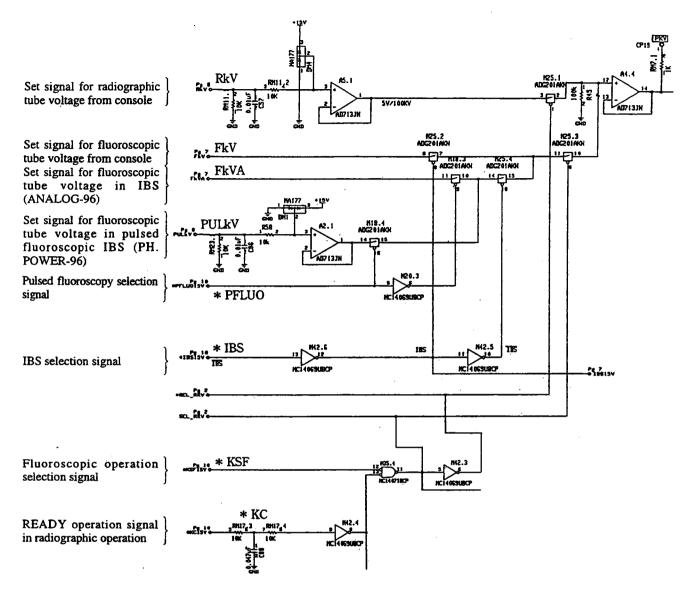


Fig. 3.4.1

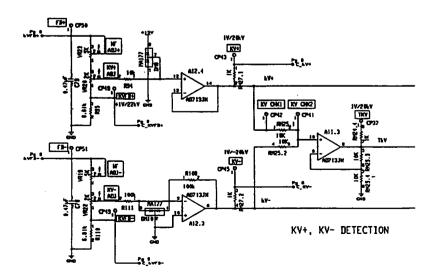


Fig. 3.4.2

(3) Voltage control circuit for fluoroscopic tube (in fluoroscopic and radiographic operation with tube current less than 50 mA)

Refer to Fig. 3.4.3 and Fig. 3.4.4.

Fig. 3.4.3 shows a circuit that supplies a 2.9V signal to the oscillation circuit (refer to (1) in section 3.3) when X-RAY ON is executed in fluoroscopic operation. (Oscillator frequency: 31 kHz, inverter frequency: 15.5 kHz)

When fluoroscopic operation is selected, an analog switch M33 is turned ON between terminal 3 and 2, because an input $\overline{\text{KSF}}$ is turned LOW and $\overline{\text{KC}}$ is HIGH. The switch between terminal 6 and 7 of M33 is turned ON, because the reset terminal 10 and the output terminal 12 $\overline{\text{(Q)}}$ of a flip-flop M41 is turned HIGH.

When X-RAY ON is executed, EXR is LOW and the switch between terminal 10 and 11 of M33 is ON.

As a result, a voltage 2.9 V at the input terminal of an operational amplifier A4 is supplied to the input terminal VIN of the oscillation circuit (refer to (1) in section 3.3) through terminals 3 and 2, 10 and 11, 6 and 7 of the analog switch M33 and terminals 3 and 1 of an operational amplifier A9. The circuit including a check terminal VINLMT will be described in (1) of section 3.4.

Fig. 3.4.4 shows a circuit in which the inverter is turned ON and OFF (15.1 kHz) so that the measured tube voltage and the set tube voltage are made equal in fluoroscopic operation.

The signal for setting tube voltage PKV from the signal input circuit passes through two stages in the operational amplifier A4 and becomes a signal FKVREF.

The voltage at each portion is:

Check terminal PKV

: 5V/100KV

• Output terminal 1 of operational : $(PKV-3) \times (0.5 \sim 2.0) [V]$ amplifier A4

• Output voltage from variable : (1.4 ~ 4.3) [V] resistor F60KV ADJ1

• Check terminal FKVREF : $-\{(PKV-3) \times (0.5 \sim 2.0) + (1.4 \sim 4.3)\} [V]$

As shown in Fig. 3.4.4, a comparator M30 compares the FKVREF signal with the measured tube voltage TKV.

When FKVREF > TKV, a check terminal KV OFF (DATA input terminal 5 of flip-flop M41) becomes HIGH.

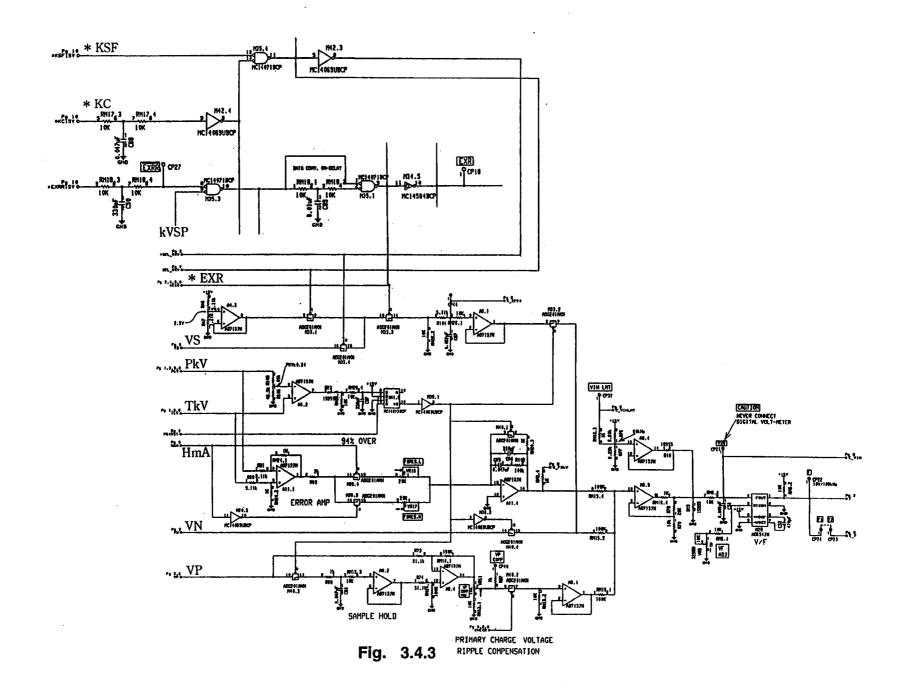
When FKVREF < TKV , the terminal becomes LOW.

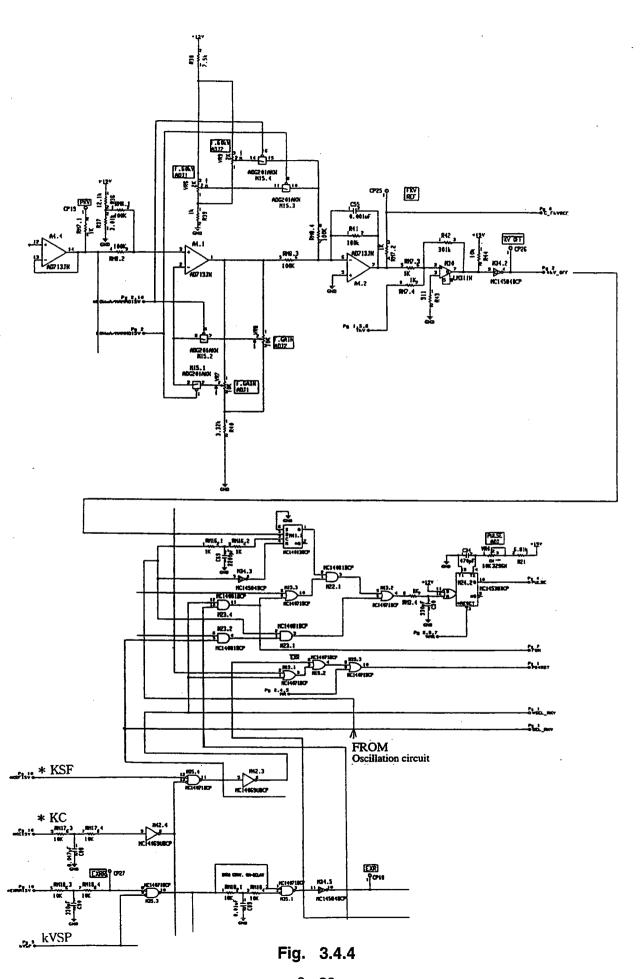
During KV OFF is HIGH, the signal at the output terminal 10 of M22 in the oscillation circuit (refer to (1) in section 3.3) enters the input terminal 2 of M22 through terminals 3 and 1 of the flip-flop M41.

When X-RAY ON is executed in fluoroscopic operation, HIGH signal at terminal 1 of M22 goes through terminal 3 of M22 and terminals 5 and 4 of M13 to M24 and causes the inverter to oscillate. (Refer to (1) in section 3.3, "oscillation circuit", for further explanation.)

When $\overline{\text{KV OFF}}$ is LOW, the signal from the oscillation circuit is blocked at M41 and the inverter stops to oscillate. With above circuit operations, the tube voltage in fluoroscopic operation ($\overline{\text{TKV}}$) is controlled to be equal to the set tube voltage $\overline{\text{PKV}}$.

Variable resistors F60KV ADJ1 and FGAIN ADJ1 adjust FKVREF signal so that it becomes a little lower than PKV signal for any tube voltage (refer to Fig. 3.4.5). This can correct the cutoff delay of the inverter, thus making it possible to derive a correct tube voltage. (Note: when the tube current is less than 50 mA in radiographic operation, variable resistors F60KV ADJ2 and FGAIN ADJ2 adjust FKVREF.)





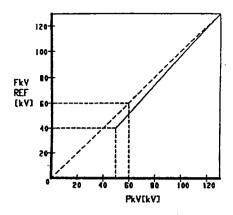


Fig. 3.4.5

(4) Voltage control circuit for radiographic tube

When X-RAY ON is executed in radiographic operation, the inverter oscillates at a memorized frequency in accordance with radiographic tube voltage, current, and power supply voltage. When a measured tube voltage approaches a set tube voltage, the frequency is switched to another memorized value (a value a little lower than at start time and close to a final stable value) and then feedback-controlled so that the measured voltage becomes equal to the set voltage.

(a) PKV, RMA, and VP input circuit

Refer to Fig. 3.4.6.

The relation between input and output of an analog multiplier AD633 is given by

$$W = \frac{(X_1 - X_2) \times (Y_1 - Y_1)}{10} + Z = \frac{(X_1) \times (Y_1)}{10} [V]$$

where $X_2 = Y_2 = Z = 0$ [V].

Applying this relation to the circuit including M45 and terminals 5, 6, 7 of A11 gives

$$W = PKV/2$$
, $X_1 = VP$, $Y_1 = (terminal 7 of A11)$

(Terminal 7 of A11) =
$$\frac{10W}{X_1} = \frac{5 \times (PKV)}{Vp}$$
 [V]

The voltage at terminal 7 of A11 is amplified by the circuit of terminals 10, 9, 8 of A8 and output to a check pin PRKV.

A variable resistor $\boxed{PRKV \text{ ADJ}}$ is adjusted so that the voltage at \boxed{PRKV} becomes 5.56 [V] when supply voltage is 400 V (Vp = 5.66 [V]) and set tube voltage is 100 kV (PKV = 5 [V]). (The relation is given by 180 kV / 10 V.)

Similarly, a voltage is generated at terminal 7 of A1 as,

(Terminal 7 of A1) =
$$\frac{5 \times (RMA)}{Vp}$$
 [V]

The voltage at terminal 7 of A1 is amplified by the circuit of terminals 1, 2, 3 of A1 and output to a check pin PRMA.

A variable resistor PRMA ADJ is adjusted so that the voltage at PRMA becomes 3.33 [V] when supply voltage is 400 V (Vp = 5.66 [V]) and set tube current is 400 mA (RMA = 2 [V]). (The relation is given by 1200 mA / 10 V.)

(b) Frequency memory circuit

Refer to Fig. 3.4.7.

The analog output PRKV in prior section (a) enters A/D converter M2 and PRMA enters M1.

When X-RAY is executed, \overline{EXRR} signal becomes LOW, the output terminal \overline{Q} (7) of one-shot multivibrator M24 becomes LOW for 10μ sec, and CONV terminal (12) of M2 and M1 becomes HIGH. Hence, A/D conversions are practiced, outputting 7-bit (128) digital signal from M2 and 9-bit (512) signal from M1.

This 16-bit digital signal enters P-ROM and address terminals of M3 and M4.

Six bits (64) of 16-bit data in M3 and M4 enter D/A converter M9 and an analog voltage corresponding to the digital input is derived at a check terminal VS.

VR2 adjusts the voltage at VS so as to be 10V at maximum.

Ten bits (1024) of 16-bit data in M3 and M4 enter D/A converter M8 and an analog voltage corresponding to the digital input is derived at a check terminal VN.

VR1 adjusts the voltage at VN so as to be 10 V at maximum.

When checking the memory contents without generating X-ray, short-circuit check terminals MEMORY TEST1 and MEMORY TEST2. Then READY operation generates voltages at VS and VN.

(c) Oscillation frequency control circuit

Refer to Fig. 3.4.3.

When the radiographic operation is selected, an input $\overline{\text{KSF}}$ becomes HIGH. When READY operation is executed, an input $\overline{\text{KC}}$ becomes LOW (in fluoroscopic operation, too). In these cases, the terminal 16 of analog switch M33 becomes LOW and the switch between terminal 14 and 15 is turned ON.

Next, when X-RAY is executed, the switch between terminal 10 and 11 of M33 is turned ON. During the time TKV < 0.94PKV, the set terminal 8 of flip-flop M41 is LOW. Then, the output terminal 12 of \overline{Q} is HIGH and the analog switch between terminal 6 and 7 of M33 is ON.

As a result, the output VS of the frequency memory circuit (refer to (4) (b) in section 3.4) enters the input terminal VIN of the oscillation circuit (refer to (1) in section 3.3) through terminals 14, 15 and 10, 11 of the analog switch M33, terminals 3, 1 of the operational amplifier A9, terminals 6, 7 of the analog switch M33, and terminals 10, 8 of the operational amplifier A9.

Then, the inverter starts to work and when a condition (TKV > 0.94PKV) is reached, the set terminal 8 of flip-flop M41 becomes HIGH, and the output terminal \overline{Q} becomes LOW. Hence, the analog switch between terminal 6 and 7 of M33 is turned OFF, the switch between terminal 14 and 15 of M40 becomes ON, and the input signal to the oscillation circuit is switched from \overline{VS} to \overline{VN} .

At the same time the analog switch between terminal 2 and 3 of M40 is turned OFF. Then, a correction voltage generated by the voltage difference between PKV and TKV is output from the output terminal 14 of the operational amplifier A11 to $\boxed{\text{VN}}$, and the voltage at VN controls so that the voltages at PKV and TKV are made equal. Also, at the same time by the turn-OFF of the analog switch between terminal 10 and 11 of M40, a correction voltage corresponding to the ripple voltage of the DC power supply is output at the output terminal 14 of the operational amplifier and supplied to $\boxed{\text{VN}}$.

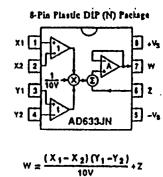
Yet, when CHECK signal (refer to (1) "Abnormal operation detecting circuit" in section 3.5) is HIGH, these correction voltages are not output, because the analog switch between terminal 6 and 7 is turned OFF.

The circuit including terminals 12, 13, and 14 of the operational amplifier A9 limits the voltage output to the oscillation circuit to 8.25 [V] at maximum. (Oscillator frequency: 90 kHz, inverter frequency: 45 kHz)

10Y/180kY (YP-5,66Y) PRKY PCP36 5 + AD713JH AD713JN 2 10K₁ RH17.1 10Y/1200mA (YP5.66Y) |PRHA 9 CP5 AD719JN AD713JN Pg 1,3,5 PRIMARY CHARGE VOLTAGE COMPENSATION

Fig. 3.4.6

AD633 CONNECTION DIAGRAMS



EXRR CP27

HCI465/BCs

3 - 25

(5) Tube voltage measurement circuit

Refer to Fig. 3.4.8.

This circuit supplies set tube voltage and measured tube voltage to other units.

Generally, at check terminal TKV OUT, measured tube voltage signal TKV (refer to (2) in section 3.4) is output after it has been current-buffered. However, in CHECK mode set tube voltage signal PKV is output.

At check terminal PKV OUT set tube voltage signal is always output after having been current-buffered.

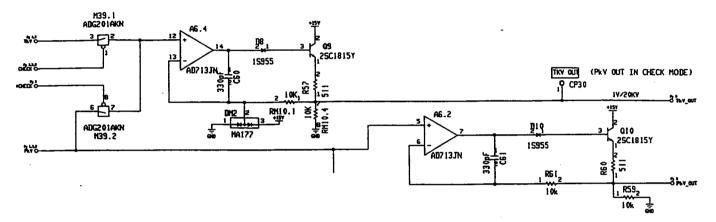


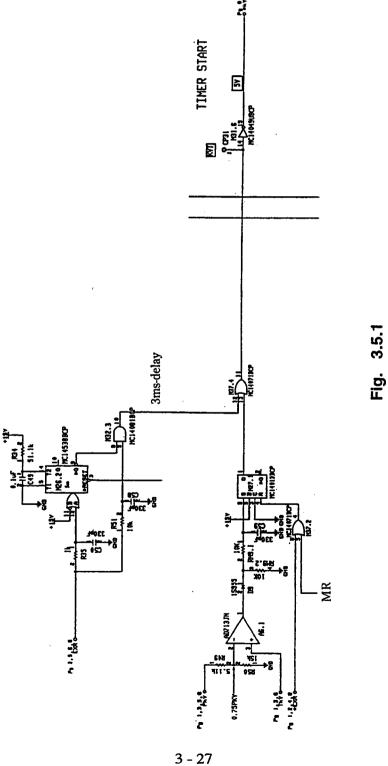
Fig. 3.4.8

3.5 KVT circuit

Refer to Fig. 3.5.1.

Operation time, radiographic and fluoroscopic, is defined as the time tube voltage is higher than a specified value (about 75% of peak value). A startup confirmation signal of a measured tube voltage, KVT, is generated when the voltage reaches about 75% of its peak value.

This signal is sent to EMC-96PCB and used as a start signal for a operation timer.



3.6 IBS control section

(1) Outline

IBS (automatic fluoroscopic brightness controller) holds a fluoroscopic brightness constant by varying the fluoroscopic tube voltage in relation to the luminance signal from a monitor television.

(2) IBS circuit

When "IBS" is selected and fluoroscopic operation starts, a signal proportional to the luminance signal of the television camera enters terminals TV7 and TV2. This signal voltage enters pin 10 of A5 and IBS reference voltage, about 6 V, enters pin 9 of A5. (This voltage is determined because IBS reference value of television is about 6 V.) The two signals are amplified by A5 and the difference signal is integrated by A3.

IBS RES VR11 adjusts the response of kV by varying the integral time constant. The voltage at CP7 "FKVA" varies so that the voltages at pin 9 and 10 of A5 have no difference, thus holding the brightness of the television screen. VR12 FKV MAX. ADJ is adjusted so that a fluoroscopic tube voltage in IBS does not exceed the maximum fluoroscopic tube voltage of the X-ray tube.

When IBS is used, a microcomputer stores the last value of the fluoroscopic tube voltage in previous operation and assigns the value for the startup voltage in the next operation.

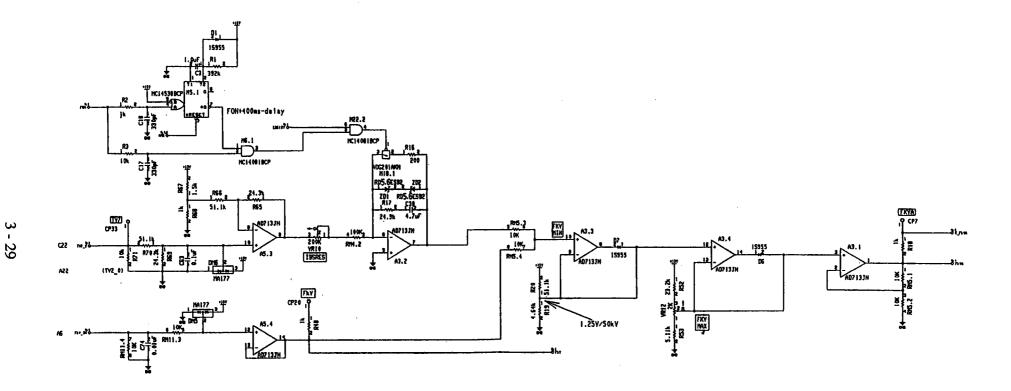


Fig. 3.6.1

(3) Pulsed fluoroscopy IBS

IBS in pulsed fluoroscopy is controlled in PH CONT-96 (refer to section 12). As a result, a set tube voltage enters as a PUL kV.

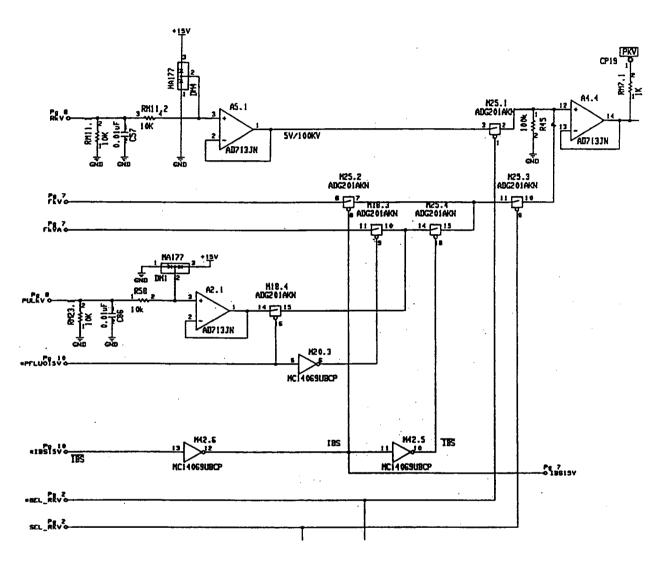


Fig. 3.6.2

3.7 Others

(1) Detection circuit for abnormal operation

(a) FAULT signal

This circuit detects abnormal operations of the main circuit and outputs them to the console as FAULT signals.

Refer to Table 3.7.1.

Table 3.7.1

FAULT signal	Abnormal operation signal	Significance
TKV BR	TKV OVER	Measured tube voltage KV+, KV->90KV
	TKV UNDER	Measured tube voltage 67% UNDER
PKV OVER	PKV OVER	Set tube voltage signal, when PKV exceeds 157 kV.
CHG BR	CHG OVER	Charging voltage for main circuit capacitor is more
<u> </u>		than 395V.

(b) TKV OVER

Refer to Fig. 3.7.1.

When a measured tube voltage KV+ or KV- is more than 90 kV, the output terminal 1.14 of operational amplifier A7 becomes HIGH, the set terminal 8 of flip-flop M36 becomes HIGH, and LED TOV is turned on. Then, FAULT signal is output to the console. At the same time, the reset terminal 10 of flip-flop M21 in the oscillation circuit (refer to (1) in section 3.3) becomes HIGH and the inverter stops oscillating.

(c) TKV UNDER

Refer to Fig. 3.7.1.

When a measured tube voltage is less than 67% of the set tube voltage, the output terminal 8 of operational amplifier A6 becomes HIGH, the set terminal 6 of flip-flop M36 becomes HIGH, and LED TUN is turned on. When the operation is not in check mode (check terminals CHK1 and CHK2 are not short-circuited), FAULT signal, TKVBR, is output to the console. The circuit including a diode D11 clamps TKV so that it does not become less than 2.5 V, in order to prevent circuit malfunctions. (When the set tube voltage is less than 75 kV, TKV UNDER does not work.)

Whereas this abnormal operation detection works only during X-ray exposure period, it does not work during the startup delay time of TKV signal. The period the

detection is stopped is defined as 5 msec by a one-shot muotivibrator M26.

(d) PKV OVER

Refer to Fig. 3.7.3.

When the set tube voltage signal PKV exceeds 7.85 V (157 kV), the terminal 7 of operational amplifier A10 becomes HIGH and LED PKO is turned on. Then, FAULT signal, PKV OVR, is output to the console.

(e) CHG OVER

Refer to Fig. 3.7.3.

Output voltages from the charging voltage detection circuit (refer to (3) in section 3.2) appear at check terminals $\overline{VP_1}$ and $\overline{VP_2}$. The relation between these signals and the capacitor charging voltage is given by 1 V / 100 V.

When the voltage at VP₁ or VP₁ is more than 3.95 V (capacitor charging voltage: 395V), the output terminal 1 or 14 of operational amplifier A10 becomes HIGH and LED CHO is turned on. Then, FAULT signal, CHG BR, is output to the console.

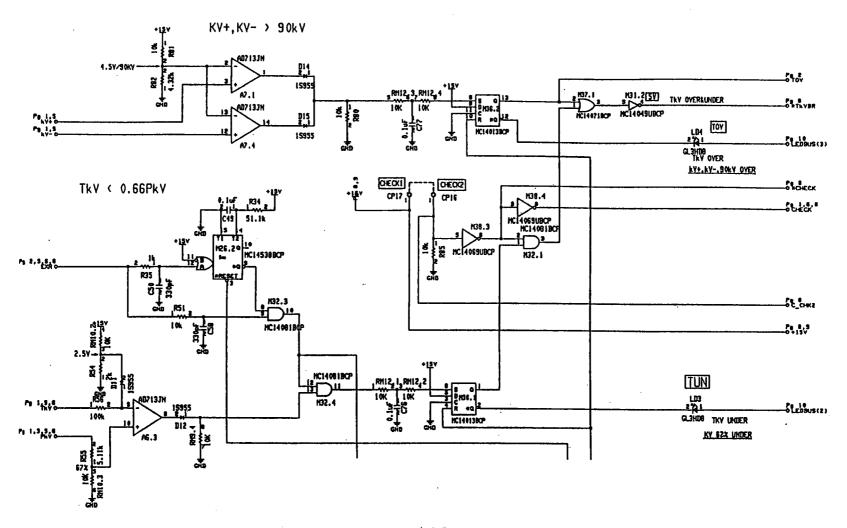


Fig. 3.7.1

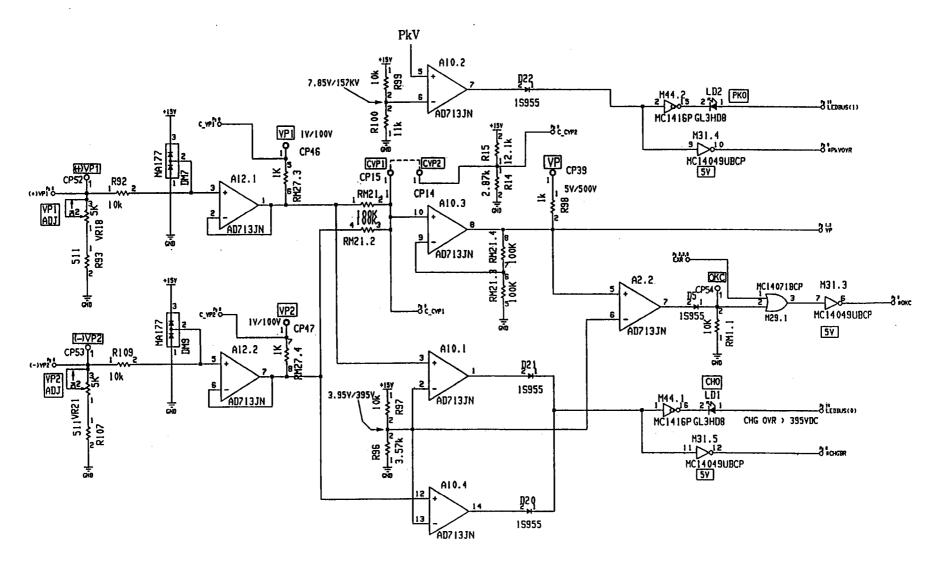


Fig. 3.7.2

(f) Discharge detection circuit

Refer to Fig. 3.7.3.

While X-ray tube cannot avoid micro discharge, the current flowing through IGBT may exceed the rating if the discharge continues. The discharge detection circuit detects the discharge in terms of a sharp change of tube voltage KV+ or KV- and stops X-ray exposure for 15 msec. After 15 msec it restarts the exposure.

The measured voltage KV+ and KV- enters a differentiating circuit and the rate of change is monitored. When the tube voltage decreases rapidly and the output of the differential circuit exceeds -0.75 V, the terminal 7 and 8 of A7 become HIGH. The one-shot multivibrator M26 is triggered by the rising edge of the HIGH transition and outputs a pulse of 15-msec length (KVSP signal). The exposure is stopped for 15 msec by the pulse signal.

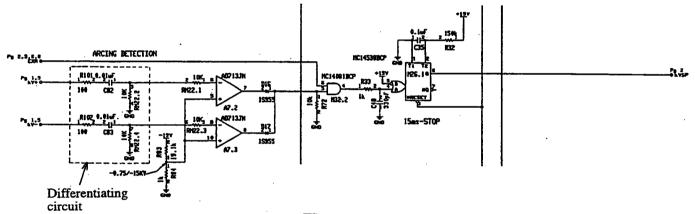


Fig. 3.7.3

(2) Reset circuit

Refer to Fig. 3.7.4.

At power-ON of the generator, a signal MR becomes HIGH and MR becomes LOW for about 1 msec. With these signals all flip-fops and one-shot multivibrators come to reset.

When FAULT signals occur, a reset signal FRST from the console can reset flipflops of the abnormal operation detecting circuit.

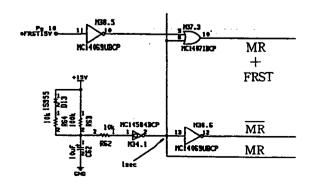


Fig. 3.7.4 3 - 35

(3) Signal table of ANALOG-96 board

Signal	Content	Remark
RKV	Set signal for radiographic tube voltage	7.5V/150KV
CHECK	CHECK mode	
FKV	Set signal for fluoroscopic tube voltage (not in IBS)	7.5V/150KV
LOW mA/MAMMO	Control of voltages by comparator in low tube current (MAMMO)	
FKVA	Set signal for fluoroscopic tube voltage in IBS	7.5V/150KV
IBS	Automatic fluoroscopic brightness control	
PULKV	Set signal for fluoroscopic tube voltage in pulse fluoroscopic IBS	
PFLUO	Pulse fluoroscopic operation	
KSF	Fluoroscopic operation	
KC	Ready signal	
EXRR	X-ray exposure command	INPUT
EXR	X-ray exposure command	OUTPUT
KVFB+	Tube voltage feedback signal (anode)	
KVFB-	Tube voltage feedback signal (cathode)	
RMA		5V/1000mA
A+, A-	IGBT, ON signal (QA)	
B+, B-	IGBT, ON signal (QB)	
C+, C-	IGBT, ON signal (QC)	
D+, D-	IGBT, ON signal (QD)	
VP1	Electrolytic capacitor charging voltage signal at positive side	
VP2	Electrolytic capacitor charging voltage signal at negative side	
FRST	FAULT circuit reset	
TKV OUT	Measured tube voltage signal (set tube voltage signal in CHECK mode)	7.5V/150KV
PKV OUT	Set tube voltage signal	7.5V/150KV
TKVBR	TKV OVER or TKV UNDER signal	
KVT	Operation timer start signal	
PKVOVR	PKV has exceeded 7.85 V (157 kV).	
CHGBR	Electrolytic capacitor charging voltage has exceeded 395 V.	
TV7	Television luminance signal in IBS	Standard: 6V

4. Filament heating circuit

4.1 Introduction

This device is provided with control circuits with following features in order to control X-ray current with precision and good reproducibility.

- 1) Constant-current control in primary circuit
- 2) Filament heating by inverter method (20 kHz)
- 3) Preheating current proportional to filament current in use
- 4) Feedback control of tube current during X-ray exposure
- 5) Flashing circuit in relation to using filament current (only for X-ray tube with less than 5 A)

Operation method	Focus	Ratio of flash current	Trimmer No.	Remark
Operation without	Small focus	About 20%		Target startup time within 1.2 sec
fluoroscopy	Large focus	About 34%	None	
Operation with fluoroscopy	Small focus	0 ~ About 66%	FLS VR 1	Target startup time
	Large focus	0 - About 20%	FLL VR 2	of 0.8 sec

4.2 Outline

(1) Configuration

Filament current of X-ray tube is controlled in mA POWER-96 board.

- (2) Specifications
 - (a) Power supply

AC 135 V

DC \pm 15 V (DC stabilized power supply)

(b) Rating

Usable maximum power

	Current	Voltage
Secondary circuit	5.2 A	20 V (MAX)

(c) Insulation transformer

Transformer for insulating low-voltage filament circuit from high-voltage side Winding ratio: 5.5:1

(3) Outline of filament heating circuit

Fig. 4.2.1 shows a block diagram of this circuit.

(a) Power circuit

AC power supply (single phase, 135VAC) is rectified by diode D7 and smoothed by capacitor C17. The derived DC power is converted to AC power of 20 kHz by an inverter consisting of FET Q2 ~ Q5.

The output from the inverter is input to a focus switching relay circuit, switched either for large focus or small focus by a focus switching control circuit, and output to X-ray filament through a filament transformer.

A resonance capacitor C12 is added to the inverter output in series, making a resonance type inverter.

(b) Control circuit

The tube currents of radiographic tube and fluoroscopic tube are feedback-controlled so that they become equal to their set value.

The tube current measured by the mA DETECTOR board is input to an error signal amplifier 1 and subtracted from the output from the tube current set circuit (RmA/FmA). The error signal amplifier 1 controls its output voltage so that the error becomes sufficiently small. That is, when (measured value) < (set value), the amplifier output a positive signal, and when (measured value) > (set value), it outputs a negative value.

The output from the error amplifier 1 is added to the value stored in a filament current set circuit (microcomputer) and corrects the set value. The output of the adder is input to another error amplifier 2 as a new set value of filament current and compared with the output from a filament current measuring circuit. The error amplifier 2 feedback-controls with a PWM control circuit so that the two values become equal to each other.

According to the process described above, the tube current is feedback-controlled so that it becomes equal to the set value.

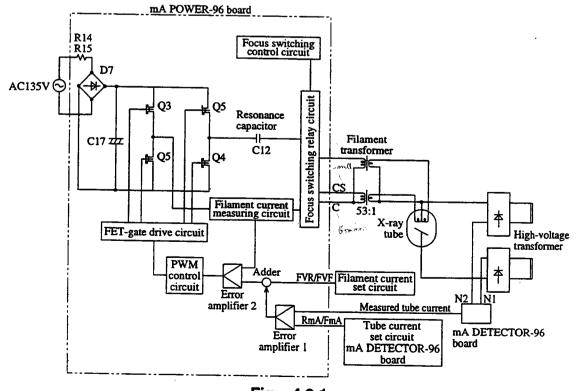


Fig. 4.2.1

4.3 Power circuit

(1) Rectifying and smoothing circuit

Refer to Fig. 4.3.1.

When power of the generator is turned ON, AC 135 V power comes in. A diode bridge D7 rectifies the input power with resistors R14 and R15 and a capacitor smoothes it.

Because it is not stabilized, this output voltage varies with a variation of the input power.

(2) Inverter circuit

Refer to Fig. 4.3.1.

(a) Full-bridge type inverter

Four MOS-FET's (Q2 ~ Q5) make a full-bridge type inverter. By Q2 / Q5 and Q3 / Q4 being alternatively and repeatedly turned on, AC output of 20 kHz is generated.

(b) Gate drive circuit

A drive method with pulse transformer is used.

When a drive signal turns on a small signal transistor 2SC3733, a voltage is applied to the pulse transformer. Then, a voltage is induced on the secondary winding of the transformer and supplied to a gate of MOS-FET through a 47.5 Ω resistor. When the voltage at the gate exceeds a threshold, the MOS-FET is turned on.

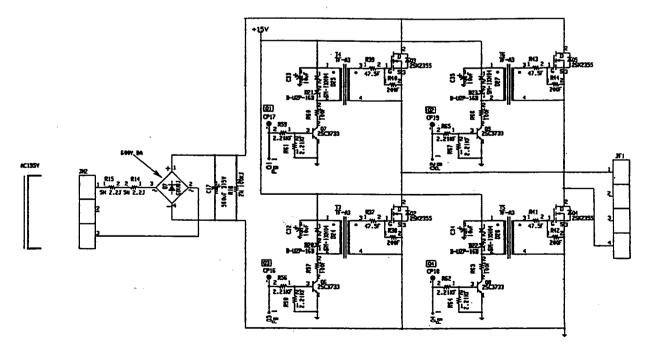


Fig. 4.3.1

- (3) Focus switching circuit
 - (a) When the operation does not include fluoroscopy,

Refer to Fig. 4.3.2.

When small focus is selected, an input FOSM becomes LOW, terminal 2 of M5 becomes HIGH, and a relay K2 is turned on. Then, the output voltage of the inverter circuit is supplied to a filament transformer for small focus through terminals C0 and CL.

When large focus is selected, an input FOSM becomes HIGH, terminal 2 of M5 becomes LOW, and a relay K2 is turned off. Then, the output voltage of the inverter circuit is supplied to a filament transformer for large focus through terminals C0 and CL.

When the operation does not include fluoroscopy, relays K1 and K3 are always OFF.

(b) When the operation includes fluoroscopy (fluoroscopy is operated with small focus),

Refer to Fig. 4.3.3.

When fluoroscopy is operated with small focus, S2-1 FLUO LARGE is turned OFF. When the operation including fluoroscopy is selected, input FL becomes LOW and terminal 4 of M5 HIGH. Then, terminals 1 and 2 of M13 become HIGH and terminal 6 of M13 HIGH. Relays K1, K2, and K3 are ON until READY operation is executed, because input KC is HIGH and terminal 4 of M13 HIGH.

Then, the output voltage of inverter circuit is supplied in series to transformers for large and small focus through terminals CL and CS and also supplied between terminals CL and C0 through resistor R1 (300 Ω , 40 W).

According to the process described above, a little smaller filament current flows for large focus than for small focus. R1 is adjusted so that a filament current is derived which does not cause X-ray to be generated for large focus in fluoroscopic operation. By preheating the filament for large focus in an extent that X-ray is not generated, the rise time of the filament temperature is shortened in a high-speed radiography.

Next, when READY operation is executed, the signal \overline{KC} becomes LOW, terminal 4 of M13 HIGH, and relays K1, K2, and K3 OFF. Then, the output voltage of the inverter circuit is supplied to the filament transformer for large focus through terminals C0 and CL. When small focus is selected for radiography, the input \overline{FOSM} is LOW and the relay K2 is turned ON. Then, the output voltage of the inverter circuit is supplied to the filament transformer for small focus through the terminals C0 and CL.

(c) When the operation includes fluoroscopy (both fluoroscopy and radiography are operated with large focus),

Refer to Fig. 4.3.3.

In this case S2-1 FLUO LARGE is turned on. Then, terminal 3 of M13 is LOW. Accordingly, terminal 4 of M13 is always LOW whether the signal KC is LOW or HIGH.

When radiography is also operated with large focus, terminal 2 of M5 is LOW because the signal FOSM is HIGH.

According to the process described above, the relays K1, K2, and K3 are always HIGH and the output voltage of the inverter circuit is supplied to the filament transformer for large focus through the terminals C0 and CL.

When large focus is changed to small focus in radiographic operation, it is changed to small focus in fluoroscopic operation, too. That is, it is not possible to use large focus in fluoroscopy and small focus in radiography simultaneously.

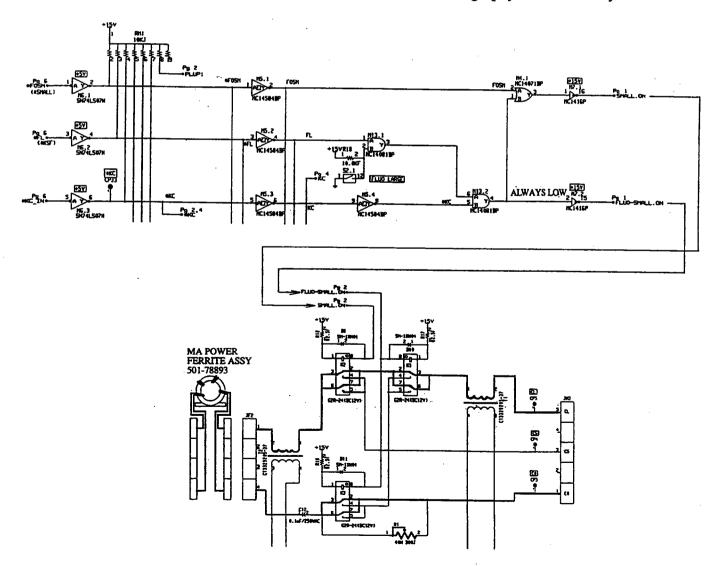


Fig. 4.3.2 Operation that does not include fluoroscopy

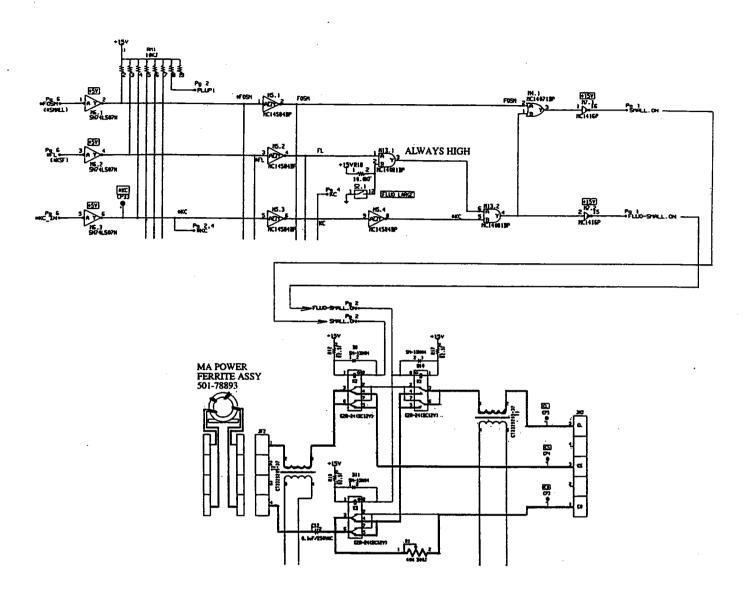


Fig. 4.3.3 Operation that includes fluoroscopy (fluoroscopy is operated with small focus)

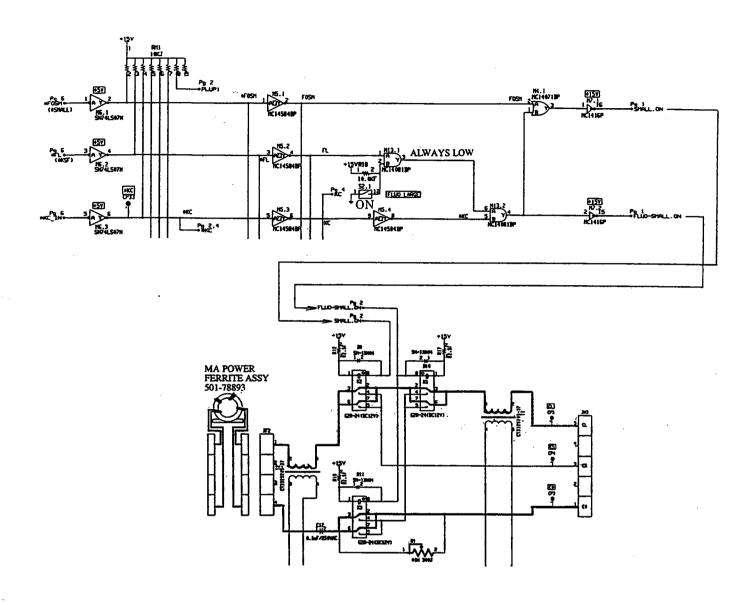


Fig. 4.3.4 Operation that includes fluoroscopy (both fluoroscopy and radiography are operated with large focus.)

4.4 Control circuit

(1) Filament current set circuit

Refer to Fig. 4.4.1.

The IFST signal shown in Fig. 4.4.1 is derived from the input signal FVR from the console in radiographic operation and from the input signal FVF in fluoroscopic operation, and determines the filament current.

(a) Radiographic operation

The input signal FVR from the console is output to a check pin C25 FVR through a buffer of operational amplifier A5.1. The relation between FVR and the filament current (secondary side) is given by 5 V / 5 A approximately.

Before READY operation is executed, an analog switch M24.3 is OFF and M27.1 is ON, because inputs *KC and *KCP are HIGH. Then, a half voltage of FVR, derived by dividing FVR by resistors R102 and R126 (+RM15.4), is input to terminal 5 of a buffer A19.2, and output from the buffer as it is.

Because the operation in this case does not include fluoroscopy or pulse fluoroscopy, analog switches M27.2 and M 28.3 are ON. Then, a non-inverting adder A20.2 adds 1/2FVR and MAFC, and outputs the added value to IFST. Here, the value is 1/2FVR because MAFC is zero when X-ray exposure is not working.

According to the process described above, the value at IFST is about 2.5 V when FVR is 5 V. That is, when FVR is 5 V, a preheating current of about 2.5 A flows through the filament.

Next, when READY operation is executed, switches between terminals 2 and 3 and between 10 and 11 of M24 are turned ON, because an input signal *KCP becomes LOW, and terminals 1 and 9 of M24 become LOW. Terminal 8 of M24 becomes HIGH, and a switch between terminals 6 and 7 is turned OFF.

When radiographic operation is selected, a terminal 8 of M23 is LOW, and a switch between terminals 6 and 7 of M23 is ON. Then, the signal FVR is reduced to one third by resistors R51 and R52, and outputs its differentiated waveform through A19 to a check pin CP 31 FLR as shown in Fig. 4.4.1. This waveform is added to the signal FVR for 0.8 seconds at its maximum. With small focus, an input signal *FOSM is LOW, the terminal 1 of the analog switch M23 is LOW, and a switch between terminals 2 and 3 is ON. Therefore, the voltage FLR is a half of that with large focus.

When READY operation is executed, a terminal 1 of analog switch M27 becomes

LOW, and a switch between terminals 2 and 3 of M27 is turned on. Then, a resistor RM153-4 is short-circuited.

According to the process described above, a voltage derived by adding the signal FLR to FVR is output as the signal IFST. Incidentally, the filament temperature rises fast to a specified value by preheating before READY operation and a flashing current at READY operation.

The input signal MAFC works to compensate with feedback a tube current during X-ray exposure. When a measured current decreases during X-ray exposure, this signal is added to FVR to increase the filament current.

(b) Operation including fluoroscopy

In operation including fluoroscopy, an input signal *FL becomes LOW. In fluoroscopic operation, a signal IFST IFST is output which is derived by adding a tube current compensated with feedback, MAFC, to the set signal from the console, FVF.

In radiographic operation, IFST signal is derived from the FVR signal sent from the console in the same way as described in the previous section (a). On READY operation, a switch between terminals 10 and 11 of M27 is turned OFF, and another switch between terminals 6 and 7 ON.

In fluoroscopy with large focus, a switch between terminals 10 and 11 of M 23 is ON, because a terminal 9 of M23 is LOW. On READY operation, switches between terminals 2 and 3 and terminals 10 and 11 of M24 are turned ON, and another switch between terminals 6 and 7 is OFF. At this time, a differentiated voltage waveform proportional to FLL at trimmer VR2 is generated at a check pin CP31 as FLR, and added to FVR for 0.8 seconds at its maximum (refer to Fig. 4.4.1).

Further, a switch between terminals 2 and 3 of M27 becomes ON, the resistor RM153-4 is short-circuited, and the signal IFST is generated in the same way as in section (a).

With small focus fluoroscopy, IFST signal is generated in the same way, too.

(2) Filament current measuring circuit

A current transformer is connected in the output side of the inverter circuit in mA POWER-96 board.

Refer to Fig. 4.4.2 to understand the following description.

The turn ratio of the filament transformer (not shown in the Figure) in the high-voltage generator is 5.5 to 1. That of the current transformer is 1 to 3000. The secondary

side of the current transformer is connected to a resistor R7 through full-wave rectifier diodes D3 ~ D6. The relation between the filament current, Ifi [A], and the voltage across R7, E7 [V], is given by

$$E7 = I_{f1} \times \frac{1}{5.5} \times \frac{1}{3000} \times 750$$

When If 1= 5 [A], the voltage across R7 (effective value) is given by

$$5 \times \frac{1}{5.5} \times \frac{1}{3000} \times 750 = 0.23 \text{ [V]}$$

This voltage is input to a terminal 2 of rms/D.C converter M3, and the same value of DC voltage as the effective value of the input voltage is output from the terminal 6. The DC voltage goes through an operational amplifier and becomes P.CUR signal.

When the filament current If is 5 [A], P.CUR signal is

$$0.23 \times \frac{51.1 \text{K}}{2.55 \text{K}} = 4.61 \text{ [V]}$$

In above calculations, the filament current includes a real filament current If and an exciting current of the filament transformer. Therefore, the relation between P.CUR signal and If is given by 5V / 5A. The P.CUR signal is sent to the DC power supply circuit (refer to (1) in section 4.3) and used to control the filament current.

The P.CUR signal becomes IFV signal after going through an operational amplifier A17, and is output to an output terminal JM1 through a dipswitch S1 and an operational amplifier A12. The dipswitch S1 is usually turned to S side. A filament ammeter is connected to the output terminal JM1. The ammeter has a full scale of 10 A and a sensitivity of 150µA. A variable resistor VR5 IFM ADJ is adjusted so that the meter indicates 5A when the signal voltage IFV is 5 V.

Filament ammeter: P/N 080-48054-57

When the ammeter reads a preheating current for large focus in fluoroscopic operation, the dipswitch S1 is turned to L side. Then, an output of the current transformer connected to the output side of the focus switching circuit (refer to (3) in section 4.3) is output to the output terminal JM1 through diodes D12 ~ D15, rms/D.C converter M17, an operational amplifier A13, and the dipswitch S1. Then, the filament current for large focus can be measured at JM1.

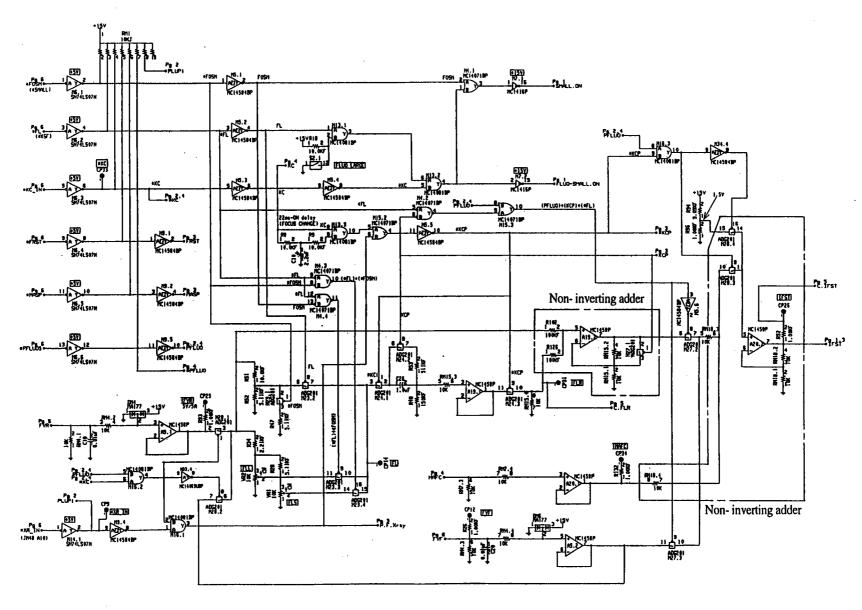


Fig. 4.4.1

(3) Heating acknowledgment circuit

Refer to Fig. 4.4.3.

A measured filament current signal IFV from the filament current measuring circuit (refer to (2) in section 4.4) is supplied to the non-reversal input terminal 3 of a comparator A12. Because about 0.9 V is applied to the reversal input terminal 2 of A12, the output terminal 1 of A12 and the terminal 12 of M16 becomes HIGH when IFV exceeds 0.9 V.

When READY operation is executed, a signal *KCP becomes LOW. Then, the output terminal $7(\overline{Q})$ of an one-shot multivibrator M1 becomes LOW for about 0.8 seconds, and becomes HIGH after that.

According to the process above, a *OKF signal is output to EMC when the filament current exceeded 0.9 A and about 0.8 seconds has passed after READY operation was executed.

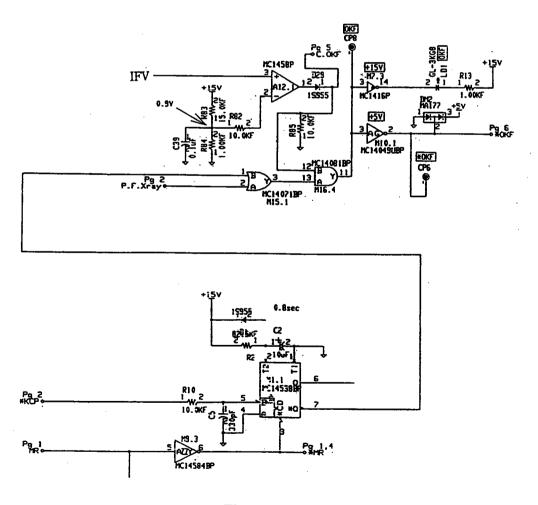


Fig. 4.4.3

(4) Faulty operation detecting circuit

(a) IFO circuit

Refer to Fig. 4.4.4.

The measured filament current signal is supplied to the non-inverting input terminal 3 of an operational amplifier A2. A signal of maximum filament current LMT from the console is supplied to the inverting input terminal 2 of A2. Before READY operation is executed, a switch between terminals 7 and 8 of M22 is ON, because the terminal 8 is LOW. When READY operation is executed, a signal *KCP becomes LOW and the output terminal 6 of a one-shot multivibrator M1 becomes HIGH for about 0.8 seconds. During that time a switch between terminals 6 and 7 of M22 becomes OFF, and the input voltage to the terminal 7 of A3 becomes about 1.4 times larger than the signal voltage LMT.

When the voltage at terminal 3 of A2 is higher than that of terminal 2 (when IFV signal is larger than LMT signal, and when IFV is 1.4 times larger than LMT for 0.8 seconds after READY operation due to an increase of IFV by flashing), terminal 1 of A2 becomes HIGH and a flip-flop M11 is set, then a terminal 1 of M11 becomes HIGH. As a result, LED IFO is turned on and an output *IFOVER becomes LOW.

(b) IFSO circuit

Refer to Fig. 4.4.4.

The set signal of filament current IFST enters the non-inverting input terminal 5 of an operational amplifier A2. 4 V is applied to the inverting input terminal 6 of A2.

When the voltage at terminal 5 of A2 is higher than 4 V (when IFST signal is larger than 4 V), terminal 7 of A2 becomes HIGH and the flip-flop M11 is set, and the terminal 1 of M11 becomes HIGH. As a result, LED IFOS is turned on and an output *IFOVER (output signal to EMC circuit) becomes LOW.

During X-ray exposure and during READY operation, this faulty operation detecting circuit is stopped to work.

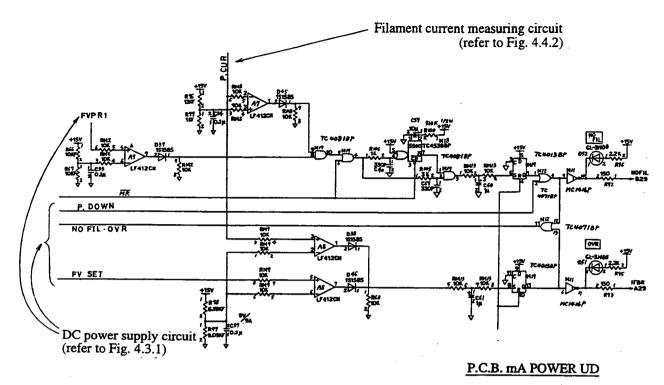


Fig. 4.4.4

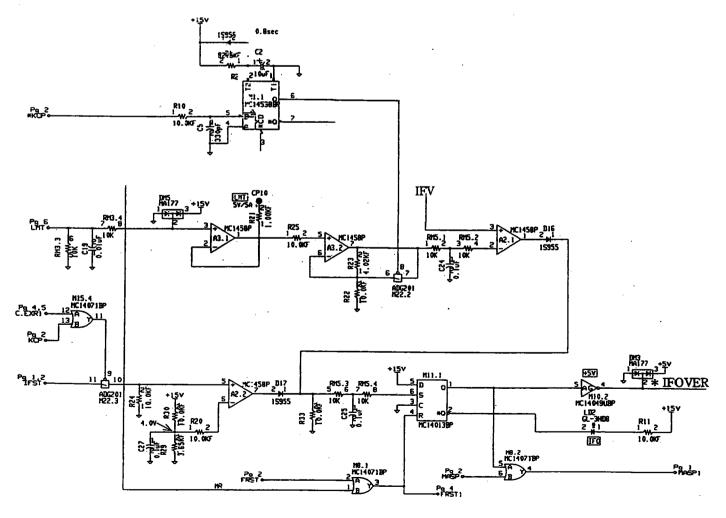


Fig. 4.4.5 4 - 15

(5) Reset circuit

Refer to Fig. 4.4.6.

The reset circuit is included in mA POWER-96 board. When the generator is turned on, a signal MR becomes HIGH and MR becomes LOW for about 2.5 seconds and all flip-flops and one-shot multivibrators are reset. Also, the DC power supply (refer to (1) in section 4.3) and the inverter circuit (refer to (2) in section 4.3) are stopped to work.

When FAULT signals are generated, the flip-flop in the faulty operation detecting circuit can be reset by a reset signal *FRST from the console.

4.5 Tube current control

The mA POWER-96 board detects tube currents at a neutral point and feedback-controls in both fluoroscopic and radiographic operation. (In pulsed fluoroscopic operation the feedback is made in vain, because pulse lengths are short.)

(1) Feedback circuit (for both fluoroscopy and radiography) Refer to Fig. 4.5.1.

A difference voltage between a measured radiographic tube current MAM (fluoroscopic tube current AMA) and its set tube current RMA (FMA3) appears at the output terminal 7 of a differential amplifier A4. The error voltage is input to an integrator A4 and its output becomes MAFC, and the error is corrected (refer to section 4.4).

The speed of response of the feedback circuit is changed according to operation method. In fluoroscopic operation the response is made slow to prevent hunting and DC gain is made large to enhance feedback accuracy. On the contrary, the speed of response is made fast in radiographic operation.

The feedback circuit does not work in check mode.

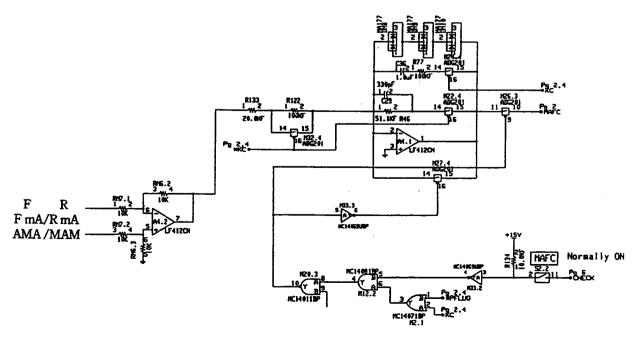


Fig. 4.5.1 4 - 16

(2) Tube current setting circuit for fluoroscopic tube

Refer to Fig. 4.5.2.

Trimmers $A \sim G$ establishes the relation between fluoroscopic tube voltage FKV and set fluoroscopic tube current FmA3.

Function of each trimmer is:

- A: total gain
- B: flexion point
- C : gain (positive)
- D: flexion point
- E : gain (positive)
- F: flexion point
- G: gain (negative)

S2-3 FMC is not used now. (Normally OFF)

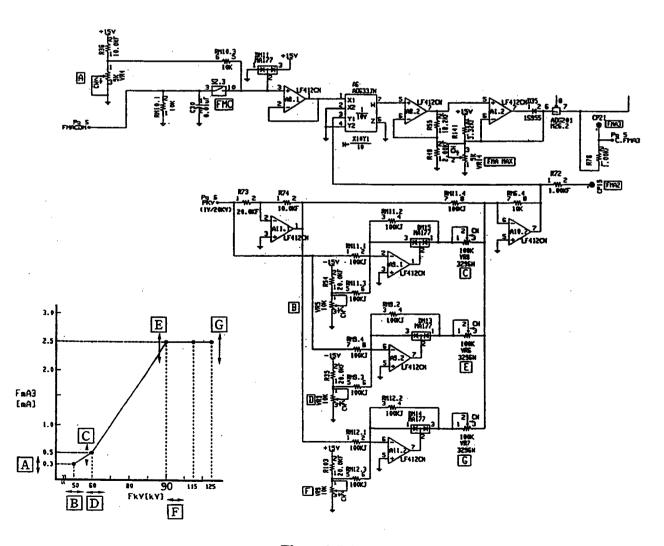


Fig. 4.5.2

(3) Tube current measuring circuit

(a) Outline

This circuit measures X-ray tube current. Fig. 4.5.3 shows an outline of the tube current measuring circuit.

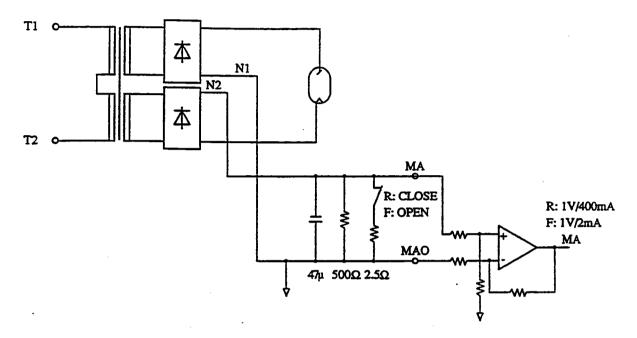


Fig. 4.5.3 Outline of tube current measuring circuit

As shown in Fig. 4.5.3, a current at the neutral point of high-voltage circuit is measured as a tube current.

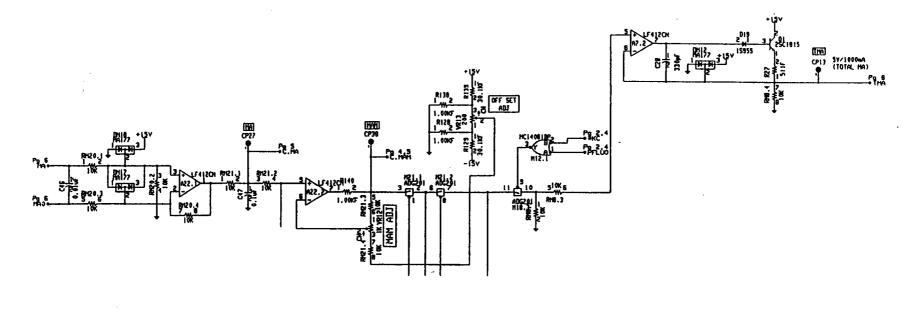
The detecting resistor portion is mounted on MA DETECTOR-96 board in the high-voltage generator.

In fluoroscopic operation the detecting resistors 2.5Ω and 500Ω are connected in parallel by a relay, and in fluoroscopic operation the relay opens and the resistor is 500Ω alone.

The detected current enters A22 and appears at CP27 MA. The relation between the voltage at CP27 MA and the tube current is given by a ratio of about 1 V /2 mA in fluoroscopy and about 1 V /400 mA in radiography.

(b) Tube current measuring circuit for radiography

As shown in Fig. 4.5.4, a measured tube current signal MA and a set current signal MAO is input to a differential amplifier A22 and the differential output is input to pin 5 of A22. The output level of A22 is adjusted by VR1 MAM ADJ and appears at CP38 MAM. The relation between the voltage at CP38 MAM and the tube current is given by a ratio of 5 V /1000 mA in radiography.



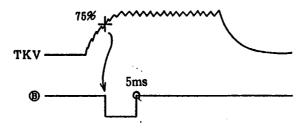


Fig. 4.5.4 Tube current measuring circuit for radiography

Whereas this "MAM" is output to the console as "TMA" in radiographic operation, the set current signal for radiographic tube "RMA" is output as "TMA" for 5 msec from the beginning of tube current measurement in radiographic operation.

(c) Tube current measuring circuit for fluoroscopy

As described in section (a), the tube current detecting resistor is about 500Ω in fluoroscopic operation. In the same way as in radiographic operation, a voltage proportional to a tube current appears at CP27 "MA" with a relation of about 0.5V / 1mA.

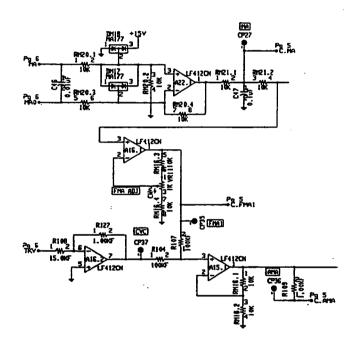


Fig. 4.5.5 Tube current measuring circuit for fluoroscopy

CVC corrects MA, because it includes a current flowing through the voltagedividing resistor in the high-voltage transformer.

Note: When the high voltage is 100 kV, the leak current is $\frac{100 \text{kV}}{150 \text{M} \times 2} = 0.333 \text{ mA}$. Because a tube current of 1 mA leads to 1 V at FMA, the correction voltage 0.333 V should be subtracted.

The input voltage at pin 3 of A15 is adjusted by VR11, FMA ADJ, so that the voltage at CP36, AMA, is related to the tube current by a ration of 4 V/4 mA.

(4) Over-current protection circuit

This circuit checks over-currents in radiographic and fluoroscopic operation.

The following cases are determined as an over-current.

In radiography: Set value + 200 mA

600 mAs

In Fluoroscopy: 10 mA

(a) RmA OVER

Refer to Fig. 4.5.6.

This circuit operates when a measured tube current MAM in radiographic operation exceeds 200 mA more than a set value RMA. In pulsed fluoroscopic operation it operates when a measured tube current MAM exceeds 200 mA.

(b) 600 mAs OVER

Refer to Fig. 4.5.6.

This faulty operation detecting circuit functions when S-24 is turned ON. It operates when mAs value in fluoroscopic operation exceeds 540 mAs.

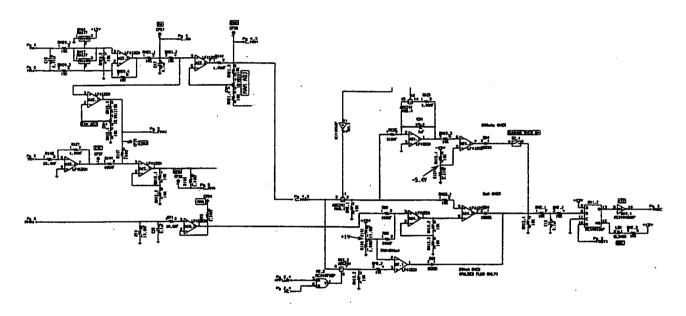


Fig. 4.5.6

(c) FOC

Refer to Fig. 4.5.7.

This circuit operates when a measured tube current AMA in fluoroscopic operation exceeds 10 V (corresponding to 10 mA). The FOC signal is transmitted to EMC-96 board and stops the fluoroscopic operation. Releasing a foot-switch can reset FOC.

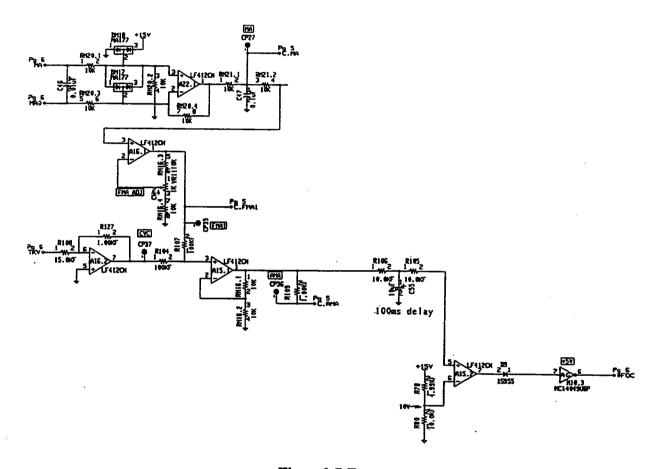


Fig. 4.5.7

4.6 Signals in mA POWER-96 board

Signal	Content	Remark
*ROC	Radiographic tube over-current signal	
*FOC	Fluoroscopic tube over-current signal	
*EXR 1	X-ray ON signal	
*FRST	FAULT reset signal	
PKV	Set tube-voltage signal (in all operational modes)	7.5V/150kV
TKV	Measured tube-voltage signal	7.5V/150kV
RMA 1	Set radiographic tube current signal	5V/1000mA
TMA	Measured radiographic tube current signal	5V/1000mA, 1V/1mA
MA	Manuscript sized	
MAO	Measured tube current signal	
FVF	Setting signal for fluoroscopic filament voltage	
TV 7	G: 1 G: 1 G: TVI Color	
TV 2	Signal proportional to TV brightness	
*FOSM	Selection signal for small focus	
*PFLUOS	Selection signal for pulsed fluoroscopic operation	
FMACOM	Unused (for SID correction)	
*MASP	Stop signal for filament heating	
LMT	Limit value of filament heating	
*FL	Selection signal for fluoroscopic operation	
FVR	Setting signal for radiographic filament voltage	
CHECK	Check mode signal	
*IFOVER	Signal of faulty filament heating	
*XR IN	Exposure signal	
*KC IN	READY signal	
*OKF	Acknowledge signal of filament heating	

5. Mother-96 board

5.1 Input/output signal for power supply

When supply voltage is +10% more or -25% less than the standard value, a signal LVOVR is output. In READY operation this signal is inoperative.

Refer to Fig. 5.1.1, where the power on/off and FRST (fault reset) circuits are shown.

(1) J96 connector

Signal	Content	Remark
LN12	Power (12 V)	
LNON	Power ON signal	
LNOF	Power OFF signal	
PGND	GND signal	
FRST	FAULT releasing signal	•
+15V	+15 V power	
GND	GND signal	
KCC	READY operation signal	
FON	Fluoroscopic operation ON signal	
LOCK	Power supply voltage OK signal	
LVOVR	LV CONT trouble signal	

(2) J97 connector

Signal	Content	Remark
0LA	AC 10 V input	A.C. 1077
10LA	Power for LN 12	AC 10V
0LB	AC 100 V input	
100LB	Power for magnet	AC 100V

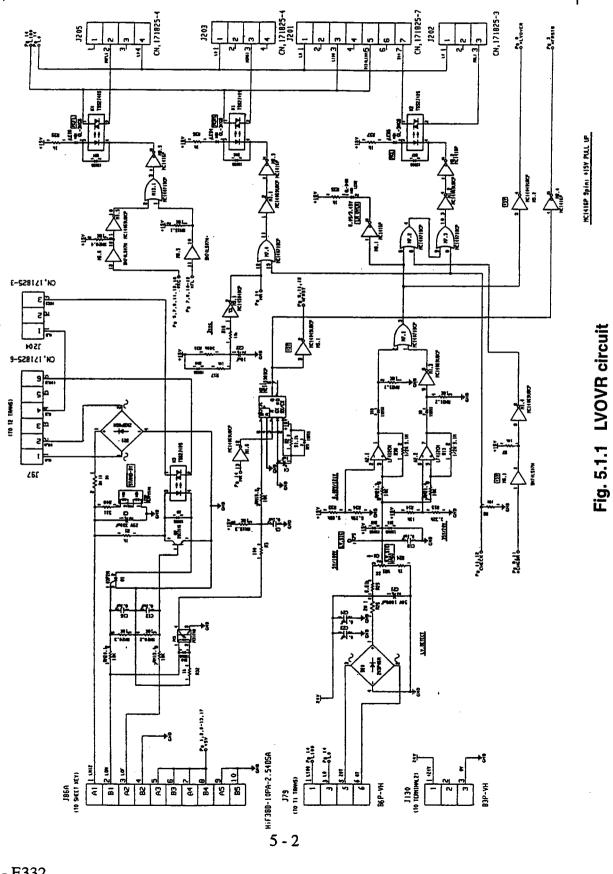
(3) J98 connector

Signal	Content	Remark
0LB	AC 100 X/	
100LB	AC 100 V output	AC 100V

(4) J100 connector (5P)

Signal	Content	Remark
0LB	AC 100 V output	
MGL 1	LINE magnet ON signal	AC 100V

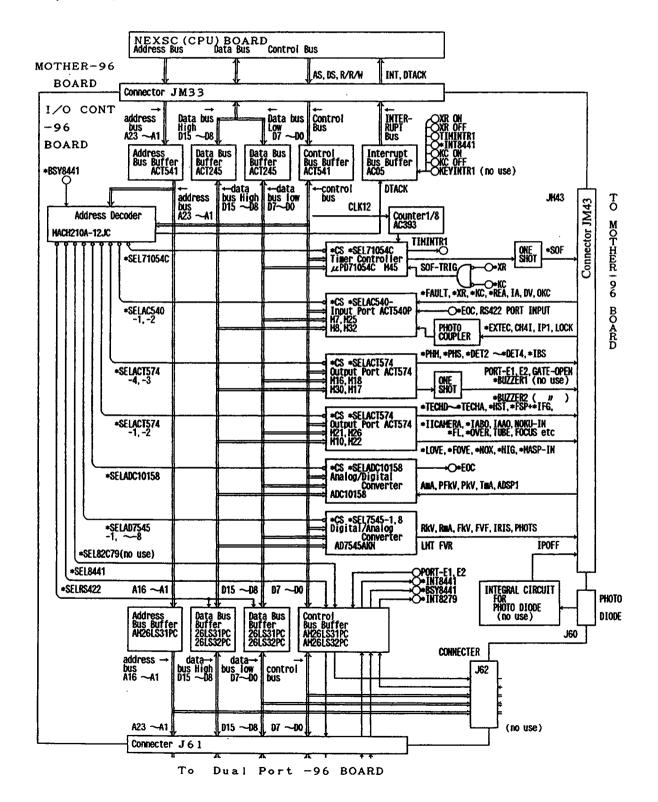
24 V rectified by 0T-20T are used in EMC-96, TERMINAL-96, etc. On the other hand, 24 V for driving gates are supplied by an independent switching power. Do not connect each other.



6. I/O CONT-96 board

6.1 Schematic diagram of I/O CONT-96 board

Schematic block diagram of I/O CONT-96 board is shown including MEXSC (CPU) board, Timer IC (μPD71054C), A/D converter IC (ADC10158), D/A converter IC (AD7545), INPUT IC (ACT540, 373), OUTPUT IC (ACT574), connectors, data buses, etc.



6.2 Input/output signals of I/O CONT-96 board

[1] Table of input/output signals

Input/output signals on I/O CONT-96 board are shown below.

For circuit mark r~w, refer to "6.2 Input/output signals of I/O CONT-96 board, [2] Input/output circuit", for k~p refer to "13.3 EXT CONT-96 board, [2] Input/output circuit", and for a~j refer to "7.31 Input/output signals on EMC-96 board, [2] Input/output circuit".

Connector	Connectio n diagram Page	Pin No	Designation	In / Out	Circuit	Significance	Destination
JM33	11/12	A-1				DC power	MOTHER-96
		B-1				_	
1		C-1	+5V	In		+5 V input	
j ,		A-2				_	•
		B-2					ļ
		C-2					
		A-3					
		B-3	+15V	In		+15 V input]
		C-3		<u> </u>			
		A-4					
		B-4	-15V	In		−15 V input	
	0/10	C-4					
	9/12	A-6	*IPOF	Out		X-ray cutoff signal from photodiode	E. M. C96
	-	B-6	*E370			integrating circuit (unused)	P. C. B.
		C-6	*EXR	In		Radiographic and fluoroscopic	
	1/12	A-11	*O-EXTINIR7	0		XRAYON signal	
	1/12	B-11		Out	g "		NEXSC
		C-11	″ 6 ″ 5	"	"		(BASE)
	Ì	A-12	" 3 " 4	"	"	Interrupt Signal	·
		B-12	<i>"</i> 3	"	"		
		C-12	<i>"</i> 2	"	"		
		A-13	*O-EXTINIRI	"	"		
		B-13	O-GATE	In	a	-	
<u> </u>		C-13	OUT-FC2	"	"		
i i		A-14	OUT-FC1	"	11		
]		B-14	OUT-FCO	"	"		
	ŀ	C-14	*OUT-AS	"	"	Control Signal	
		A-15	*OUT-LDS	"	"		
		B-15	*OUT-UDS	"	"		
		C-15	OUT-R/*W	"	"		
		A-16	O-DTACK	Out	g		
	ſ	B-16	OD [15]	In	а		,
	1	C-16	″ [14]	"	"		
	j	A-17	" [13]	"	"	Data Bus	İ
		B-17	″ [12]	"	"	Data Dus	1
		C-17	" [11]	"	"		ļ
		A-18	" [10]	"	"		

Connector	Connectio n diagram Page	Pin No	Designation	In / Out	Circuit			Signific	ance	Destination
JM33		B-18	OD [9]	In	a					NEXSC
110122	1/12	C-18	/ [8]	"	"					(BASE)
		A-19	" [7]	"	"		(2222)			
1		l		,,	"		1			
	}	B-19	" [6]	! !					•	
		C-19	<i>"</i> [5]	"	"	Da	ta Bus			1
ļ		A-20	<i>"</i> [4]	"	"					
		B-20	" [3]	"	"					1
]		C-20	" [2]	"	"					
j	\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \	A-21	"[1]	"	"					1
	ļ	B-21	" [0]		"	<u> </u>			 	
ļ	1/12	C-21	OA [23]	In	а]				}
1	1	A-22	" [22]	"	"					
]		B-22	" [21]	"	"]				
}	1	C-22	" [20]	"	"]]]]		
	1	A-23	<i>"</i> [19]	"	"					1
Į.		B-23	<i>"</i> [18]	"	"	ļļ				1
1		C-23	<i>"</i> [17]	"	"	i i				1
1	1	A-24	<i>"</i> [16]	"	"					1
1	1	B-24	<i>"</i> [15]	"	"	1 1]
Į.	1	C-24	<i>"</i> [14]	"	"					1
	ļ	A-25	<i>"</i> [13]	"	"					1
		B-25	<i>"</i> [12]	"	"	Ad	iress Bus	3		
1		C-25	" [11]	"	"	1 1				
		A-26	" [10]	"	"					1
1	-	B-26	" [9]	"	"	}				1
l		C-26	" [8]	"	"	[1
	1	A-27	" [7]	"	"					
1	1	B-27	" [6]	"	"					
1		C-27	" [5]	"	"	1 1				1
1	İ	A-28	" [4]	"	"					
	1	B-28	/ [3]	"	"	1 1				1
İ		C-28	" [2]	"	"		-			{
		A-29	"[1]	"	"					-
		B-29	*O-RESET	4	a	1		r signa		
		C-29	O-CLK12	_	"	CLOC	K [12M	Hz] INP	UT SIGNAL	
	5/12	A-30	*TID	Out) ~	Ba	ckup-tin	ner set si	gnal {1:5V}	→ EMC-96
į .	ļ	B-30	*TID	"	"	1 1	egative le		{0:0V}	
		C-30	*TIB	"	"] — `	Ū	U ,	(,	1 {
			Set second	i				selection	Backup time	
	-					*TID	nal (bina *TIC	*TIB	-	1
			1.0ms ~	120n	ns	1	1	111111111111111111111111111111111111111	250msec	
1			j	140ms ~ 250ms			1	0	0.5 sec	ļ [
			1	280ms ~ 500ms 560ms ~ 1.0sec			0	1	1.0 sec	
	İ		l l				0	o	2.0 sec	
			•	1.1sec - 2.0sec			i	1	4.0 sec	1
			2.2sec ~			0	i	o	8.0 sec	
			4.5sec ~			0	o	i	16.0 sec	
1	1		9.0sec ~			o	ő	o	32.0 sec	
L						1		1	1	

Connector No	Connectio n diagram Page	Pin No	Designation	In / Out	Circuit	Significance	Destination
ЛМ33	5/12	A-31	GND	In		7	Mother-96
]	B-31	"	"			
1]	C-31	"	"		GND inputs	
1	<u> </u>	A-32	"	"		GND mpus	
		B-32	"	"			
		C-32	"	"			

Connector No	Connectio n diagram Page	Pin No	Designation	In / Out	Circuit	Significance	Destination
JM43	6/12	A-1	AMA	In	r	Measured fluoroscopic tube current (now unused) (4V/4mA) (Adjustment trimmer VR4) (CP5)	mA POWER -96 P. B.
		B-1	TMA	In	"	Measured (fluoroscopic / radiographic) tube current (5V/1000mA) (Adjustment trimmer VR3) (CP4)	
		C-1	PFkV	In	"	Measured fluoroscopic tube voltage (5V/100kV) (Adjustment trimmer VR1) (CP3)	ANALOG-96 P. B.
		A-2	PkV	In	"	Measured radiographic tube voltage (5V/100kV) (Adjustment trimmer VR5) (CP2)	
	B-2 A/DSP1 In " Preparatory A/D input (Adjustment trimmer VR2) (CP1)						
	7/12 C-2 LMT Out s		Maximum heating current for filament protection M58 (7V/700 A) (Adjustment trimmer VR8) (CP6)	mA POWER -96 P. B.			
		A-3	RkV	Out	"	Set value of radiographic tube voltage M47 (5V/100kV) (Adjustment trimmer VR10) (CP10)	ANALOG-96 P. B.
		B-3	FVF	Out	"	Set current for fluoroscopic filament heating M43 (5 V/5.00 A) (Adjustment trimmer VR7) (CP8)	mA POWER -96 P. B.
		C-3	RMA	Out	"	Set value of radiographic tube current M51 (5V/1000mA) (Adjustment trimmer VR11) (CP11)	
		A-4	FVR	Out	"	Set current for radiographic filament heating M72 (5V/5.00 A) (Adjustment trimmer VR13) (CP13)	
		B-4	FkV	Out	"	Set value of fluoroscopic tube voltage M79 (5V/100kV) (Adjustment trimmer VR12) (CP12)	ANALOG-96 P. B.
		C-4 IRIS Out " Set value of iris release M66 (Adjustment trimmer VR9) (CP9)			MOTHER-96 JM2 → IRIS		
		A-5	РНОТО	Out	"	Set reference voltage for cutoff by photo-timer density M37 (Adjustment trimmer VR6) (CP7)	PH. CONT PH. POWER

Connector No	Connectio n diagram Page	Pin No	Designation	In / Out	Circuit		Sign	ificance		Destination
JM43	3/12	B-5	*FLTD	In	a					EMC-96 →
ł		C-5	*FLTC	"	Fault input signal (negative logic)					
1		A-6	*FLTB	"	(1					
į		B-6	*FLTA)		lo):0V ∫	<u> </u>
	*FL	Т		,					,	
}	DCB			-		ficance			In	dication
	111				Not f					
ļ	111				Not f		_::4:	·	56 5	70
	110		7Open 5Open					is not confirmed. is not confirmed.	l	7Open 5Open
ļ	101		Open			of operation	-		Door	
	101		RMAL OVER	-		-		e has worked.	ı	RMAL OVER
	100		RTOR BRAKE	: }		er is faulty.				TOR BRAKE
	100	0 HVT	NOt CONNECTE	ED	High	-voltage ger	nerator is no	t connected.		NOT ONNECTED
	011	1 Char	ge Brake		Charg capac	ged voltage itor is fault	of primary : y.	smoothing	CHAI	RGE OVER
	011					ent heating	IF OVER			
	010		over kV over)		Set tu	ibe voltage	PkV (OVER		
	010		over sured kV over)	,	Measured tube voltage is out of permissible TkV range.					OVER
	001	1 Radio	o. Over current			ured radiog issible range		OGRAPHY R CURRENT		
	001	0 Fluo.	Over current			ured fluoros issible range		current is out of		GRAPHY R CURRENT
	000	1 Line	Voltage Over		Powerange		ltage is out	of permissible	LINE OVE	VOLTAGE
	000	0 Powe	r Down		Voltage of -15 V power is down.					POWER N
	3/12	C-6	*IAB	In	a	*IAB	Input signa	l for changing	1 · 5V)	EMC-96 →
		A-7	*IAA	"	"	*IAA	visual field	(negative logic)	0:0V	
							*IAA-IN			
						1	1	the largest IF	71	
						1	0	the large IF	72	
]						0	1	Ī	73	ĺ
						0	0	the small IF	₹4	
		B-7	*DV1	In	a	*DV1-				TERMINAL
		C-7	*DV2	"	"	*DV2		signal for operation	n	-96
		A-9	*DV3	11	"	*DV3 —	with divid	ed film		_
		B-9	*GR1	In	a	*GR1	1			
		A-8	*KC	In	a		on start signart of heat	nal for operation		EMC-96 →
		B-8	*REA	"	"			ing) gnal for operation		

Connector	Connectio n diagram Page	Pin No	Designation	In / Out	nit		Sic	gnificance			Destination
ပ္သီး	Con Page dir	1111110	Designation	In /	Circuit						Destination
JM43	3/12	C-8	*OKC	In	a	Charging volt	age a	acknowledg	ge sign	al	ANALOG-96
							for primary smoothing capacitor				→
		C-9	*INPSP7	In	a	Spare input [7	TL	level]			
Ì		A-10	*INPSP8	"	"	Spare input [TTL level]					
İ		B-10	*XR-IN	"	"	Radiographic X-ray signal				EMC-96 →	
	4/12	C-10	*EXTEC	In	t	*EX-TECHC				-	J8 →
		A-11	*EXTEB	"	"	*EX-TECHB		for operatio			MOTHER-96
İ		B-11	*EXTEA	"	"	*EX-TECHA	٦((code) (neg	ative lo	ogic)	\rightarrow
										$ \begin{cases} 1:5V \\ 0:0V \end{cases} $	
}				1		*EX-TECH				(0.01)	
							ratio	n method	Abb	oreviation	
1	1					111 Unuse			7 =	-	1
•	1					110 Gener	al rac	diography	G	R	
1						4		diography l	BI	U1	
						100 Auto-			0		
						011 Tomo		-	PI	L	
						· •		diography 2	В	U2	
						001 Unuse	d		-	-	
						000 Unuse	d		-	-	
		C-11	*RDER	In	t	Selection sign	al fo	r reader op	eration	<u> </u>	
		A-12	EXPWB	In	t	Common pow			gnal in	put	
		B-12	*INSP12	"	"	Spare input [c					
1	İ	C-12	*INSP13	"	"	Spare input [c	urrei	nt loop]			
}		A-13	*OUTSP2	Out	g	Spare output					
		B-13	*OUTSP3	"	"	"					,
		C-13	*OUTSP4	"	"	"					
		A-14	*OUTSP5	"	"	"					
	1	B-14	*OUTSP6	"	"	,					
		C-14	*OUTSP7	"	"	"					
		A-15 B-15	*OUTSP8 *FDS3				1 0010	ation simo			DII CONT
1	1	C-15	*FDS2	Out	g "	Pick-up field Three select		-	_		→ PH. CONT PH. POWER
1	1	A-16	*FDS1	"	"	POWER-96		-			-96
•			1201			1011220	Dou	aa (nogaa i	o logic	[1:5V]	,,
]						*FDS1 *FI	OS2	*FDS3	Diale :	(0:0V)	
]		,					<u> </u>	1	FICK-	up field	ļ
1)	1 1			
						1	1	0			
		B-16	*Bacomp	Out	g	Selection signal for compensating		→ PH			
						barium covering ratio					POWER-96
1		C-16	*OUTSP0	Out	g	Spare output					
		A-17	*OUTSP11	"	"	"					
	}	B-17	*OUTSP12	"	"	"]
}		C-17	*OUTSP13	"	"	"					
1		A-18	*OUTSP14	"	"	<i>"</i>					
	3/12	B-18	*PHM	Out	g	PH. Multi sele	ectio	n signal			→ PH. CONT PH. POWER

Connector	Connectio n diagram Page	Pin No	Designation	In / Out	Circuit		Significance	Destinati	ion
JM43	3/12	C-18	*DET4	Out	g	Photo-tim	er receptor number 4 (IFG)	→ PH. CO	ONT
					•		selection signal		
		A-19	*DET3	"	"	Photo-tim	-96		
		·					selection signal		
İ		B-19	*DET2	"	"	Photo-tim	Photo-timer receptor number 2 (IFG)		
İ		C-19	*IBS	0		TDC colors	selection signal	→ PH. POV	WED
		C-19	100	Out	g	ID2 select	tion signal	ANALO	
		A-20	*PHS	Out	g	PH. Singl	e selection signal	→ PH. CO	
							C	PH. POW	ÆR
								-96	
		B-20	*Buzzer1	Out	g		[Unused]		
	5/10	C-20	*Buzzer2	"	"	37	[Unused]	FNC	
	5/12	A-21 B-21	*SOF *TECHA	Out	g	X-ray cut	off signal from timer	→ EMC-	90
		C-21	*TECHA	Out "	g ″	Select	ion signal output		
		A-22	*TECHC	"	"	1 1	AC exerction	}	
		B-22	*TECHD	"	"		(0:0V		
						*TECH			
						DCBA	Operation method	Code	
		;				1111	Unused		
						1110	General radiography	GR	
ļ						1101	Bucky's radiography 1	BUI	
						1100 1011	Bucky's radiography 2 Tomography	BU2 PL	
						1011	Auto-changer	ox	
						1001	MAMMO radiography (unused)	MAMM	
						1000	Direct spot filming	FSP	
						0111	Indirect spot filming	IFG CRS	
						0110	Indirect serial radiography	CKS	
						0100	Direct serial radiography	SEST	
						0011			
						0010 0001	D04 E	DOD	
						0001	DSA radiography CINE radiography	DSP CIN	
1		C-22	*OUTSP16	0			1	1	
		A-23	*HST	Out	g g		put signal [TTL level] tch effective signal	→ EMC-	96
		B-23	*FSP1+	// //	. "		th-speed radiography or	-7 LIVIC-	7 0
		_ 	*IFG			_	ct high-speed radiography		
					.		ed radiography selection signal		
		C-23	*IICAME	Out	g	I.I. indired	ct camera selection signal		
		A 04	RA-IN			***			
		A-24 B-24	*IAB-0 *IAA-0	Out	g "	*IAB0 — *IAA0 —	Signal output for changing visual field (negative logic)	→ EMC-	96
	.	J-24	T-74-A	"		1220	visual field (negative logic)	,	
						*IAB0	TIAAU Visual field	S 1	
						$\begin{bmatrix} 1\\1 \end{bmatrix}$	largest IF1 large IF2		
						o l	1 middle IF3		
						0	0 small IF4		

Connector	Connectio n diagram Page	Pin No	Designation	In / Out	Circuit	Significance	Destination
JM43	5/12	C-24	*NOKU-IN			Signal to invalidate double exposure	-→ EMC-96
•						prevention circuit	P. B
		A-25	*LOWmA	"	"	Selection signal for low tube current	1.2
		B-25	*FSAON	"	"	Signal to rotate X-ray tube anode in	
						fluoroscopic operation	
		C-25	*SPSWE	"	"	Signal to validate high-speed operation	
		A-26	*OUTSP15	"	"	Spare output signal [TTL level]	
		B-26	*FL	"	"	Signal to enable fluoroscopic operation	
		C-26	*LOVE	"	"	Signal indicating to be out of conditions	
						for radiographic operation	
		A-27	*HOVE	"	"	Signal indicating to be over anode-heat-	
						capacity of X-ray tube (unused)	
		B-27	*FOVE	"	"	Signal indicating 5 minutes over in	
		C 05	*****			fluoroscopic operation	
}		C-27	*NOX	"	"	Signal to prohibit X-ray exposure	
		A-28 B-28	*HIG	"	"	Signal to rotate X-ray tube anode in high speed	
		C-28	*MASP-IN *SCD	"	"	Signal to stop operation of heating circuit	
		C-20	SCD	"	"	Signal to invalidate a circuit function to	
		A-29	*OUTSP1	"	"	assure actions of general radiographic devices Spare output signal [TTL level]	
]	ļ	B-29	*TUA	Out	g	X-ray tube number selection signal	→ EMC-96
.		C-29	*TUB	"	0 //	- 1 (management 1 mm)	→ ENIC-30
						$ \begin{array}{c} \text{(negative logic)} \\ \begin{cases} 1:5V \\ 0:0V \end{cases} \end{aligned} $	•
[]						1 1	
						*TUA *TUB X-ray tube number	
			i			1 1 Unused 1 0 TUBE 1	
						0 1 TUBE 2	
			·			0 0 TUBE 3	
	ŀ	A-30	*OUTSP19	Out	g	Spare output signal [TTL level]	
	Ì	B-30	*FOB	Out	g	X-ray tube focus selection signal	→ EMC-96
		C-30	*FOA	"	"	(negative logic) [1:5V]) Livic-yo
.						{0:0v}	
ł							
	}			Ì		*FOB *FOA X-ray tube focus	
	J	•	-			1 Unused	
						1 0 Unused Small focus 0 1 Large focus	
				[0 1 Large focus 0 0 Micro focus (unused)	
	}	A 31	CNE	. 		Where rooms (unused)	22 2 3 3
		A-31	GND	In			Mother-96
	Į	B-31 C-31	"	"			
	.	A-32	"	"		GND input	
	Ì	B-32	",	"			
		C-32	"	"			
		C-32		″_			

	Connector No	Connectio n diagram Page	Pin No	Designation	In / Out	Circuit	Significance	Destination
	J60	10/12	1	PH-DET	In		Photo-current input signal from photo-diode	PH. DIODE
ı		į					(unused)	
l			2	GND	Out		GND output	
ı			3	+15V	"		+15 V output	
			4	-15V	"		−15 V output	

Connector No	Connectio n diagram Page	Pin No	Designation	In / Out	Circuit		Significance	Destination
J61	8/12	A-1	A1-	Out	v			DUAL PORT
		B-1	A1+	"	"			-96 J61
		A-2	A2-	/ /	"			
		B-2	A2+	/ /	11			
		A-3	A3-	"	"			
		B-3	A3+	/	"			
		A-4	A4-	/ /	"			
		B-4	A4+	//	11			
		A-5	A5-	"	11			
1		B-5	A5+	"	"			
		A-6	A6-	"	"			
		B-6	A6+	"	"			
		A-7	A7-	//	4			
		B-7	A7+	"	"			
		A-8	A8	"	"		i	
		B-8	A8+	"	"		Adress Bus OUT PUT	
ł		A-9	A9	"	"			
		B-9	A9+	"	"			
		A-10	A10	"	"			
		B-10	A10+	"	"			
		A-11	A11-	"	"		·	
}	ł	B-11	A11+	"	"			
		A-12	A12-	"	"			
		B-12	A12+	"	"			
		A-13	A13-	"	"			
		B-13	A13+	"	"			
Ì		A-14	A14-	"	"			
Į		B-14	A14+	"	"			
		A-15	(A15–)	"	"			
ŀ		B-15	(A15+)	"	"		·	
		A-16	(A16–)	"	1.			
l		B-16	(A16+)	"	"	_		
1	9/12	A-17	D0-	In/out				
		B-17	D0+	"	"			
		A-18	D1-	"	"			
		B-18	D1+	"	"		Data Bus	
		A-19	D2-	"	"		Dum Dus	
		B-19	D2+	"	"			
		A-20	D3-	"	"			
		B-20	D3+	"	"		 	

Connector No	Connectio n diagram Page	Pin No	Designation	In / Out	Circuit	Significance	Destination
J61	9/12	A-21	D4-	In/out	w		DUAL PORT
		B-21	D4+	"	"		-96 J61
	!	A-22	D5-	"	"		į
		B-22	D5+	1 , 1	"		Ì
		A-23	D6-	1	"		
	[B-23	D6+	"	"		}
	[i	A-24	D7-	1/	"		
		B-24	D7+	"	"		
	<u>'</u>	A-25	D8-	//	"		
	<u> </u>	B-25	D8+	1/	4	Data Bus]
ļ		A-26	D9-	"	"		1
		B-26	D9+	1/	"		
		A-27	D10-	"	"		1
	i 1	B-27	D10+	"	"]
		A-28	D11-	"	"		1
ļ		B-28	D11+	"	"		
ŀ		A-29	D12-	"	"		
	j i	B-29	D12+	"	"		Ì
		A-30	D13-	In/out	w	7	1
1		B-30	D13+	1/	"		
ļ	ļ	A-31	D14-	"	"		
		B-31	D14+	1/	"	Data Bus	Į į
	1	A-32	D15-	"	"		ĺ
1		B-32	D15+	"	"		
1	8/12	A-33	*READ-	Out	V	READ SIGNAL	→
1	ļ	B-33	*READ+	"	"		DUAL PORT
		A-34	*WRL-	Out	v	WRITE SIGNAL (LOW D0 ~ D7)	-96 J61
	}	B-34	*WRL+	"	"		
	Ì	A-35	*WRH-	"	"	WRITE SIGNAL (HIGH D8 - D15)	.]
1	}	B-35	*WRH+	"	11		<u> </u>
1	ŀ	A-36	*SEL8441-	Out	V	8224 menory Select SIGNAL	
		B-36	*SEL8441+		11		
		A-37	*BSY8441-	1	u	8224 menory BUSY INPUT SIGNAL	DUAL PORT
		B-37	*BSY8441-		"		-96 J61Æ
		A-38	*INT8441-		u	8224 menory INTERRUPT INPUT SIGNAL	
		B-38	*INT8441+	+	"		
1		A-39	*SPE1-	Out			→ DIM DODT
1		B-39	*SPE1+	"	"		DUAL PORT
1		A-40	*SPE2-	//	"		-96 J61
1	-	B-40	*SPE2+	//	//	1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1	DIM DODT
1	9/12	A-41	PW (+15V		V	Acknowledge signal for cable connection	DUAL PORT
-	<u></u>	B-41	*CNET (GNI	_	//	The state of the s	-96 J61 →
	8/12	A-42	*XR-	Out	1	X-ray radiation signal	→ DUAL PORT
		B-42	*XR+	"	"	[for LED display, BUZZER]	-96 J61
1		A-43	*KC-	//	1"	Signal for preparation of radiographic	-40 10I
L	1	B-43	*KC+		"	operation [for LED display]	

Connector No	Connectio n diagram Page	Pin No	Designation	In / Out	Circuit	Significance	Destination
J61	8/12	A-44	(unused)				\rightarrow
		B-44	"	"	"		DUAL PORT
}		A-45	"	"	"		-96 J61
1		B-45	"	"	"		
		A-46	"	"	"		'
		B-46	"	"	"		,
1		A-47	"	"	"		;
ļ		B-47	"	"	"		,
		A-48	"	"	"		!
		B-48	"	"	"		
Ì		A-49	GND	In			
1		B-49	"	"		GND output	
1		A-50	"	"		GIAD output	
		B-50	"	"			

Connector	Connectio n diagram Page	Pin No	Designation	In / Out	Circuit	Significance	Destination
J62	8/12	A-1	A1-	Out	V	All J62 connectors unused	SHEET
		B-1	A1+	"	"		PANEL
		A-2	A2-	"	"	Adress Bus Out PUT	[no use]
}		B-2	A2+	"	"		
	9/12	A-3	D0	In/out	w		
1		B-3	D0+	"	"		
		A-4	D1-	"	"		
1		B-4	D1+	"	"		
İ		A-5	D2-	"	"		
		B-5	D2+	"	"		
		A-6	D3-	"	"		į .
i		B-6	D3+	"	"	Data Bus	
Ì		A-7	D4-	In/out	"	Data Dus	
1	1	B-7	D4+	"	"		
1	1	A-8	D5-	"	"		
1	İ	B-8	D5+	"	"		
	İ	A-9	D6	"	"	1	
	ļ	B-9	D6+	"	"		}
l	1	A-10	D7-	In/out	"		
	<u> </u>	B-10	D7+	"	"		<u> </u>
	8/12	A-11	*READ-	Out	v	READ SIGNAL	
		B-11	*READ+	"	"		ļ
]		A-12	*WRL-	Out	v	WRITE SIGNAL (LOW D0 ~ D7)	
		B-12	*WRL+	//	"		<u>]</u>
		A-13	A8-	Out	v	adress Bus OUT PUT	
		B-13	A8+	"	"	<u> </u>	
1		A-14	RESET-	Out	v	RESET SIGNAL OUTPUT	
	<u> </u>	B-14	RESET+	"	"	<u> </u>	

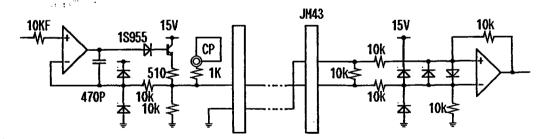
Connector	Connectio n diagram Page	Pin No	Designation	In / Out	Circuit	Significance	Destination
J62	8/12	A-15	*SEL8279-1-	Out	v		SHEET
		B-15	*SEL8279-1+	"	"		PANEL
		A-16	*SEL8279-2-	"	"		[no use]
		B-16	*SEL8279-2+	"	"	IC [8279] SELECT SIGNAL OUT PUT	
		A-17	*SEL8279-3-	"	"	IC [8279] SELECT SIGNAL OUT FUT	
		B-17	*SEL8279-3+	"	"		
1		A-18	*SEL8279-4-	"	"		
		B-18	*SEL8279-4+	"	"		
		A-19	*EXTINT1-	In	u	7	
		B-19	*EXTINT1+	"	"	IC [8279] INTR. SIGNAL IN PUT	
		A-20	*EXTINT2-	"	"		
		B-20	*EXTINT2+	11	"		
		A-21	*SEL8279-5-	In/out	"	7	
		B-21	*SEL8279-5+	"	"	IC [8279] SELECT SIGNAL OUT PUT	
		A-22	*SEL8279-6-	"	"	ie (0275) BEEEE GIGITAE COTTOT	
	_	B-22	*SEL8279-6+	-	"		
	9/12	A-23	PW (+15V)	In	"	Acknowledge signal for cable connection	
		B-23	*CNET (GND)	"		7 Toknow 20050 Signat for Guore Connection	
		A-24	GND	Out		7	
		B-24	"	"		GND output	
]		A-25	"	"			
		B-25	"	"		<u></u>	

[2] Input and output circuit

Input and output circuits for each signal are as follows.

[r] Analog signal input circuit [No. 1]

ANALOG-96 board mA POWER-96 MOTHER-96 I/O CONT-96 board



[s] Analog signal output circuit [No. 1]

I/O CONT-96 board

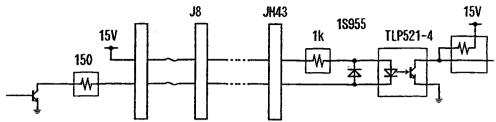
MOTHER-96

ANALOG-96 board mA POWER-96

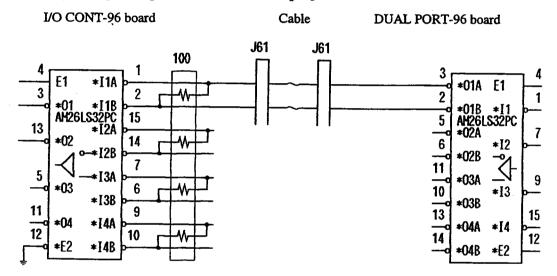
[t] Digital signal input circuit [No. 9]

External devices (YSF220, etc) MOTHER-96 I/O CONT-96 board

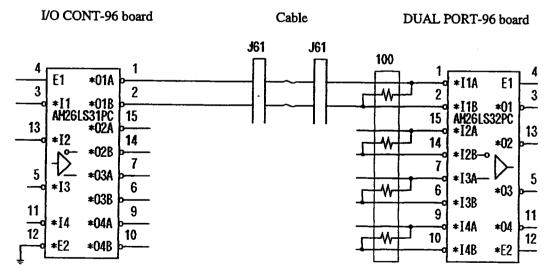
J8 JM43



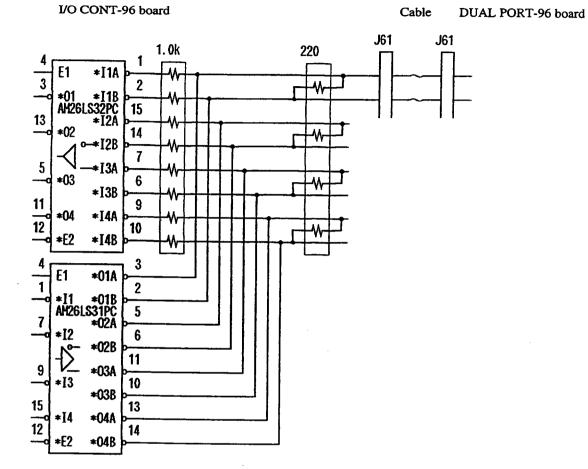
[u] Digital signal input circuit [422 I/F input]



[v] Digital signal input circuit



[w] Digital Input and output circuits [No. 1] (Data Bus)

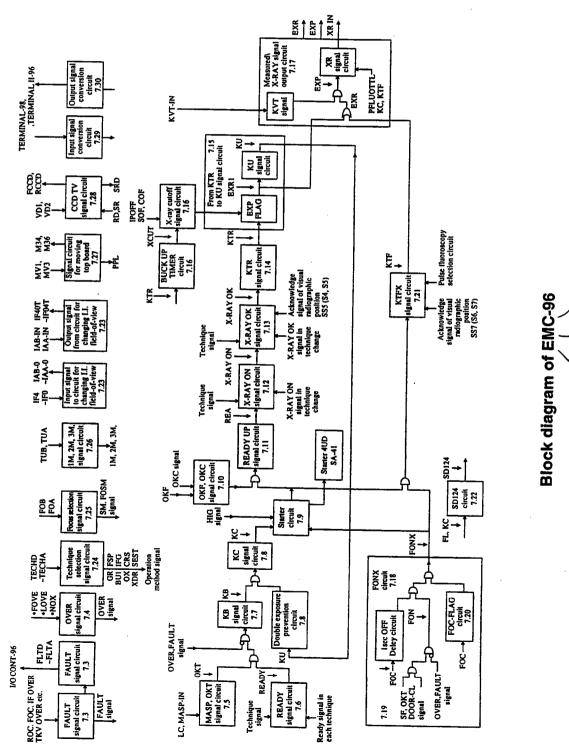


7. EMC-96 board

EMC-96 board controls external devices for X-ray radiation through TERMINAL-96 and TERMINAL II -96 (in both radiographic and fluoroscopic operation).

7.1 Block diagram of EMC-96 board

Block diagram of X-ray radiation control (in both radiographic and fluoroscopic operation) is shown below.

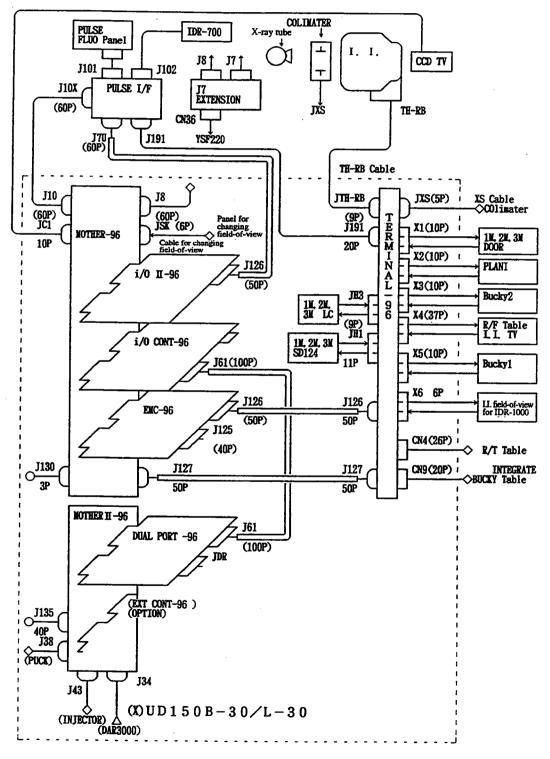


7 - 1

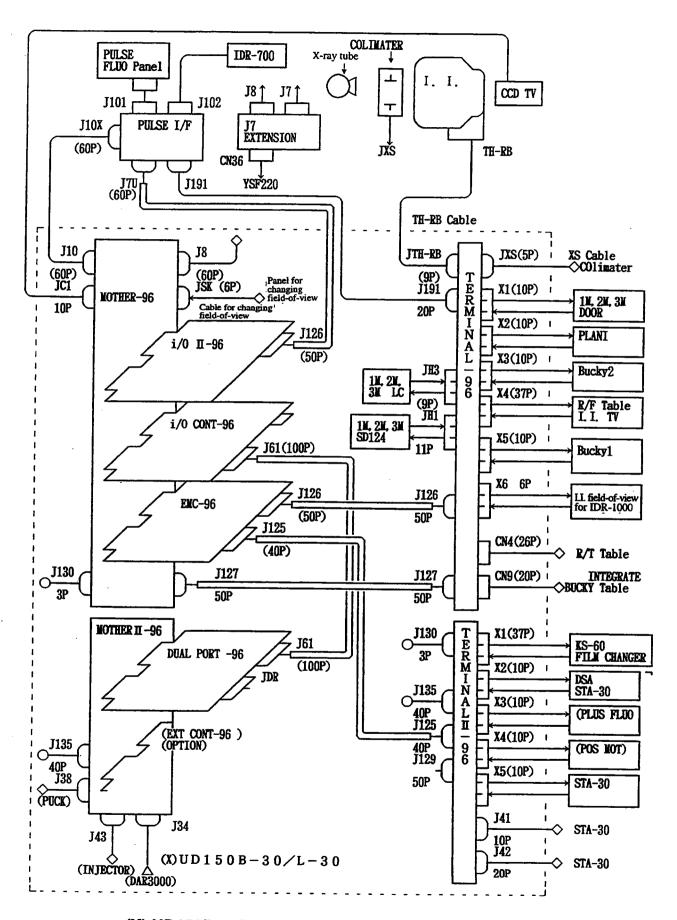
7.2 External device connection diagram

In accordance with combined external devices (film changer, DAR3000, etc.) optional control boards are added and their connections are changed.

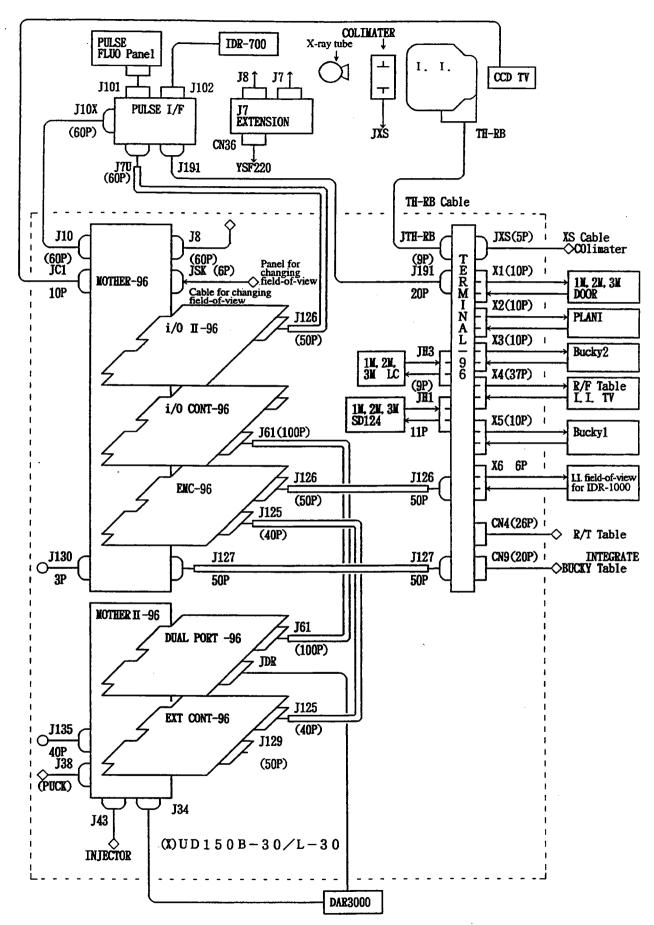
Connections between external devices and EMC-96 board, EXT CONT-96 board, TERMINAL-96, and TERMINAL II -96 board are shown below.



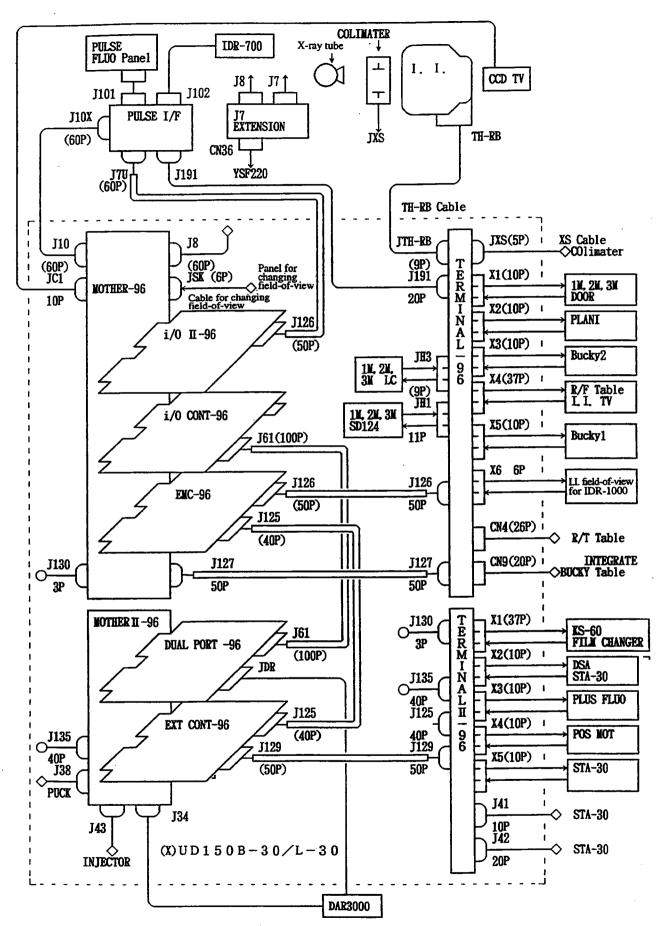
(X) UD150B-30/L-30 Connections of external devices (standard configuration)



(X) UD150B-30/L-30 Connections of external devices (standard configuration + ANGIO I/F)



(X) UD150B-30/L-30 Connections of external devices (standard configuration + DAR3000)



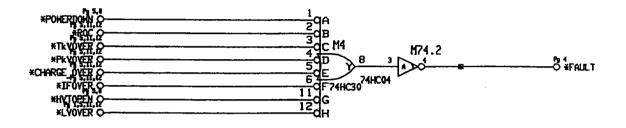
(X) UD150B-30/L-30 Connections of external devices (standard configuration + DAR3000 + ANGIO I/F)

7.3 FAULT signal circuit

(1) OVER-Brake signals from MOTHER-96

OVER-Brake signals from MOTHER-96 are transmitted to EMC-96 board through connector JM34.

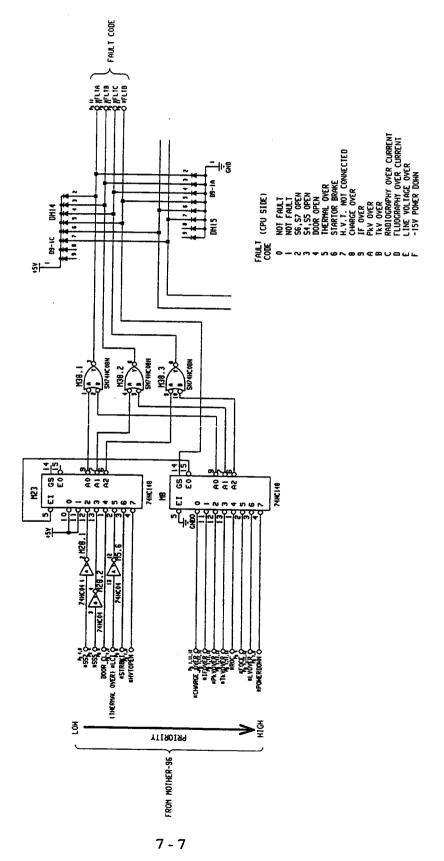
While these signals are outputted, READY operation for fluoroscopy can not be executed.



· Signa	JM34 Pin No	Significance	Indication
*POWER DOWN		Voltage of −15 V power is down	-15 Power Down
*ROC	C-10	Measured radiographic tube current is out of permissible range.	RADIO GRAPHY OVER current
*TkVOVER	A-11	Measured tube voltage is out of permissible range.	TkV over
*PkVOVER	B-11	Set tube voltage is faulty.	PkV over
*CHARGE-OVER	C-11	Charged voltage of primary smoothing capacitor is faulty.	CHARGE OVER
*IFOVER	A-12	Filament heating current is faulty.	IF over
*HVT OPEN (*OKHVT)	B-12	High-voltage generator is not connected.	H.V.T.NOT CONNECTED
*LVOVER	C-12	Power supply voltage is out of permissible range	Line Voltage Over

(2) FAULT signal to I/O CONT-96 board

OVER-Brake signals from MOTHER-96 are encoded to 4-bit signals (FLTA, FLTB, FLTC, and TLTD) and transmitted to I/O CONT-96 board through connectors JM44 and JM34.



FLTA ~ FLTD | FAULT signal output to I/O CONT-96 board

OVER-Brake signals inputted from each board in base rack are encoded to FAULT signals *FLTA ~ *FLTD (binary) (negative logic) and outputted to I/O CONT-96 board.

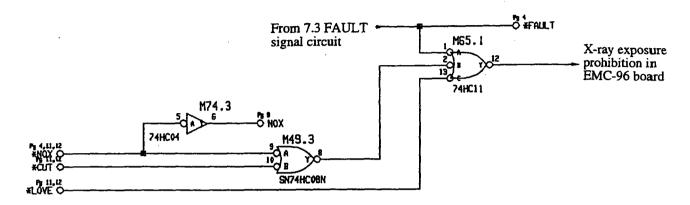
The CPU on NEXSC board reads the FAULT signals from I/O CONT-96 board and shows their messages on EL display.

	FAULT	signal	(binar	y)	OVER-Brake signa	als inputted from each board in base ra	ack
Signal		*F	LT				
Signal	D	С	В	Α	Encoder input	0::E	Message on EL
JM44 Pin No	B-5	C-5	A-6	B-6	signal	Significance	display
Value	1	1	1	1	not fault	Not fault	
	1	1	1	0	not fault	Not fault	
	1	1	0	1	S6, S7Open	Visual fluoroscopic position is not confirmed.	S6, S7 OPEN
	1	1	0	0	S4, S5Open	Visual radiographic position is not confirmed.	S4, S5 OPEN
	1	0	1	1	Door Open	Door of operational room is open.	Door Open
	1	0	1	0	THERMAL OVER	Thermal circuit of X-ray tube has worked	Thermal Over
	1	0	0	1	STARTOR BRAKE	Starter is faulty.	Startor Brake
	1	0	0	0	HVT OPEN	High-voltage generator is not connected.	H.V.T.NOT CONNECTED
	0	1	1	1	CHARGE OVER	Charged voltage of primary smoothing capacitor is faulty	Charge OVER
	0	1	1	0	IF OVER	Filament heating current is faulty.	IF.OVER
	0	1	0	1	PkV OVER	Set tube voltage is faulty.	PKV OVER
	0	1	0	0	TkV OVER	Measured tube voltage is out of opermissible range.	TKV OVER
	0	0	1	1	ROC	Measured radiographic tube current is more than set value of +200 mA.	RADIO GRAPHY Over Current
	0	0	1	0	FOC	Measured fluoroscopic tube current is more than 10 mA.	FLUOGRAPHY Over Current
	0	0	0	1	LVOVER	Power supply voltage is out of permissible range.	Line Voltage OVER
	0	0	0	0	POWER DOWN	Voltage of -15 V power is down.	-15 Power Down

7.4 OVER-Prohibition signal from I/O CONT-96 board

OVER-Prohibition signals (CUT, LOVE, NOX, and HOVE) are transmitted to EMC-96 board through MOTHER-96 board and connector JM44.

While these signals are outputted, READY operation can not be executed.

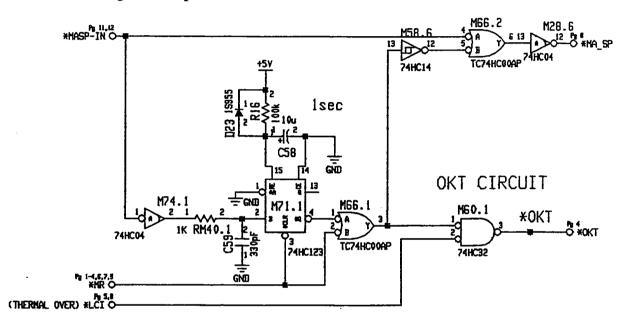


OVER-Prohibition signals from I/O CONT-96 board							
Signal (negative logic)	JM44 Pin No	Significance	Destination				
*NOX	C-27	Signal to prohibit X-ray exposure	I/O CONT-96				
*CUT	A-16	Signal to cutoff CINE-cut	I/O II -96				
*LOVE	C-26	Signal indicating to be out of conditions for radiographic operation	I/O CONT-96				
*HOVE	A-27	Signal indicating to be over anode-heat-capacity of X-ray tube (unused)	"				

7.5 MASP-OKT signal circuit

In heating by externally combined devices (STA-30, etc.) or changing a tube and focus, MASP-IN signal is output from I/O CONT-96 board and stops a heating control circuit in the apparatus.

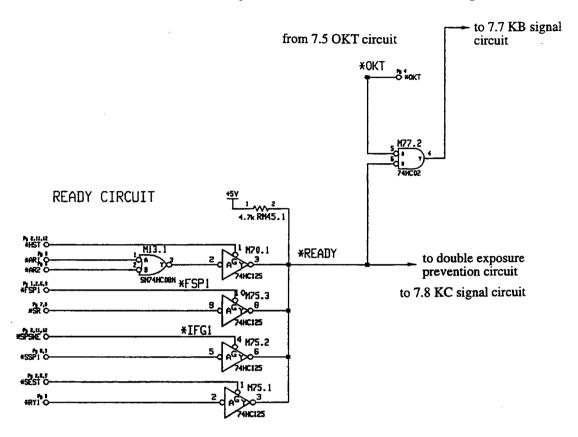
At the same time, after confirming that the thermal switch of X-ray tube is not operative, OKT signal is output.



MASP-IN	Signal to stop filament-heating control in mA POWER-96 board						
OKT	Acknowledge signal for thermal switch of X-ray tube and MASP OK						
MASP sign	nal is output in the following two cases.						
MASP-	IN signal continues to be output from I/O CONT-96 board (when STA-30 is selected).						
For 1 se	cond after MASP-IN signal was output from I/O CONT-96 board (when X-ray tube or focus was						
changed).						
OKT signa	l is output when both of the following conditions are satisfied.						
After 1	second has passed from the time MASP-IN signal was output from I/O CONT-96 board (from the						
time X-	ray tube or focus was changed).						
The then	mal switch of X-ray tube is OK.						
	For 1 second after X-ray tube or focus was changed lsec MASP-IN signal						
	*OKT signal OK OK						

7.6 READY signal circuit

This circuit makes a READY signal in accordance with a selected operation method.

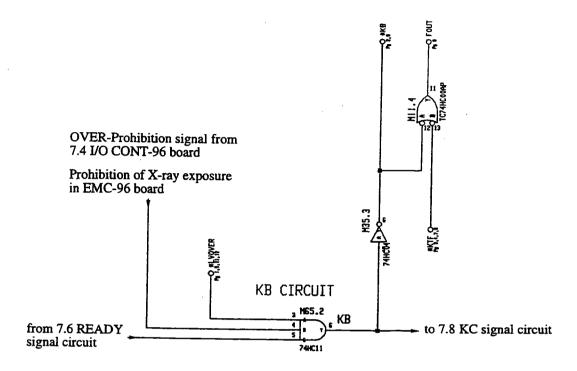


*READY	READY operation signal (negative logic)
This circuit output	s a READY operation signal by closing only the gate corresponding to a selected operation
method.	

Selected operation method	Corresponding READY operation signal	Content of the READY operation
HST	AR1 or AR2	AR1: READY signal of the hand switch on the console AR2: READY signal from terminal AR2 on TERMINAL II -96 board
FSP Direct high-speed radiography	SR	SR: READY signal from the high-speed operation switch of the fluoroscopic operation bed
SPSWE	SSP1	SPSWE: A signal to validate the high-speed operation switch of the fluoroscopic operation bed and is output when the indirect high-speed operation (IFG) and DSA operation (DSP) are executed. SSP1: READY signal from the high-speed operation switch of the fluoroscopic operation bed
SEST	RYI	RY1: READY signal from the READY switch for the direct continuous operation

7.7 KB signal circuit

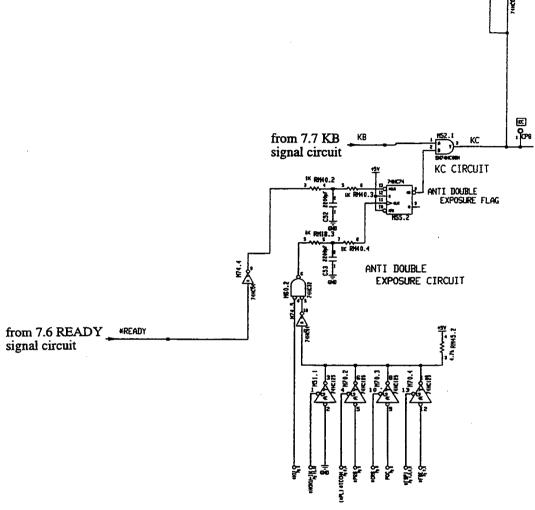
KB signal is a READY signal that passed through OKT gates.



				
*KB	READY start signal (negative logic)			
KB signal is output when all the conditions ② ~ ⑤ are satisfied for the READY signal.				
① READY signal is ON (from section 7.6).				
② OI	② OKT signal is OK.			
3 но	OVE signal from I/O CONT-96 board is OFF (unused, always OFF).			
④ Ar				
	CUT			
:	LOVE			
	NOX			
	(5) Among the following OVER-Brake signals from MOTHER-96 board, a signal that is relevant to the			
ne.	xt operation is not output (all are negative logic). POWER DOWN			
	ROC			
	TkVOVER			
	PKVOVER			
	CHARGE OVER			
	IFOVER			
	HVT OPEN			
··	LVOVER			
FOUT	I.I. getter suspension signal			
I.I. getter	I.I. getter suspension signal FOUT is output when one of the following signals is output.			
① KB signal is ON.				
② KFT signal is ON. (from section 7.21)				
KTF signal [Fluoroscopic X-RAY ON signal]				
7 10				

7.8 KC signal circuit

KC signal is derived from KB signal that has passed through a gate for double-exposure prevention flag.



*KC READY start signal in which a condition of double exposure prevention is added to READY start signal KB.

In the following operation methods or modes, however, KB signal directly makes KC signal, because the condition of double exposure prevention is not needed.

<Operation method> <Mode>

- ① In PL and PGS (in tomographic operation and intermittent exposure)
- ② In the following operation methods or modes, the double exposure is not prevented.

FSP and FSE (consecutive operation)

CIN

SEST

DSP

XDR

CRS and no PGC (consecutive operation by indirect camera)

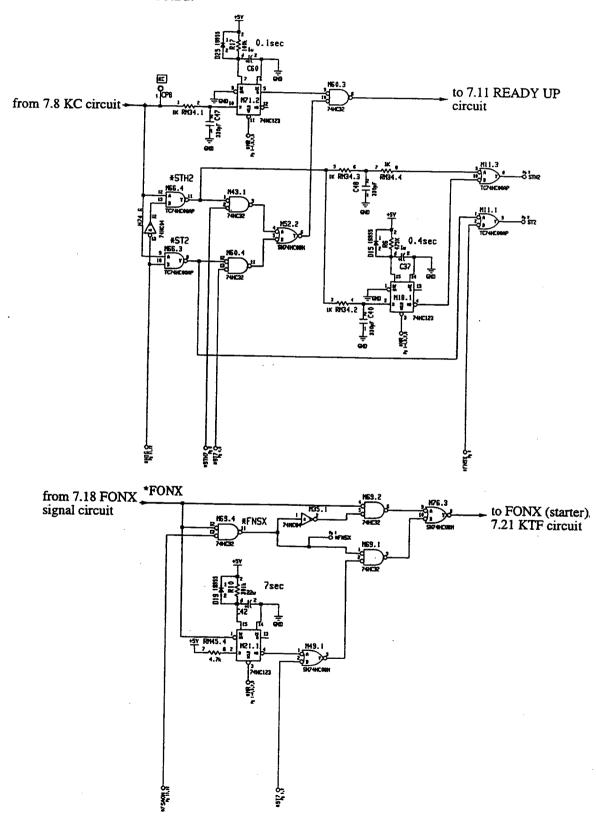
Double exposure prevention circuit

In double exposure operation, this circuit allows an X-ray exposure only when READY start signal KB is once made OFF and made ON again.

7.9 Starter circuit

Receiving a switch signal between high-speed and normal-speed rotation from I/O CONT 96 board, this circuit supplies a drive signal for each rotation.

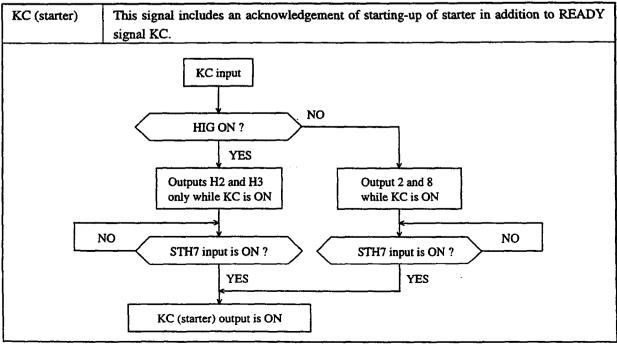
When required to rotate the X-ray tube rotor in normal speed, FSAON signal is output from I/O CONT-96 board.

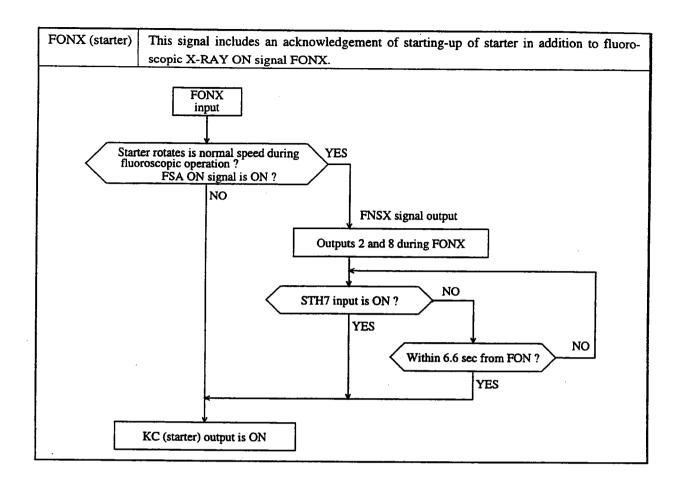


7 - 14

Connector terminals for X-ray tube anode starter						
ЈМ34 со	nnector	Function				
Name	Pin No					
HON	A14	+15 V power supply	(+15 V current-loop input)			
*1MS	A15	First tube selection signal	(+15 V current-loop output)			
*2MS	B15	Second tube selection signal	(+15 V current-loop output)			
*3MS	A18	Third tube selection signal	(+15 V current-loop output)			
*2	C15	Normal-speed rotation ON signal	(+15 V current-loop output)			
*7	B14	Normal-speed rotation start OK signal (Starter outputs *7 in startup.)	(+15 V current-loop input)			
*H2	A16	High-speed rotation ON signal	(+15 V current-loop output)			
*H7	C14	High-speed rotation start OK signal (Starter outputs *H7 in startup.)	(+15 V current-loop input)			
*H11	B16	Drive power stop signal (X-RAY ON signal outputs this signal.)	(+15 V current-loop output)			
*H12	C16	Starting-time switching signal output (This signal is output when *(FSPI+IFG) s	- -			
*TRST	C17	X-ray exposure prohibition signal output (This signal is output when *NOX signal is	· ·			
*STRBK	B17	Starter failure signal input	(+15 V current-loop input)			
*FRST	(A17)	FAULT reset signal output (Note: this signal is output from MOTHER	(+15 V current-loop output) R-96 board.)			

Starter signal from I/O CONT-96 board			
Signal	Content		
HIG	Starter high-speed rotation selection signal		
FSAON	Starter normal-speed rotation signal during fluoroscopic operation		



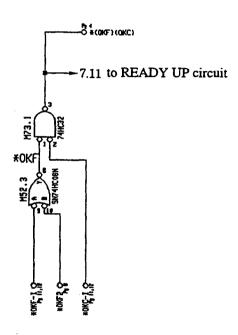


7.10 OKF and OKC signal circuit

OKF signal circuit is the acknowledgement circuit of filament heating.

When controlling an ordinary X-ray tube (using mA POWER-96 board), the acknowledging method is different from when externally controlling a stereo X-ray tube.

OKC signal circuit is the acknowledging circuit for charging voltage of the main circuit capacitor.



OKF signal circuit

Class of X-ray tube	Necessary signal
When controlling an ordinary X-ray tube (using mA POWER-96 board)	Only OKF- I
When externally controlling a stereo X-ray tube (using STA-30)	Trequires OKF2.

Signal from	m MOTHER-96 board (mA POWER-96 board)
OKF- I	Signal of filament heating OK (mA POWER-96 board)

Signal from TERMINAL 2-96 board (STA-30):	
OKF2	Operates when CU1 and CU2 of the connector J41 on TERMINAL 2-96 board are short-circuited.
	(This signal is required when STA-30 is combined.)

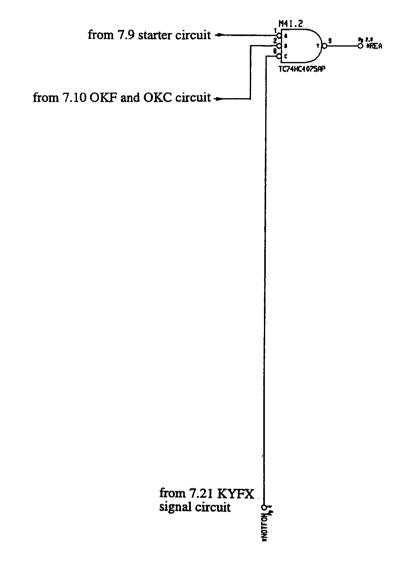
OKF•OKC(OUT) Signal to indicate that heating of filament and charging of main circuit capacitor are OK:

Output to READY UP circuit and KTF circuit, after confirming that filament-heating necessary for X-ray exposure and charging of main circuit capacitor are OK.

Signal from MOTHER-96 board (ANALOG-96 board):		
окс- І	Indicates that charging of main circuit capacitor is OK. (ANALOG-96 board)	

7.11 READY UP signal circuit

This signal indicates that the preparation for a radiographic operation has been finished and illuminates READY display light on the console.

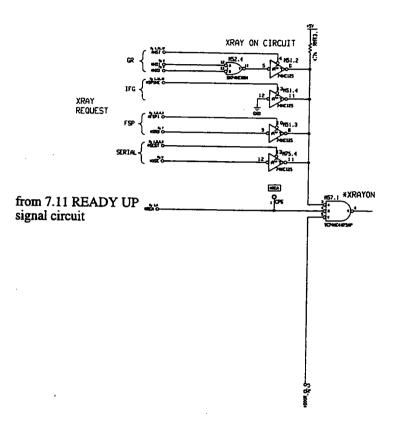


READY UP (REA) signal circuit

READY UP (REA)	Signal to indicate that all conditions for the READY were OK, the READY operation has been finished, and the apparatus is now in standby.	
This signal is out	ignal is output when the following conditions ② and ③ are established in addition to ①.	
① Signal KC	Signal KC (starter) is ON.	
② Signals Ol	② Signals OKF and OKC (OUT) are OK.	
③ Signal NO	OTFON (fluoroscopic X-RAY ON) is OFF. (inoperative)	

7.12 X-RAY ON signal circuit

This circuit outputs X-RAY ON signal by gating various X-ray operation signals with each operation method.



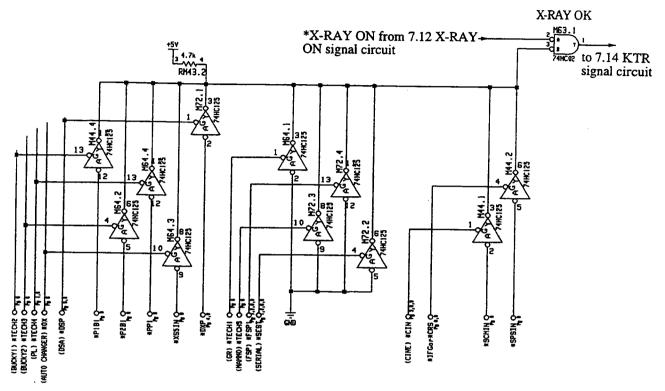
X-RAY ON signal circuit

X-RAY ON	X-RAY start signal	
This signal is output when the following conditions ② and ③ are established in addition to ①.		
① Signal X-1	-RAY is ON. 3 Signal DOOR-CL (door-interlock signal) is OK.	
② Signal READY UP is OK.		

X-RAY	X-RAY operation signals	
Closing only the g	ate for a selected operation method outputs the X-RAY operation signal. The necessary	
	gnal for each operation method is shown below	
<operation method=""></operation>	<x-ray is:="" operation="" signal="" which=""></x-ray>	
HST	HX1 Generated by the hand-switch on the console,	
	or HX2 Inputted from TERMINAL 2-96 board,	
FSP	SRD The signal RD received at the terminal RD of TERMINAL-96 board	
	from the high-speed operation switch on the fluoroscopic operation bed,	
SPSWE	Always outputted, so that the next X-RAY ON signal is READY UP	
	(REA) signal alone,	
SEST	XSE Derived from the X-RAY switch for direct consecutive operations.	

7.13 X-RAY OK signal circuit

X-RAY OK signals are output by gating with each operation method.



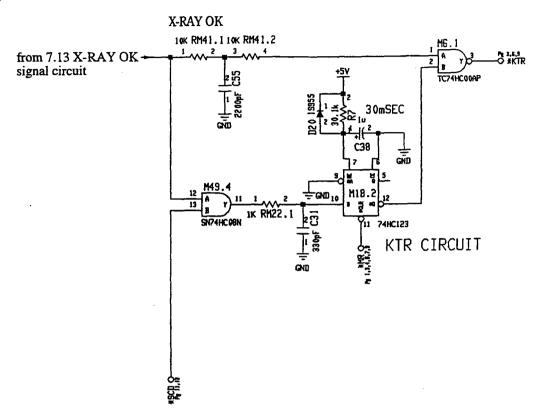
XRAY ENABLE FROM PERIPHERALS

X-RAY OK signal circuit

X-RAY O		X-RAY OK acknowledge signal	
Closing	Closing only the gate for a selected operation method outputs the X-RAY operation signal. The necessary		
X-RAY op	eration sign	nal for each operation method is shown below	
<operation< td=""><td></td><td><x-ray is:="" operation="" signal="" which=""></x-ray></td></operation<>		<x-ray is:="" operation="" signal="" which=""></x-ray>	
(BUCKY1)	TECH2	P1B1 (received from Bucky's radiographic device 1 at terminals [1B1] and [1B11] of TERMINAL-96 board),	
(BUCKY2)	TECH3	P2B1 (received from Bucky's radiographic device 2 at terminals [2B1] and [2B11] of TERMINAL-96 board),	
(PL)	TECH4	PP1 (received from the tomographic device at terminals [P1] and [P11] of TER-MINAL-96 board),	
(AUTO CH	IANGER)	XS5IN (received from the auto-changer radiographic device at terminals [XS6] and	
	OX	[XS5] of TERMINAL-96 board),	
(GR)	TECH1	Unneeded (X-RAY OK signal is always in OK),	
(MAMMO)	TECH5	Unneeded (X-RAY OK signal is always in OK),	
	FSP	Unneeded (X-RAY OK signal is always in OK),	
	SEST	Unneeded (X-RAY OK signal is always in OK),	
(DR)	DR1	Unused	
	CIN	Unused	
	IFG+CRS	SPSIN (received from I.I. indirect camera and rapid sequence camera at terminals [XS3] and [XS4] of TERMINAL-96 board),	
		SS7 (a logic level signal converted from a contact-point signal at terminals [S4] and [S5] of TERMINAL-96 board which acknowledges moving of the mir-	
	DSP	ror in I.I. optical system toward the operating position), DXP (received from the DSA device at terminals [EXP1] and [EXP2] of TER-MINAL-96 board),	
		SS5 (a logic level signal converted from a contact-point signal at terminals [S4] and [S5] of TERMINAL-96 board which acknowledges moving of the mirror in I.I. optical system toward the operating position).	

7.14 KTR signal circuit

This signal is output after acknowledging X-RAY OK signal derived from X-RAY ON signal.



KTR signal circuit

KTR	Take X-RAY ON signal (X-RAY OK acknowledge signal must be in OK.)
	1 (

This signal is output 30 msec after the following two conditions have been established.

X-RAY ON signal is ON.

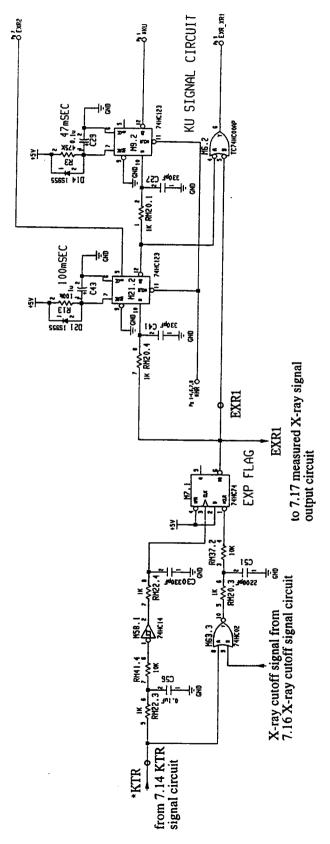
X-RAY OK signal is OK.

Provided that *SCD signal (signal to invalidate a circuit function to assure actions of general radiographic devices [negative logic]) is input, KTR signal is immediately output after above two conditions have been established.

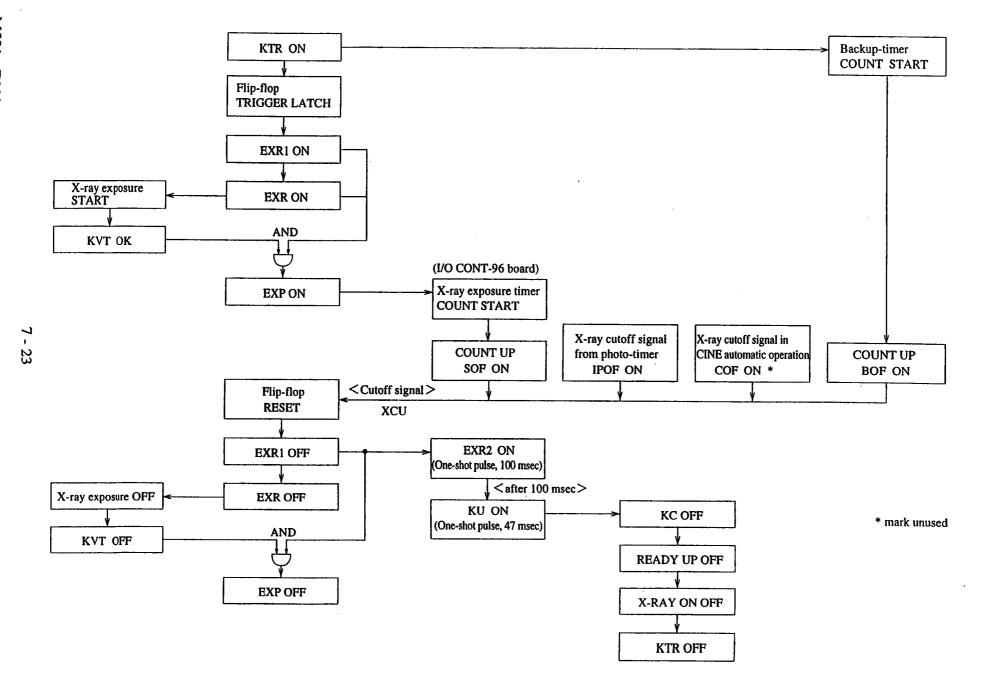
*SCD signal	Signal to invalidate a circuit function to assure actions of general radiographic devices [negative logic]
SCD signal is out	put in the following operation methods.
① FSP	
② IFG	
3 CRS	
④ DSP	
⑤ SER (SES	T)
⑥ XDR	
⑦ CIN	·

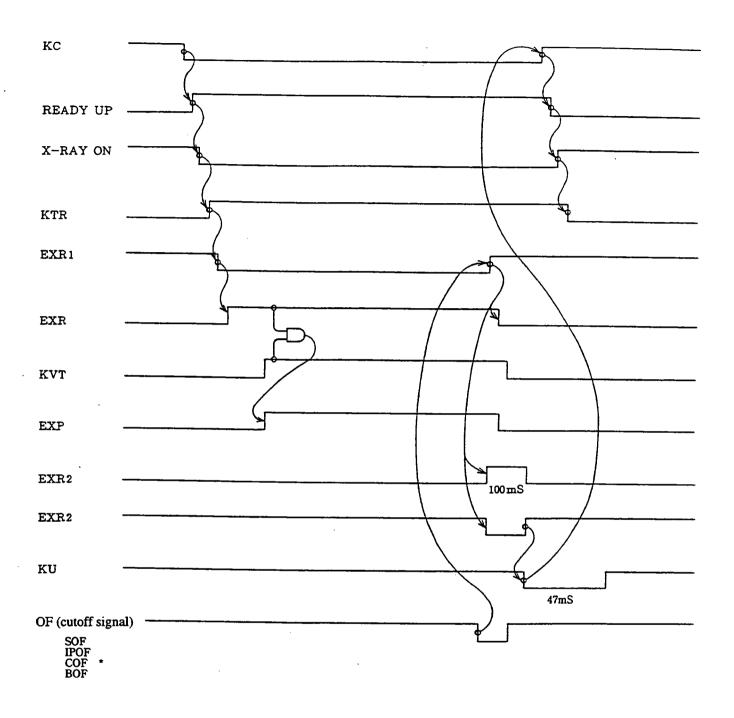
7.15 Signal circuit from KTR to KU

Block diagram and timing chart of signal circuit from KTR to KU are shown below.



Signal circuit from KTR to KU





* mark unused

Signal circuit from KTR to KU

EXR1	Take X-RAY ON signal
Signal that is triggered by KTR and reset by KTR OFF or cutoff signal	

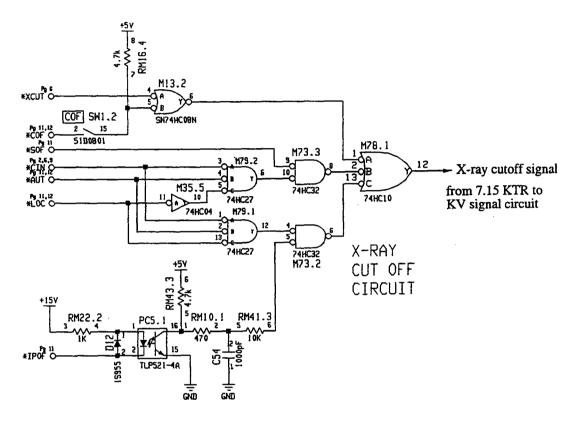
EXR_XR1	Take X-RAY ON signal (EXR1 + 100ms)		
Signal that extends	Signal that extends Take X-RAY ON signal by 100 msec		

EXR2	Take X-RAY OFF signal
One-shot pulse sign	nal (for 100 msec) triggered by the ending-edge of EXR1

KU	Take X-RAY OFF signal
One-shot pulse signal (for 47 msec) triggered by the ending-edge of EXR2	
KU resets READY start signal KC and finishes Take X-RAY	

7.16 X-ray cutoff signal circuit

This circuit generates four X-ray cutoff signals, COF, IPOF, SOF, and XCUT. Effectiveness and priority of these signals are determined in accordance with a specified operation method.



? OF X-ray cuto	ff signals in accordance with selected operation method
Resetting Take X-RAY ON sign	nal EXR1 cuts X-ray radiation.
X-ray cutoff signals are: ① COF ② IPOF ③ SOF	Note) COF is now unused
XCUT When X-ray exposure is regular	ly controlled, the X-ray cutoff signals are output in the following order.
In all operation methods exc ① SOF	ept CINE>
② XCUT (No input of COF and	H IPOF)
In all operation method with	selecting photo-timer except CINE>
l ① IPOF	
② SOF_	
③ XCUT	15
<in cine="" manual="" mode=""> (un ① SOF</in>	used)
© COE	
© COF ③ XCUT	
(No input of IPOF)	
<in auto-mode="" cine=""> (unuse</in>	cd)
① IPOF	
② COF	
③ XCUT	at auto)
(Input of SOF is cut a In CINE auto-mode and LO	it gate.) C signal ONS (unused)
① SOF	Congress (unused)
© COF	
③ XCUT	
(Input of IPOF is cut	at gate.)

COF

X-ray cutoff signal for backup-timer in CINE (unused)

This signal is output from I/O II -96 board with a length of about $1.5 \sim 2$ times the set take time.

When IPOF signal is not output because the photo-timer does not work due to a light density of the film, COF cuts the X-ray.

IPOF

X-ray cutoff signal by photo-timer

This signal is output from PH POWER-96 and PH CONT-96 board when an exposure level specified by the selected photo-timer has been reached.

SOF

X-ray cutoff signal from the sec timer of I/O CONT-96 board

I/O CONT-96 board receives a measured X-RAY signal EXP (XR-IN) and counts up to a set seconds, and then outputs this signal to EMC-96 board.

XCUT

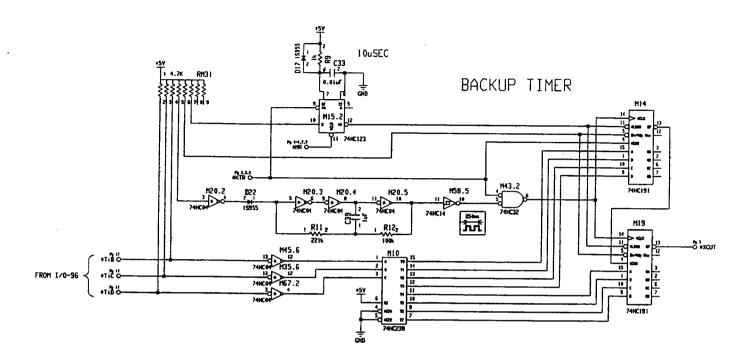
X-ray cutoff signal from backup-timer

In I/O CONT-96 board a timer counter is preset by a signal decoded from backup time signal (binary) TIB ~ TIC which is selected in accordance with a set seconds.

Take X-RAY ON signal KTR starts the timer counter, and the counter outputs his XCUT signal at the preset time.

A CR oscillator with a period of 250 msec (4 Hz) generates the clock for the counter.

This XCUT signal is used as a backup when the X-ray cutoff signal SOF from the sec timer of I/O CONT-96 board is not regularly output.

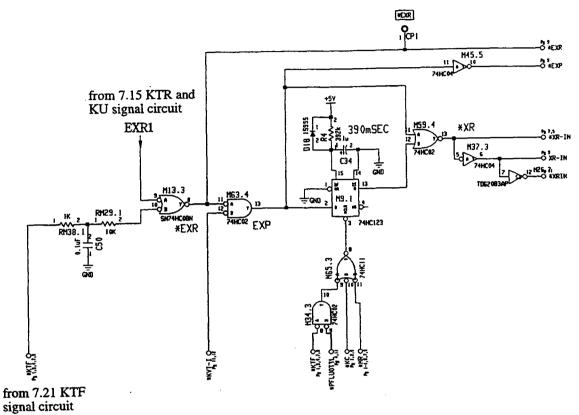


Set sec value	Backup time selection signal (binary)			Backup time	
	*TID	*TIC	*TIB	·	
1.0ms ~ 120ms	1	1	1	250 msec	
140ms ~ 250ms	1	1	0	0.5 sec	
280ms ~ 500ms	1	0	1	1.0 sec	
560ms ~ 1.0sec	1	0	0	2.0 sec	
1.1sec ~ 2.0sec	0	1	1	4.0 sec	
2.2sec ~ 4.0sec	0	1	0	8.0 sec	
4.5sec ~ 8.0sec	0	0	1	16.0 sec	
9.0sec ~ 10.0sec	0	0	0	32.0 sec	1:5V 0:0V

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7.17 Measured X-RAY signal output circuit (for both fluoroscopy and fluoroscopy)

Radiographic and fluoroscopic (including pulse fluoroscopy) X-RAY ON signals start build up of tube voltage. After acknowledging the measured tube voltage build up, the measured X-RAY signal is generated.

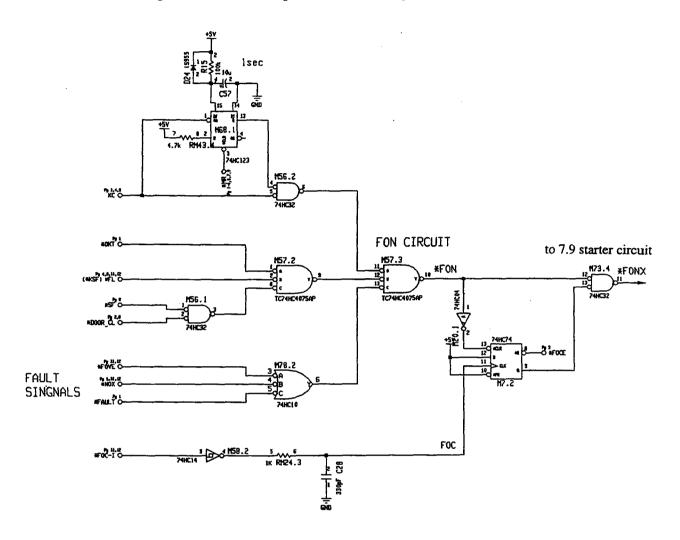


Measured X-RAY signal

KTF	Fluoroscopic X-RAY ON signal (the acknowledge signal must be OK.)	
KVT	Acknowledge signal of build up of measured tube voltage	
This signal is or	utput from ANALOG-96 board as an acknowledge signal of the tube voltage build up when	
the measured tu	be voltage has reached a specified value (76% of kV peak value).	
PFLUOTTL	Pulse fluoroscopy selection signal	
This signal is ou	atput from I/O II -96 board when pulse fluoroscopy is selected.	
KC	This signal is a READY start signal that includes a condition of double exposure prevention.	
EXR	Radiographic or fluoroscopic X-RAY ON signal	
OR signal of EXR1 (fluoroscopy) or KTF (fluoroscopy)		
EXP	Measured X-RAY signal (radiography and fluoroscopy)	
AND signal of l	EXR and KVT	
XR-IN	Measured X-RAY signal (in both fluoroscopy and fluoroscopy)	
EXP signal is e	xtended by one-shot pulse (390 msec) to a continuous signal.	

7.18 FONX signal circuit

This circuit generates fluoroscopic X-RAY ON signal.



FONX	Fluoroscopic X-RAY ON s	signal
This signal FON	X is output when all conditions	②~ ⑨ are satisfied in addition to ①
① SF is ON.		① FL (fluoroscopy enable signal) is OK.
② OKT is O	K.	DOOR-CL (door lock signal) is OK.
③ FOVE for	m I/O CONT-96 board is OFF.	NOX (X-ray exposure prohibition) from I/O CONT-96
FAULT is	OFF	board is OFF.
(5) KC (OFF DELAY0.5S) is OFF.		
⑥ FOC FLA	.G is OFF.	

7.19 SF signal circuit

This signal is for fluoroscopic X-ray operation.

*SF	Fluoroscopic X-ray operation signal in selected operation method (negative logic)
A TTL level sig	nal that is converted from fluoroscopic X-ray operation signal from foot switch F.

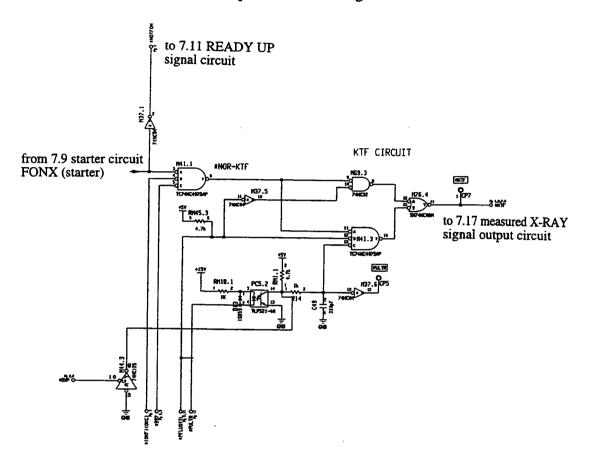
7.20 FOC-FLAG signal circuit

This circuit latches fluoroscopic over-current signal FOC supplied from mA POWER-96 board.

FOC-FLAG	Latched signal caused by fluoroscopic over-current signal FOC supplied from mA Power-96 board.
To reset the latch, any one of the conditions ① ~ ⑤ for signal FON must be once canceled, and these condi-	
tions ① ~ ⑤ must be satisfied again.	

7.21 KTF signal circuit

This circuit generates fluoroscopic X-RAY ON signal.



KTF signal circuit

KTF	Fluoroscopic X-RAY ON signal	
This signal is output when conditions ② and ③ are established in addition to condition ①. ① Signal FON (starter) is ON. ② Signals OKF and OKC are OK. (acknowledge signals for heating and charging) ③ I.I. mirror acknowledge signal is OK.		
In pulse fluoroscopy, an additional condition (4) must be satisfied. (4) Signal PLTR (pulse trigger) is ON. Note) When the operation method is DSP, signal DXP (radiation) must be ON.		

SS7	I.I. mirror acknowledge signal
	gic level signal converted from a contact-point signal at terminals [S6] and [S7] of TERMI-ich acknowledges moving of the mirror in I.I. optical system in the direction of TV camera.
PFLUOTTL	Pulsed fluoroscopy selection signal

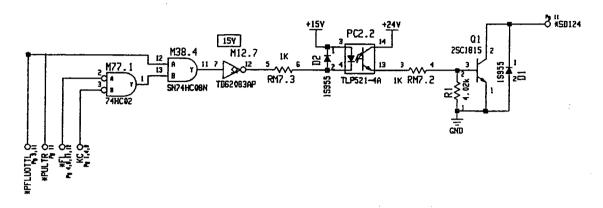
PFLUOTTL	Pulsed fluoroscopy selection signal
This signal is out	out when pulsed fluoroscopy is selected on the fluo-panel or the console
DI I ITTD	Duland fluorescent size of

ı	FLUIR	Pulsed fluoroscopy trigger signal
ı	This signal is pulse	ed fluoroscopy trigger signal gated by pulse fluoroscopy selection signal and is output as
	fluoroscopic X-RA	

DXP	X-RAY acknowledge signal
This signal is receive	ved from DSA device at terminals [EXP1] and [EXP2] of TERMINAL II -96 board. (option)

7.22 SD124 signal circuit

This signal switches mA detection resistor on TUBE SELECTOR board of the high-voltage generator in terms of fluoroscopic and radiographic operation.

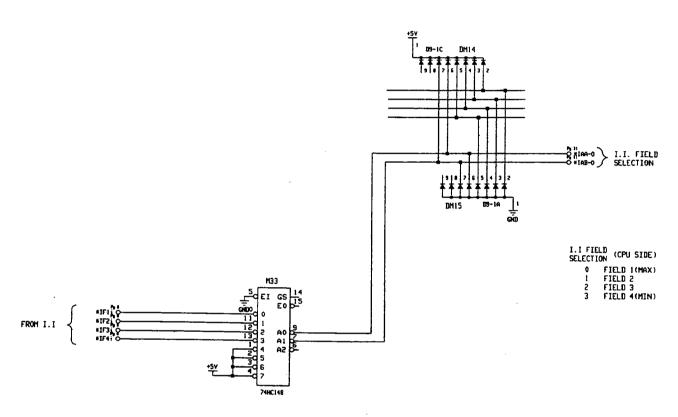


SD124 Signal to switch the tube current detection circuit of the high-voltage generator to f roscopy side. This signal is output when conditions ② and ③ are established in addition condition ①.				
<operation r<="" td=""><td>nethod> <mode></mode></td></operation>	nethod> <mode></mode>			
① (FL) who	en fluoroscopy enable signal is output			
② (KC) wh	en READY operation is not executed			
③ (PFLUO	TTL) when pulse fluoroscopy is not selected			
[This sig	nal drives DC24 V relay.]			

7.23 I.I. field-of-view switching signal circuit

(1) Input circuit

With I.I. of field-of-view switching type, a signal from a field-of-view changing switch on fluoroscopic operation bed is sent to EMC-96 board and encoded to *IAA-O and *IAB-O signal there, and sent to I/O CONT-96 board through connector JM44.



I.I. field-of-view switching signal circuit (input)

I.I. field-of-view switching signal circuit (input)

With I.I. of field-of-view switching type, signals IF0, IF1 \sim IF4 is input to connector JSK of MOTHER-96 board and further input to EMC-96 board through connector JM34. The signal is encoded to binary signals IAA-O and IAB-O, and sent to I/O CONT-96 board through connector JM44.

CPU uses this signal to:

- [1] Calculate an object thickness from fluoroscopic condition of memory-shot, and
- [2] Correct mAs value in an operation method IFG.

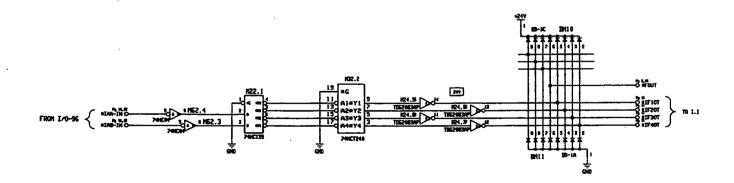
I.I. field-of-view switching signals (connector JSK) from the field-of-view change switch			Field-of-view signals to I/O C	_			
IF0	IF1	IF2	IF3	IF4	*IAB-IN *IAA-IN		
0-	<u> </u>				1	1	
0-		-0			1	0	
0—			<u> </u>		0	1	
$\circ \dashv$				0	0	0	

1:5V 0:0V

I.I. field-of-view sv	vitching signals IF0, IF1	~ IF4		
The field-of-view c	hanging switch is connec	cted as follows in acco	ordance with the number	er of changing steps.
Connector JSK		Two steps	Three steps	Four steps
IF0		0	0	0
IF1	Large field-of-view	O>	0	○
IF2	\$			○
IF3	Small field-of-view	0+	0>	○
IF4		ل		○

(2) Output circuit

The CPU on I/O CONT-96 board processes the input field-of-view changing signals in section (1) and outputs *IAA-IA and *IAB-IN signals to EMC-96 board. The EMC-96 board decodes the input signals to *IF10T ~ *IF40T signals and sends them to TERMINAL-96 board through connector JM34.



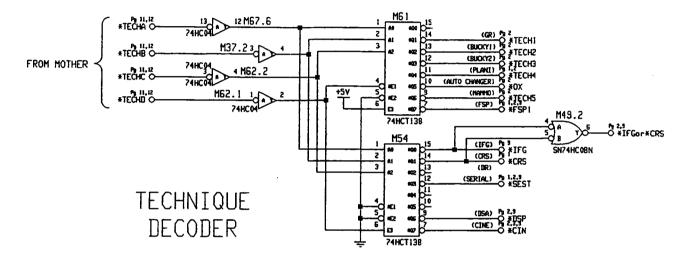
I.I. field-of-view switching signal circuit (output)

EMC-96 board receives *IAA-IA and *IAB-IN signals outputted from I/O CONT-96 board, decodes them to *IF10T ~ *IF40T signals, and sends the decoded signals to TERMINAL-96 board through connector JM34. The signals are sent to the collimator through connector JXS of TERMINAL-96 board and to the I.I. through connector JTH-RB.

7.24 Operation method selection signal circuit

The operation method (terminal code) selection signals (*TECHA \sim *TECHD) are transmitted from I/O CONT-96 board to EMC-96 board through MOTHER-96 board and connector JM44.

Operation methods (terminal codes), signal notations, abbreviations, and control signals are shown below.



Operation method selection signals from I/O CONT-96 board

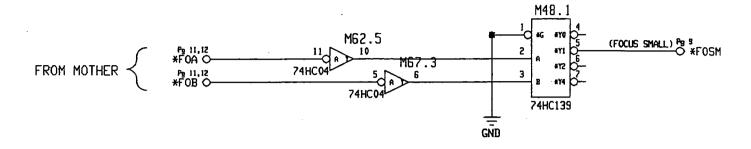
Signal notation (negative logic)	JM44 Pin No
*TECHA	B-21
*TECHB	C-21
*TECHC	A-22
*TECHD	B-22

Operation me tion signals CONT-96 bo ry) (negative	from I/O pard (bina-	Operation signals in EMC-96
*TEC	Operation methods (terminal codes)	board
-D-C-B-A	Designation	
1111	Unused	
1110	General radiography	GR
1101	Bucky's radiography 1	BU1
1100	Bucky's radiography 2	BU2
1011	Tomography	PL
1010	Auto-changer radiography	ox
1001	MAMMO radiography (unused)	MAMM
1000	Direct spot filming	FSP
0111	I.I. indirect spot filming	IFG
0110	I.I. indirect serial radiography	CRS
0101		
0100	Serial radiograph	SEST
0011		
0010		
0001	DSA radiography	DSP
0000	CINE radiography (unused)	CIN
7 06		

1:5V 0:0V

7.25 Focus selection signal circuit

Focus selection signals (*FOA, *FOB) are sent from I/O CONT-96 board to EMC-96 board through MOTHER-96 board and connector JM44.



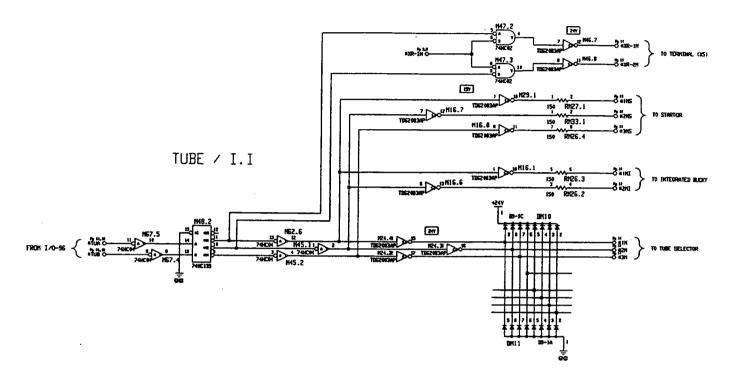
	Focus selection I/O CO (binary) (neg	EMC-96 (TERMINAL II -96) Focus selec-	
Focus	*FOB JM44C-29	*FOA JM44B-29	tion signals for EMC-96 (TERMINAL II -96) board
Unused	1	1	
Small focus	1	0	*FOSM
Large focus	0	1	
Micro focus	0	0	

Note) Micro focus cannot be used at present.

{1:5V } {0:0V }

7.26 $1 \text{M} \sim 3 \text{M}$ signal circuit

Tube selection signals (*TUA, *TUB) are sent from I/O CONT-96 board to EMC-96 board through MOTHER-96 board and connector JM44.



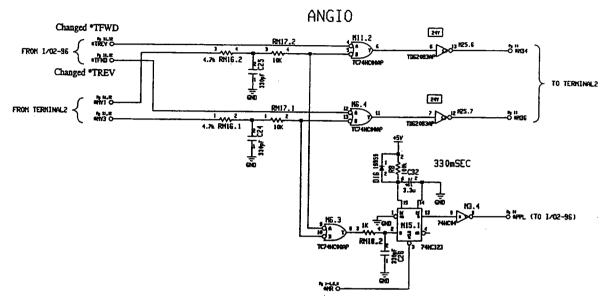
*1M ~ *3M	Tube selecti	Tube selection signal circuit (Tube No. 1 ~ No. 3) (negative logic)				
X-ray tube	X-ray tube selection signals from I/O CONT-96 board (binary) (negative logic)		Tube selec- tion signals for TUBE	Tube selection signals for INTE-GRATE	Tube selec- tion signals for STAR-	X-ray exposure signal
number	*TUB JM44B-29	*TUA JM44C-29	SELEC- TOR board	BUCKY device	TOR device	for each X- ray tube
Unused	1	1			-	
TUBE1	1	0	*1M	*1MI	*1MS	*XR-1M
TUBE2	0	1	*2M	*2MI	*2MS	*XR-2M
TUBE3	0	0	*3M		*3MS	

7.27 Top-panel move signal circuit

This circuit generates signals to move the top-panel of the examination bed forward and backward in angiography of lower limbs.

Correct errors in the circuit diagram below.

Change a signal *TREV to *TFWD at pin @ of M11 and *TFWD to *TREV at pin @ of M6.



Top-panel move signal circuit

*TFWD(negative logic)	Signal to move the panel forward [output from the console (I/02)]			
This signal is output from	This signal is output from I/O II -96 board by console operation to move the panel forward.			

*TREV(negative logic)	Signal to move the panel backward [output from the console (I/02)]	7		
This signal is output from	This signal is output from I/O II -96 board by console operation to move the panel backward.			

*MV1(negative logic)	*MV1(negative logic) Signal to move the panel forward [output from the film-changer device]	
This signal is output from	m the film-changer device to TERMINAL II -96 board to move the panel forward.	

*MV3(negative logic) Signal to move the panel backward [output from the film-changer device]				
This signal is output from	n the film-changer device to TERMINAL II -96 board to move the panel backward.			

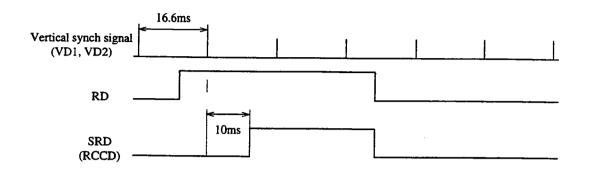
M34	Signal to move the panel forward
This signal is output from	EMC-96 board to move the panel forward by driving the relay of TERMINAL II -96 board.

M36	Signal to move the panel backward
This signal is output from	EMC-96 board to move the panel backward by driving the relay of TERMINAL II -96 board.

PPL	Signal to move the panel [output from the film-changer device]
This signal is output from	om the film-changer device to TERMINAL II -96 board to move the panel. This signal
is used to change radio	ographic conditions at the console. CPU in I/O II -96 board processes the signal from
EMC-96 board for the	change.

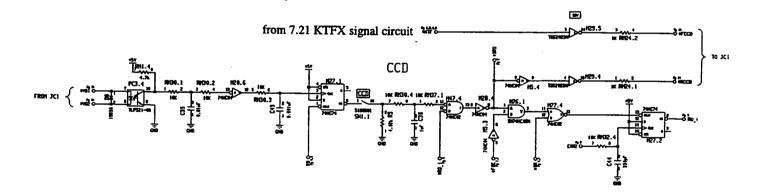
7.28 Input/output signals and timing chart on CCD camera device

(1) Timing chart



(2) Input/output signals on CCD camera device

Input/out	Input/output signals on CCD camera device										
VD1	Vertical synch signal input from CCD camera device	The first vertical signal after RD signal triggers a flip-flop with a pulse width of 10 msec. After the delay time of 10 msec, SRD									
VD2		signal is sent to X-ray signal circuit.									
RECD	Radiographic sequence signal output to CCD camera device	This signal is sent to X-ray signal circuit as SRD signal in EMC-96 board.									
FCCD	Fluoroscopic sequence signal output to CCD carnera device	This signal is KTF (fluoroscopic radiation signal) in EMC-96 board.									



7.29 Input signal conversion circuit

The circuit on EMC-96 board is made of HC-CMOS powered by 5 V supply.

It converts input signals to the same level as those of external devices and other boards.

The circuit diagram of the input signal conversion circuit is shown on Page 8.

Refer to 7.31 "Input/output signals on EMC-96 board" for significance of input signals and class of circuit configurations.

7.30 Output signal conversion circuit

The circuit on EMC-96 board is made of HC-CMOS powered by 5 V supply.

It converts output signals to the same level as those of external devices and other boards.

The circuit diagram of the output signal conversion circuit is shown on Page 9.

Refer to 7.31 "Input/output signals on EMC-96 board" for significance of output signals and class of circuit configurations.

7.31 Input/output signals on EMC-96 board

[1] Table of input/output signals on EMC-96 board

Connector	Connectio n diagram Page	Pin No	Designation	In / Out	Circuit	Significance	Destination
ЈМ34	10/12	A-1	+5VM	In			Mother-96
1		B-1	"	"			
		C-1	"	"			
		A-2	+5VM	In		+5 V input	Mother-96
		B-2	"	"			
		C-2	"	"			
1	10/12	A-3	+15VM	In			Mother-96
		B-3	"	"		+5 V input	
į		C-3	"	"			
		A-4	-15VM	In			Mother-96
	l l	B-4	"	"		-15 V input	
		C-4	"	"			
]	8/12	A-5	*AR1I	In	е	Hand-switch READY operation signal	19→
] .		B-5	*HX1I	"	"	Hand-switch X-RAY operation signal	Mother-96
	7/10	C-5	(no use)				
	7/12	A-6	*RCCD	Out	i	Radiographic sequence signal to CCD camera device	JC1→
]		B-6	*FCCD	,,	"	Fluoroscopic sequence signal to CCD camera device	Mother-96
. '		C-6	*VD2	In	f	Vertical synch signal input from CCD camera device	→JC1
		A-7	*VD1	"	"		
1		B-7	(no use)				
	1/12	C-7 A-8	(no use) *OKF-I	T		Filment heating OV signal [TTT] level]	A DOWED
	1/12	A-0	"OKF-1	In	а	Filament heating OK signal [TTL level]	mA POWER -96
	1/12	B-8	*OKC-I	"	"	Main circuit capacitor charging OK signal [TTL level]	ANALOG-96
	3/12	C-8	*KVT-I	"	"	Acknowledge signal of measured tube voltage build-up	ANALOG-96
	3/12	A-9	*IPOF	In	e	X-ray cutoff signal from photo-timer	PH POWER
	11	,	101			71 Tay Outors Signal from photo-times	-96 PH CONT-96
	4/12	B-9	*FOC-I	In	a	Fluoroscopic over-current signal	mA POWER
	,,,,,			111	•	ruoroscopie over-current signar	-96
		C-9	(no use)	_			
		A-10	(no use)	"			
3	1/12	B-10 C-10	(no use) *ROC	//		Padiographia avez avezat sienal	ANALOGOG
	5	A-11	*TkVOVER	In "	a "	Radiographic over-current signal Measured tube-voltage over permissible range	ANALOG-96
		B-11	*PKVOVER		"	Faulty set-value of tube voltage	
		C-11	*CHARGE	"	"	Faulty set-value of tube voltage Faulty charging-voltage of primary smoothing	
		C-11	OVER			capacitor	
		A-12	*IFOVER	In		Faulty filament-heating-current	mA POWER
					_	,	-96
	8/12	B-12	*OKHVT	"	b	High-voltage generator connected	
	1/12	C-12	*LVOVER	In	a	Power supply voltage over permissible range	Mother-96
		_				for apparatus	, -
		A-13	(no use)				
		B-13	(no use)	—			ļ
ľ		C -13	(no use)	"			İ

	Connector	Connectio n diagram Page	Pin No	Designation	In / Out	ii ii			Signific	ance	Destination
ĺ	Con	Con Page	1111110	Designation	=	Circuit			Signific	ance	Destination
Ī		8/12	A-14	HON	In	c	+1	5 V	power for curren	t-loop input	JS1→
ı			B-14	* 7	"	"	[-	n startup OK signal	(SA-41)
1					1	ĺ			•	current-loop input)	(Starter 4UD)
1			C-14	*H7	"	"	His	zh-sp	eed revolution star	• • •	(======
1		9/12	A-15	*1MS	Out	i	1 '	•		15 V current-loop output)	
١			B-15	*2MS	"	"			tube selection si	• • •	
			C-15	*2	"	"	1		-speed revolution d	• • •	
1			A-16	*H2	"	"	1		eed revolution dri	• •	
			B-16	*H11	"	"	1 7	-	g power stop sign		
İ			C-16	*H12	"	"				of startup time (")	
ŀ			A-17	(no use)		İ		_		•	
		8/12	B-17	*STRBK	In	С	Inp	ut si	ignal for faulty st	arter	
									(+15 V	current-loop input)	
1		9/12	C-17	*TRST	Out	li	Ou	tput	signal for X-ray	exposure prohibition	
							}		(+15 V	current-loop output)	İ
-			A-18	*3MS	"	"	Th	rd tı	ube selection sign	nal(")	
			B-18	(no use)	—						
			C-18	(no use)	"						
		8/12	A-19	IF1	In	b					JSK→
1			B-19	IF2	"	"		I.I.	field-of-view sw	itching signal (input)	MOTHER-96
ı			C-19	IF3	"	"					
			A-20	IF4	"	"	—				
			Connector 1			Two-	step		Three-step	Four-step	
			IF0	Large field	C) —			0		
	İ		IF1	-of-view	C)— `	$\overline{}$,	<u></u>		
1			IF2 IF3	(C1) E-14							1
İ	}		IF3	Small field -of-view		Ή,				0_	
	}		·			<u> </u>			0	1 0	
		7/12	B-20	*IF1OT	Out						TERMINAL
	İ	1	C-20	*IF2OT	"	"		I.I. f	field-of-view swit	ching signal (output)	-96
İ		Ī	A-21	*IF3OT	"	"	l				→JTH-RB
		ŀ	B-21	*IF4OT	.11	"					→ìXS
l]	Connector J			Two-	step		Three-step	Four-step	
ĺ			IF0	Large field)			0	0	
			IF1	-of-view)—`			O>-		
			IF2	(11 - 11	_	١.,		,			
			IF3	Small field							
			IF4	-of-view		_		ı		0-0	1
		0/10	C-21	(no use)	"				· · · · · · · · · · · · · · · · · · ·		
		9/12	A-22	*S100	Out	h			signal indicating		TERMINAL
		Ì	, a	*60						ding fluoroscopy	-96
			B-22	*S2	"	"	_		• •	hree-way) distributor	Ì
			C-22	*S3	,,	,,			evice toward ind		ļ
	ŀ	l	C-22	33	~	"			to move three-wat toward CINE can	ay distributor of I.I.	

			 				
Connector No	Connectio n diagram Page	Pin No	Designation	In / Out	Circuit	Significance	Destination
ЛМ34	8/12	A-23	S5	In	ь	Acknowledge input signal indicating that mirrors	TERMINAL
Į						of two-way (three-way) distributor have finished	-96
Į			!			to move toward indirect camera or CINE camera	
1		B-23	S7	In	"	Acknowledge input signal indicating that mirrors	
	ļ ,	ļ	ļ			of two-way (three-way) distributor have finished	}
						to move toward fluoroscopic TV camera	j
		C-23	(no use)	<u> </u>			
	9/12	A-24	*FSP1C	Out	i	FSP output (selection signal for direct high-	TERMINAL
1	,		!		}	speed radiographic operation)	-96
{		!	,			(+15 V current-loop output)	→DFS700
		B-24	*TSC2C	"	"	IFG output (selection signal for indirect high-speed	
						radiographic operation) (+15 V current-loop output)	
1		C-24	*XR4	"	"	X-RAY ON output in operation methods DSP,	
}						IFG, and CRS (+15 V current-loop output)	
1	9/12	A-25	*FSP1PH	Out	g	FSP output (selection signal for direct high-speed	PH POWER
}			Ì			radiographic operation) (TTL level output)	-96
1		B-25	*TS2PH	"	"	IFG output (selection signal for indirect high-speed	PH CONT-96
1]			radiographic operation) (TTL level output)	Į
1		C-25	(no use)				
1	9/12	A-26	*2B2I	Out	i	Drive signal output to Bucky's device 2 (X-RAY	TERMINAL
1.			Ì]]		ON signal output in operation method BU2)	-96
1		B-26	*1B2I	"	"	Drive signal output to Bucky's device 1 (X-RAY	→
1	1					ON signal output in operation method BU1)	INTEGRA
		C-26	*P2I	"	"	Drive signal output to tomography device (X-RAY	TE BUCKY
			ł	[[ON signal output in operation method PL)	
}		A-27	*KC2I	"	"	Preparation signal output to tomography device	
l	Ĺ					(KB signal output in operation method PL)	
	9/12	B-27	*KCLV	Out	i	KC signal output to AVR-UD device	MOTHER-96
			ţ			(+15 V current-loop output)	terminal
ļ							board X1
		C-27	(no use)				→AVR-UD
	9/12	A-28	*SP2CN4	Out	i	Signal output on input of SP1 signal in the	TERMINAL
		ļ				operation method FSP (for film exposure)	-96
			, ,	1		(+15 V current-loop output)	→CN4
		B-28	(no use)	-			
1		C-28	(no use)	"			
	0/22	A-29	(no use)			D 1:	NEVCC
	9/12	B-29	O*RESET	In	a	Reset signal input from NEXSC board	NEXSC
	<u> </u>	C-29	(no use)		<u> </u>		

Connector	Connectio n diagram Page	Pin No	Designation	In / Out	Circuit		•	Signific	ance	Destination
JM34	6/12	A-30	*TID	In	а			•		I/O CONT
		B-30	*TIC	"	"	Tir	ne selec	tion sign:	al of backup timer	-96→
		C-30	*TIB	"	"]		(1	negative logic)	
			Set value	in se	С		lection s timer (l	ignal of oinary) *TIB	Backup time	
			1.0ms ~	120r	ns	1	1	1	250msec	
			140ms ~	250r	ns	1	1	0	0.5 sec	
			280ms ~	500r	ns	1	0	1	1.0 sec	
1			560ms ~	1.0s	ec	1	0	0	2.0 sec	
			1.1sec ~	2.0s	ec	0	1	1	4.0 sec	
			2.2sec ~			0	1	0	8.0 sec	
		1:5V	}			0	0	1	16.0 sec	
		(0:0V	9.0sec ~	10.0s	ec	0	0	0	32.0 sec	
		A-31	GND	In						Mother-96
		B-31	"	"						
		C-31	"	"		GN	ID input			
		A-32	GND	In						
		B-32	"	"						1
		C-32	"	"						

Connector	Connectio n diagram Page	Pin No	Designation	In / Out	Circuit	Significance	Destination	
JM44	11/12	A-1	+24V	In	Ť	_	Mother-96	
		B-1	,,	"		+24 V input	Wiother-30	
ļ		C-1	"	"				
		A-2	(no use)	_				
ļ		B-2	"	"	1			
]		C-2	"	"				
ļ		A-3	"	"				
İ		B-3	"	"				
ļ		C-3	"	"				
Ì	9/12	A-4	*KC700	Out	j	READY start signal	J10→	
	}	D 4	*********			(+15 V current-loop outp	ut) PULSE I/F	
		B-4	*XR700	"	"	X-RAY signal	. "	
	9/12	C-4	*MASP	"	_	(in both fluoroscopy and radiography) ("		
	7,12	<u> </u>	WIASI		g	Signal to stop filament heating	mA POWER	
		A-5	(no use)	_			-90	
JM44	5/12	B-5	*FLTD	Out	g		I/O.CONT	
		C-5	*FLTC	"	"	FAULT output signal (negative logic)	1	
	:	A-6	*FLTB	"	"	(1:5V)	10.2.	
		B-6	*FLTA	"	"	$J \left\{ \begin{array}{c} 1.0 \text{ o} \\ 0.0 \text{ o} \end{array} \right\}$		
	*FLT							
	DCB.	A		9	Signif	icance	Notation	
	111	not fa	ult		Not fa	The state of the s		
	111	not fa	ult	1	Not fa	ulty		
	110	1 S6, S	S7Open	I	luor	oscopic position in visual system is S6,	S6, S7Open	
						knowledged.		
	1100	J S4, S	S5Open			graphic position in visual system is S4, knowledged.	S5Open	
	101	l Door	Open				Open	
		l l	RMAL OVER				RMAL OVER	
ł	100		RTOR BRAKE				TOR BRAKE	
	1000	TVH C	NOt CONNECTE			•	T.NOT	
		ŀ			-	i i	ONNECTED	
1	0111	l Charg	ge Brake	(Charg		RGE OVER	
Ī					_	tor is irregular.		
į	0110					ent heating current is irregular. IF O	11 1	
j	0101	· 1	over kV over)	S	Set va	lue of tube voltage is irregular. PkV	OVER	
	0100	TkV o	•		/leasu	ed tube voltage is over permissible range. TkV	OVER	
	0011	Radio	. Over current				OGRAPHY	
	0010	Elma	Over				R CURRENT	
	0010	, Fluo.	Over current			<u>-</u>	OGRAPHY	
1	0001	T ins V	Voltage Over				R CURRENT	
	0001	Line	v Ultage Over	P	ower	supply voltage is over permissible range. LINE OVE	VOLTAGE	
	0000	Power	r Down	-	15 V	l l	POWER	
		<u> </u>				DOW	N	

Connector	Connectio n diagram Page	Pin No	Designation	In / Out	Circuit	Significance	Destination
JM44	5/12	C-6	*IAB-O	Out	g	*IAB-O I.I. field-of-view switching	→I/O.CONT
		A-7	*IAA-O	"	"	*IAA-O signal output (negative logic)	-96P.C.B.
						*IAB-O *IAA-O Field-of-view	
			'			1 1 Largest IF1	
						1 0 Large IF2	,
						(1:5V) 0 1 Middle IF3	
						0:0V 0 0 Small IF4	
JM44	9/12	B-7	(no use)	_		· · · · · · · · · · · · · · · · · · ·	
	,,,,,	C-7	"	"			
		A-8	*KC-O	Out	g	READY start signal [TTL level]	MOTHER-96
		B-8	*REA-O	"	"	READY operation finish signal [TTL level]	
		C-8	(no use)	-			
		A-9	"	"		·	
		B-9	"	"			
		C-9	"	"			
		A-10	*INPSP8			Spare input	
		B-10	*XR-O	Out	g	Measured X-RAY signal [TTL level]	MOTHER-96
		C-10	*KTR-O	"	"	Radiographic X-RAY ON signal ["]	"
		A-11	*KTF-O	"	"	Fluoroscopic X-RAY ON signal ["]	"
		B-11	*KB-O	"	"	READY start signal ["]	"
		C-11	*EXR-O	"	"	Radiographic, fluoroscopic X-RAY ON signal	"
			*PTP 0			["]	
		A-12	*EXP-O	"	"	Measured X-RAY signal ["]	"
		D 10	***********			(radiography, fluoroscopy)	
		B-12	*XRAYON	"	"	Radiographic X-RAY start signal["]	"
	8/12	C-12 A-13	(no use) *PUL	Out	_	Pulsed radiography selection signal (unused)	TERMINAL I
	7/12	B-13	*PPL	Out	g	Signal to move top-panel of examination bed [TTL level]	→I/O2
	//12	C-13	*CM4		5	CINE camera exposure signal (unused)	102
	7/12	A-14	*TFWD	In		Signal to move top-panel of examination bed	I/O2→
						forward ["]	
		B-14	*TREV	"		Signal to move top-panel of examination bed	"
						backward ["]	
		C-14	0V			0 V for CM4 (unused)	
	3/12	A-15	*AUT	In	a	CINE AUTO selection signal [TTL level]	V O2→
		B-15	*LOC	"	"	Signal to fix radiographic conditions	"
		_				(for CINE AUTO) (unused) ["]	
		C-15	*COF	."	"	X-ray cutoff signal from CINE 1 exposure	"
				$\mid \downarrow \downarrow \mid$		timer (unused) ["]	
	1/12	A-16	*CUT	"	"	CINE CUT cutoff signal ["]	I/O2→
	8/12 9/12	B-16 C-16	*SCM	In	a	CINE camera exposure signal ["]	"
	7/12	A-17	*TEST (no use)		а	CINE test signal ["]	"
 	9/12	B-17	*Pk	Out	h	Cathode blanking signal (unused)	TERMINAL [
		C-17	(no use)		**	Cariogo oranging signal (minago)	TEXMINAL II
	4/12	A-18	*PFLUOTT	In	a	Pulsed fluoroscopy selection signal	I/O II -96
	4/12	B-18	*PULTR	In	e	Pulsed fluoroscopy X-ray radiation trigger signal	PULSEI/F
		C-18	(no use)				<u> </u>

Connector	Connectio n diagram Page	Pin No	Designation	In / Out	Circuit	Significance	Destination
JM44	1052	A-19	(no use)	 =			
310144]	B-19	(no use)	_			
		1		"			
}		C-19	(")	"	ĺ		
		A-20	(")	"			
	ł i	B-20	(")	"	ĺ		
1		C-20	(")	"			
	3/12	A-21	*SOF	In	а	X-ray cutoff signal from timer	I/O CONT -96→
Ì	6/12	B-21	*TECHA	In	a	*Input selection signal for the operation	I/O CONT
		C-21	*TECHB	"	"	method *TECHBEMC (negative logic)	-96→
		A-22	*TECHC	"	"	(1:5V)	
		B-22	*TECHD	"	"	$\bot \{0:0V\}$	
						*TECH	
ĺ						DCBA Operation method Code	
						1 1 1 1 Unused	
		,				1 1 1 0 General radiography GR	
						1 1 0 1 Bucky's radiography 1 BU1	
	i i			1		1 1 0 0 Bucky's radiography 2 BU2	
				ì		1011 Tomography PL	
	[]					1010 Auto-changer radiography OX	
						1 0 0 1 MAMMO radiography (unused) MAMM	
						1 0 0 0 Direct spot filming FSP	
						0 1 1 1 I.I. indirect spot filming IFG	Ì
	ŀ					0 1 1 0 I.I. indirect spot finning 1FG	
				1		0 1 0 1 III. Indirect serial CRS	
				ļ		0 1 0 0 Serial radiography SEST	
	İ					0011	
]	0010	
	}			I		0001 DSA radiography DSP	
					I	0000 CINE radiography CIN	
JM44		C-22	*OUTSP16			Spare signal	
	1/12	A-23	*HST	In	a	Hand-switch valid signal	I/O CONT
	2	1			-	Timid-Switch Valid Signal	-96→
	9/12	B-23	*FSP1+	In	a	Input selection signal for direct high-speed	-90 7
			*IFG		_	radiography (FSP) or I.I. indirect high-speed	
				I		radiography (IFG) (for fast startup of starter)	
	8/12	C-23	*IICAME	In	a	Input selection signal for I.I. indirect camera	
			RA-IN	***	-	(for confirmation of visual radiographic position)	
JM44	7/12	A-24	*IAB-IN	In	a	*IAB-IN — I.I. field-of-view switching input	
		- '			-	signal (negative logic)	
		B-24	*IAA-IN	"	"	*IAA-IN — [1:5V]	
					İ	\0:0V∫ *IAB-IN *IAA-IN Field-of-view	
		- 1]	ŀ		1 1 Largest IF1	
		İ	ì	ļ	1	1 0 Large IF2	
		ŀ		1		0 1 Middle IF3	Į
		ļ	1]	ł	0 0 Small IF4	
	1/12	C-24	*NOKU-IN	In	a	Signal to invalidate double exposure prevention circuit	

Connector	Connectio n diagram Page	Pin No	Designation	In / Out	Circuit	Significance	Destination
JM44	ا تقان	A-25	*OUTSP14	=	-	Spare signal	
J1V144	4/12	B-25	*FSAON	In	a	Input signal for X-ray tube anode rotation in	From
	4/12	D-2.J	TOAON	***	. "	fluoroscopy	I/OCONT-96
	1/12	C-25	*SPSWE	In	a	Input signal to validate high-speed operation button	
	2	A-26	*OUTSP15	_	-	Spare input signal [TTL level]	
	4/12	B-26	*FL	În	a	Fluoroscopy enable input signal	
	9						
	1/12	C-26	*LOVE	In	а	Input signal indicating over radiographic conditions	
		A-27	*HOVE	"	"	Signal indicating over anode heat-capacity of	1
						X-ray tube (unused)	
	4/12	B-27	*FOVE	"	"	Input signal indicating over 10 minutes in fluoroscopy	
	1/12 4	C-27	*NOX	"	"	Input signal of X-ray exposure prohibition	1
	1/12	A-28	*HIG	"	"	Signal of high-speed anode rotation of X-ray tube	ļ
	1/12	B-28	*MASP-IN	"	"	Signal to stop heating circuit of the apparatus	
	2/12	C-28	*SCD	In	а	Signal to invalidate operation assurance circuit	
1	212	C 20				of general radiographic devices	
1	ļ	A-29	*OUTSP14			Spare signal [TTL level]	
JM44	7/12	B-29	*TUB	In	a	<u> </u>	
						X-ray tube number selection signal $\{1:5V\}$	From
	11 12	C-29	*TUA	"	"	(negative logic) \[\(\begin{aligned} \ 0:0V \end{aligned} \]	I/OCONT-96
ļ						*TUB *TUA X-ray tube number	
l						1 1 Unused	
						1 0 TUBE1	
	j					0 1 TUBE2	
1						0 0 TUBE3	
ļ		A-30	*OUTSP11			· ·	
ł	6/12	B-30	*FOB	In	a		
	0/12	D -30	TOB	111	"	X-ray tube focus selection signal \(1 \cdot 5V \)	
1		C-30	*FOA	"	"	(negative logic) 0:0V	
					}		
l	1	l		}		*FOB *FOA X-ray tube focus	
	}	ĺ		1		1 1 Unused	
		ļ	j	ĺ	ļ	1 0 Small focus	
Ì		Ì	ì	İ		0 1 Large focus 0 0 Micro focus (unused)	
	<u> </u>					O O Micro rocus (dilused)	
		A-31	GND	In			Mother-96
	l	B-31	"	"			
		C-31	"	"		GND input	
		A-32	GND	In	Ì		
1		B-32	" .	"			
		C-32	"	"	<u>L</u> .		

Connector No	Connectio n diagram Page	Pin No	Designation	In / Out	Circuit	Significance	Destination
J125	10/12	A-1	+15V	Out			TERMINAL I
		B-1	"	"	j	+15 V output	-96
1		A-2	+24V	"		1247	
İ		B-2	"	"		+24 V output	
	9/12	A-3	*TS14	Out	h	DSA operation selection signal	TERMINAL I
		B-3	*KC14	"	"	Radiography preparation signal output to DSA device	-96
	0/10	A-4	*XR14	"	"	X-RAY signal output to DSA device	
	8/12	B-4	*EXP1	In	f	X-RAY OK input signal from DSA device	TERMINAL II
		A-5	*EXP2			-	-96
		B-5	*AR2I	In	b	READY operation second input signal	
		A-6	*HX2I	"	"	X-RAY operation second input signal	
	7/12	B-6	*PUL2	"	"	Pulse radiography selection signal input (unused)	
	1/12	A-7	*MV1	In	a	Signal to move top-panel of examination bed	
		B-7	*MV3			forward [output from film-changer device]	
		D-/	*M V 3	"	"	Signal to move top-panel of examination bed	
		A-8	*M36		,	backward [output from film-change device]	
		A-0	-M130	Out	h	Signal to move top-panel backward, which	
	ĺ	B-8	*M34	"	11	drives relay of TERMINAL2-96 board	
		D-0	14134	"	"	Signal to move top-panel forward, which drives relay of TERMINAL2-96 board	İ
	9/12	A-9	*XROB	Out	"	X-RAY ON signal output	
·	3/12	B-9	*XRIN	//	"	Output signal for X-RAY exposure	
		A-10	(no use)			output signal for 21 Terri exposure	
	9/12	B-10	*SR2	Out	h	SEST operation selection signal output	TERMINAL II
	8/12	A-11	*RY3	In	ь	READY operation signal input from	PUCK→
					ı	film-changer device	
	9/12	B-11	*KCS2	Out	h	Radiographic preparation signal output to	→STA-30
]	STA-30 device (KC signal output)	
	8/12	A-12	*CU2	In	b	Acknowledge signal of heating from STA-30 device	STA-30→
<u> </u>	9/12	B-12		Out	h	READY UP signal output to film-changer device	→ PUCK
	8/12	A-13	*SE2	In	b	X-ray operation signal input from film-changer device	PUCK→
	9/12	B-13	*EPS2	Out	h	X-ray radiation signal output to STA-30 device	→STA-30
-	0/12	4 14		$\overline{}$		(EXR signal output)	
	9/12	A-14		Out	h	CINE operation selection signal output (unused)	TERMINAL II -96→CINE
	- 1	B-14	*KC8	Out	h	Radiographic preparation signal output for	→CINE
			1	ľ	j	CINE operation (unused)	j
			****			(KC signal output)	ļ
		A-15		Out	h	Radiographic preparation signal output (KC signal output)	TERMINAL II -96
1		B-15.	*CA2	Out	h	X-RAY ON signal output to CINE camera	→CINE
Ī		A 16	********			device (")	1
}	- +	A-16 B-16	*XR8	<i>"</i>	"	" (")	
ŀ	$\overline{}$	A-17	(no use) *CM4	\exists		CINE comore current	
}		B-17	0V	_		CINE camera exposure signal (unused) 0 V for CM4 (unused)	İ
		21,				o v for Civi4 (unused)	

Connector	Connectio n diagram Page	Pin No	Designation	In / Out	Circuit	Significance	Destination
J125	8/12	A-18	FOOT2	In	b	Foot-switch signal input	TERMINAL II
1		B-18	(no use)				-96
		A-19	GND	In			Mother-96
1		B-19	"	"		am.	
		A-20	"	"		GND input	1
		B-20	"	"			

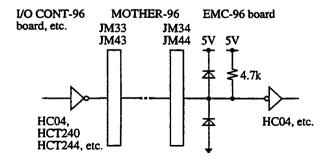
Connector No	Connectio n diagram Page	Pin No	Designation	In / Out	Circuit	Significance	Destination
J126	10/12	A-1	+15V	Out		+15 V output	TERMINAL
		B-1	"	"		+13 v output	-96
ŀ		A-2	+24V	"		+24 V output	
ĺ	4/10	B-2	"	"			
	4/12	A-3	*SD124	Out	h	Output signal to switch tube current detecting circuit	TERMINAL
	7/12	B-3	*3M	Out	h	of high-voltage generator to fluoroscopy side.	-96 JH1
	//12	A-4	*2M	Out "	"	Signal to select third tube Signal to select second tube	TUBE SELEC -TOR-96
		B-4	*1M	"	"	Signal to select first tube	-10K-90
	7/12	A-5	*XR-1M	Out	h	First tube X-ray radiation signal	TERMINAL
		B-5	*XR-2M	"	"	Second tube X-ray radiation signal	-96
	8/12	A-6	*LC	In	а	X-ray tube thermal condition acknowledge signal	JH3
	9/12	B-6	*1B22	Out	h	Drive signal output to Bucky's device 1	TERMINAL
			-			(X-RAY signal output)	-96
	8/12	A-7	*1B1	In	d	X-RAY OK signal input from Bucky's device 1	
	9/12	B-7	*2B22	Out	h	Drive signal output to Bucky's device 2	
						(X-RAY signal output)	
	8/12	A-8	*2B1	In	d	X-RAY OK signal input from Bucky's device 2	
	9/12	B-8	*KC1 (PL)	Out	h	Preparation signal output to tomographic device (KB)	TERMINAL
	·	A-9	*P22	Out	"	Drive signal output to tomographic device	-96
	8/12	B-9	*P1	In	d	X-RAY OK signal input from tomographic	
		A-10	*PG2	"	ь	device Intermittent exposure signal input from	
						tomographic device (to stop the operation of	Į.
	7/10	7.10				double exposure prevention flag)	
	7/12	B-10	*1 M I	Out	i	Signal to select first tube	TERMINAL -96
	:	A-11	*2MI	"	"	Signal to select second tube	→INTEGRA- TE BUCKY
	9/12	B-11	*KC5 (OX)	Out	h	Radiography preparation signal output to auto-changer device	TERMINAL -96
		A-12	*XR5	Out	"	X-RAY signal output to auto-changer device	→ox
ļ	8/12	B-12	*XS5	In	d	X-RAY OK signal input from auto-changer device	
	9/12	A-13	*REAO	Out	h	READY UP signal output	TERMINAL
ł	0/10	B-13	*SMALL	"	"	Output signal to select small focus	-96
	8/12	A-14	DOOR	In	b	Input signal of short-circuited door contact	
ł	9/12	B-14	*KC34	0-4		(for confirmation of closed door)	
ļ	7112	D-14	'AC34	Out	h	Preparation signal output to I.I. indirect	TERMINAL
		A-15	*XR1	"	,	high-speed radiographic camera device	-96
l		N-15	AKI		<i>"</i>	Radiographic X-ray radiation signal output to I.I. indirect high-speed radiographic camera device	
ļ		B-15	*XR34	"	,,	X-RAY signal output to I.I. indirect high-speed	Camera
			12.5			radiographic camera device	Camera
t	8/12	A-16	*XS4	In	b	X-RAY OK signal input from I.I. indirect	TERMINAL
		ļ				high-speed radiographic camera device	-96
		B-16	*PG4	"	"	Signal to select consecutive radiographic	
ļ		ļ				operation in indirect camera operation (CRS)	
					_]	(Input for one-sheet film operation)	
Ţ	9/12	A-17	*SRD1	Out	j	Signal to output X-RAY OK signal inputted	TERMINAL
	}		ļ			from fluoroscopic operation bed to DSF700	-96
<u>.</u>							→DFS700

Connector No	Connectio n diagram Page	Pin No	Designation	In / Out	Circuit	Significance	Destination
J126	8/12	B-17	*SP1	In	′ q	Radiographic operation signal input from f	TERMINAL
						luoroscopic operation bed	-96
	9/12	A-18	*SP2	Out	h	Output signal on input of SP1 signal in	
						FSP operation (for film exposure)	
		B-18	*FOOT1	"	"	Foot-switch input enable signal output	
	8/12	A-19	*F	In	ď	Fluoroscopic X-RAY signal input from	TERMINAL
}						foot-switch	- 9 6
		B-19	*R	"	"	READY operation signal input from	
						fluoroscopic operation bed	
	9/12	A-20	*RE	Out	h	READY UP signal output to fluoroscopic	
						operation bed	
	8/12	B-20	*RD	In	ď	X-RAY OK signal input from fluoroscopic	
	1					operation bed	
		A-21	*FSE1	In	а	Input signal to select consecutive operation	
						from fluoroscopic operation bed	
ł	9/12	B-21	*PRU	Out	h	TIME UP signal output to fluoroscopic operation bed	
İ		A-22	*FOUT	"	"	Output contact of KB or KTF signal (Signal	→JTH-RB
	† :		ļ			output from I.I. getter interruption contact point)	
ł		B-22	*RUC4	Out	j	TIME UP signal output to fluoroscopic	
İ						operation bed	→CN4
		A-23	*REC4	"	"	READY UP signal output to fluoroscopic	
						operation bed	→CN4
1		B-23	*S100C4	"	"	Fluoroscopy enable signal output to	
						fluoroscopic operation bed	→CN4
		A-24	GND	In			Mother-96
		B-24	"	"		GND input	
		A-25	"	"			
		B-25	11	"			

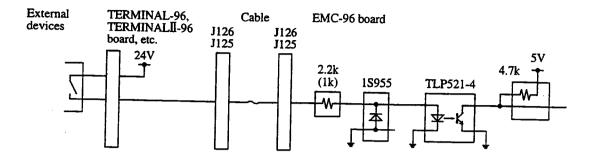
[2] Input/output circuit

Input/output circuits for the signals are as follows

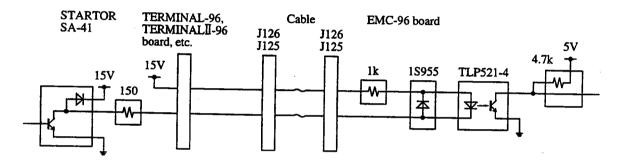
(a) Input circuit [No. 1] {HC-CMOS (5 V) level}



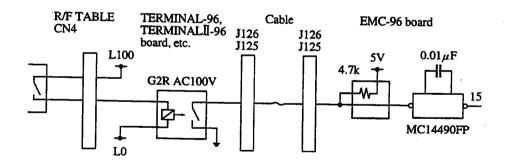
(b) Input circuit [No. 2]



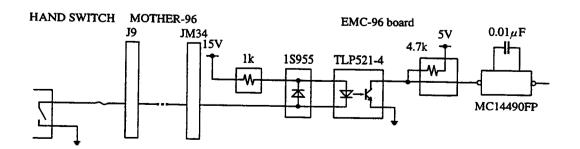
(c) Input circuit [No. 3]



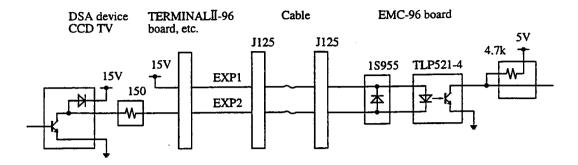
(d) Input circuit [No. 4]



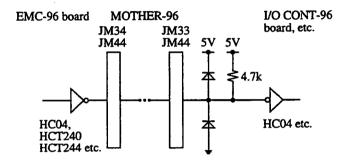
(e) Input circuit [No. 5]



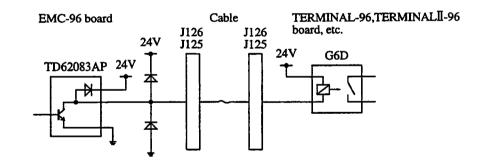
(f) Input circuit [No. 6]



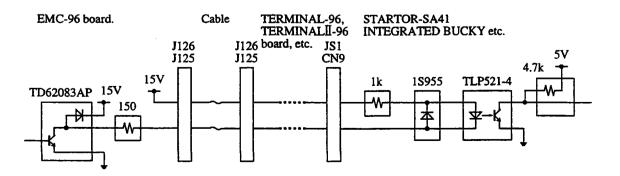
(g) Output circuit [No. 1] {HC-CMOS (5 V) level}



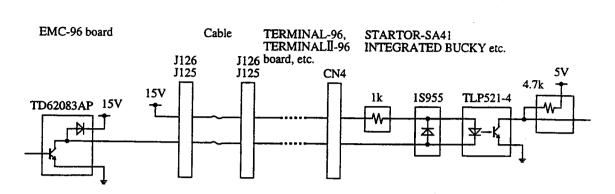
(h) Output circuit [No. 2] {Relay drive (24 V) from transistor}



(i) Output circuit [No. 3] {Current-loop drive (15 V) from transistor}



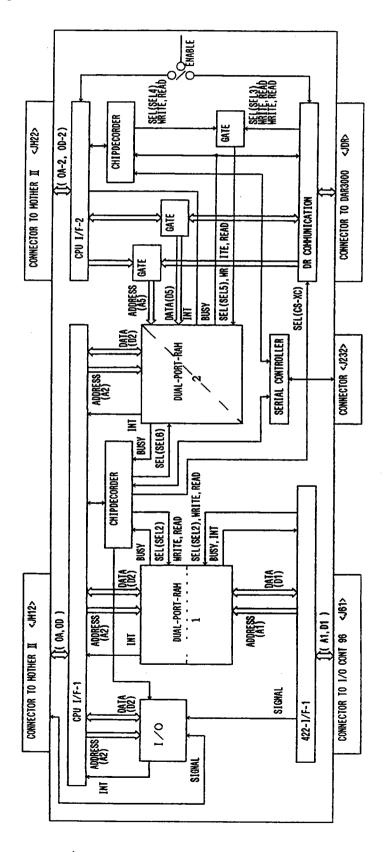
(j) Output circuit [No. 4] {Current-loop drive (15 V) from transistor}



8. DUAL PORT-96 board

8.1 Schematic diagram of DUAL PORT-96 board

Block diagram of DUAL PORT-96 board is shown below.



8.2 Functions

For functions of DUAL PORT-96 board, refer to [1] (b) "DUAL-PORT-96 board" in 2.2 "Outline of circuit board functions".

8.3 Phenomena in failures

When DUAL PORT-96 board is in failures, following symptoms appear.

- 1) When power is turned ON, Communication ERR is displayed.
- 2) While fluoroscopic tube voltage varies, radiographic conditions cannot be changed.
- 3) The density control knob and reset key of fluoroscopic timer on X-ray console do not work.
- 4) Buzzer sound of small sheet-key and displays of READY and X-RAY do not appear.
- 5) Displays on DAR3000 are not shown.

8.4 Circuit descriptions and significance of signals

Circuit diagram on Page 2

This circuit shows the interfaces of buses, interruption lines, control lines, etc. with NEXSC.EXT board.

A1 [1] ~ A1 [23] \rightarrow Address bus for CPU-2

S1 [0] \sim D1 [5] \rightarrow Data bus for CPU-2

FC0 ~ FC2, *AS, *LDS, *UDS, R/*W

→ Control signals for CPU-2

RESET, *RESET → Reset signals

CLK12 → Clock-line for CPU-2 (12 MHz)

*O_DTACK → Control finish of CPU-2

Circuit diagram on Page 3

This circuit generates signals to access the IC's in accordance with controls of CPU-2.

*SEL8441_1 → Signal to select 2PORT-memory-1 (for memory communication with CPU-1)

*WRH_1 → Write signal to 2PORT-memory-1 (M27 side)

*WRL_1 → Write signal to 2PORT-memory-1 (M36 side)

*RD_1 → Read signal from 2PORT-memory-1

*GATE → To open the data transfer gate with CPU-2

O_DTACK \rightarrow Control finish of CPU-2

*SEL8441_6	→	Signal to select 2PORT-memory-2 (for memory communi-
		cation with DAR3000)

Circuit diagram on Page 4

This circuit shows the interfaces of buses, interruption lines, control lines, etc. with optional NEXSC board (CPU-3).

tion

*ENCPU_2	→ Communication enabled signal between extended NEXSC
	board (CPU-2) and optional NEXSC board (CPU-3)

Circuit diagram on Page 5

This circuit generates signals to access the IC's in accordance with controls of CPU-3.

*WRL_2 → Write signal to 2PORT-memory-2 (M45 side)

*RD_2 → Read signal from 2PORT-memory-2

*GATE_2 → To open the data transfer gate with CPU-3

O_DTACK_2 → Control finish of CPU-3

Circuit diagram on Page 6

This circuit input/outputs signals through NEXSC.BASE board (CPU-1) and J61 cable of I/O CONT-96 board.

A3 [1] \sim A3[23] \rightarrow Address bus for CPU-1

Circuit diagram on Page 7

D3 $[0] \sim$ D3 $[15] \rightarrow$ Data bus for CPU-1

Circuit diagram on Page 8

This circuit controls communication with DAR3000.

*SEL8441_4 → Signal to select 2PORT-memory-2 (for memory communication with DAR3000) (from DAR3000 or CPU-3)

DAR3000 or CPU-3)

*WRL_4 → Write signal to 2PORT-memory-2 (M45 side) (from

DAR3000 or CPU-3)

*RDH_4 → Read signal from 2PORT-memory-2 (M40 side)

DAR3000 or CPU-3)

INT89372

Interruption signal for data transfer completion to

DAR3000

Circuit diagram on Page 9

This circuit switches the signals in accordance with the switch settings.

Circuit diagram on Page 10

This circuit is for RS2332C communication control.

Circuit diagram on Page 11

This circuit switches the interruption lines.

Signals for passing various data

Circuit diagram on Page 12

This circuit deals with signal input/outputs.

*TRESET → Fluoroscopic timer reset button on X-ray console

*DE+3, +2, +1, 0, -1, -2, -3

→ Density switches on X-ray console

*BUZ1 → Buzzer for small sheet-panel, high-tone

*BUZ2 → Buzzer for small sheet-panel, low-tone

*TIMDISP → Display of fluoroscopic timer reset button on X-ray con-

sole

*XRDISP → X-RAY display for small sheet-panel

*READISP → REACY display for small sheet-panel

*O_EXITIR1 → Interruption input of X-RAY (unused)

Circuit diagram on Page 13

Memory for the communication between basic NEXSC board (CPU-1) and extended NEXSC board (CPU-2)

Circuit diagram on Page 14

Memory for the communication between extended NEXSC board (CPU-2) and optional NEXSC board (CPU-3)

9. DISPCONT-96 board

9.1 Outline of functions

9.1.1 Functions in color display

Control LSI

AGDC

IC, µ PE72123GJ-5BG (075-31909-01)

Display memory

RAM 2MByte (Dualport Grapthics Buffer)

IC, MB818251-70PZS-G (075-32696)

RAM 4MByte (Dualport Grapthics Buffer)

IC, MB818251-70PZS-G (075-32696)

Font ROM 1 MByte

IC, MB834200-B-003 (075-32685-02)

(First grade, Second grade)

Display area

640 * 480 Dot * 4 Plane

640 * 480 Dot * 8 Plane (Option)

Display colors

Digital 16 colors

16 colors in 32768 colors

256 colors in 32768 colors (option)

IC,

Host I/F

In conformity with NEXSC-I/F

VRAM area is set on CPU memory-map.

Possible to set every 1 MByte from 600000H to 7FFFFFH

AGDC register area is set on CPU-IO map.

Offset 000H-0FFH

Refer to 9.2 "In-line package switch setting".

Display device

TFT color LCD (640*480)

LCD, LQ10D021 (078-1211701-02)

or interchangeable one

Device I/F

Differential-type line-drive (Quasi ECL level)

IC, MB571PF (075-32713-02)

Operational clock

CLK: 8.000 MHz

SCLK: 3.375 MHz

DCLK: 27.000 MHz

9.1.2 Functions in monochrome display

Control LSI

LCD controller

IC, HD66850 (075-35705-01)

Display memory

RAM 256KByte (Dualport Grapthics Buffer)

IC, TC524256Z-10 (075-3362-05)

or interchangeable one

Display area

640 * 480 Dot * 1 Plane

640 * 480 Dot * 4 Plane

Display color

Monochrome

Host I/F

In conformity with NEXSC-I/F

LCDC register area is set on CPU-IO map.

Offset 140H-14FH

Refer to 9.2 "In-line package switch setting".

Display device

ELDisplay

EL DISPLAY, LJ64H052 (078-12301-07)

or interchangeable one

Device I/F

Differential-type line-drive (RS422 level)

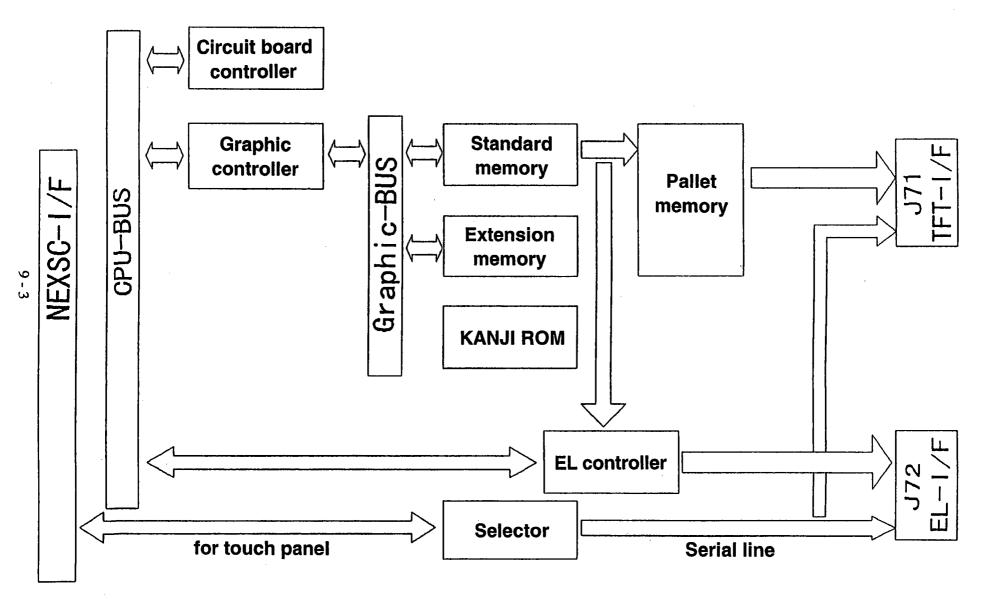
IC, DS26C31CM (075-11927-02) (*3)

or interchangeable one

Operational clock

DCLK: 32 MHz

Block diagram of DISPCONT-96 board



9.2 In-line package switch setting

9.2.1 SW1

1-5 Standard value setting of I/O addresses.

1	2	3	4	5	Set value	
OFF	OFF	OFF	OFF	OFF	F20000	(standard)
OFF	OFF	OFF	OFF	ON	F21000	(oundard)
OFF	OFF	OFF	ON	OFF	F22000	
OFF	OFF	OFF	ON	ON	F23000	
OFF	OFF	ON	OFF	OFF	F24000	
OFF	OFF	ON	OFF	ON	F25000	
OFF	OFF	ON	ON	OFF	F26000	
OFF	OFF	ON	ON	ON	F27000	
OFF	ON	OFF	OFF	OFF	F28000	
OFF	ON	OFF	OFF	ON	F29000	
OFF	ON	OFF	ON	OFF	F2A000	
OFF	ON	OFF	ON	ON	F2B000	
OFF	ON	ON	OFF	OFF	F2C000	
OFF	ON	ON	OFF	ON	F2D000	
OFF	ON	ON	ON	OFF	F2E000	
OFF	ON	ON	ON	ON	F2F000	
ON	OFF	OFF	OFF	OFF	F30000	
ON	OFF	OFF	OFF	ON	F31000	
ON	OFF	OFF	ON	OFF	F32000	
ON	OFF	OFF	ON	ON	F33000	
ON	OFF	ON	OFF	OFF	F34000	
ON	OFF	ON	OFF	ON	F35000	
ON	OFF	ON	ON	OFF	F36000	
ON	OFF	ON	ON	ON	F37000	
ON	ON	OFF	OFF	OFF	F38000	
ON	ON	OFF	OFF	ON	F39000	
ON	ON	OFF	ON	OFF	F3A000	
ON	ON	OFF	ON	ON	F3B000	
ON	ON	ON	OFF	OFF	F3C000	
ON	ON	ON	OFF	ON	F3D000	
ON	ON	ON	ON	OFF	F3E000	•
ON	ON	ON	ON	ON	F3F000	

6 EL controller (for cost-down); Yes, or No

OFF: Yes (standard)

ON: No

7 Extension memory (option); Yes, or No

OFF: No (standard)

ON: Yes

8 Color pallet memory (option); Yes, or No

OFF: No (standard)

ON: Yes

9.2.2 SW2

1 Video memory area setting OFF: 600000-6FFFFF are used. (standard) ON: 700000-7FFFFF are used. 2 Spare; OFF 3, 4 Interruption level setting of AGDC Setting **OFF** OFF ADGC interruption is not used. (standard) ON **OFF** Interruption level 3 is used. OFF ON Interruption level 4 is used. ON ON (Setting prohibited) 5 Spare; OFF 6 Spare; OFF 7 Spare; OFF 8 Spare; OFF

9.3 Memory map

9.3.1 MPU memory map

600000-6FFFFF VRAM area (SW2-1 = OFF) 6F0000-6FFFFF Pallet memory area, (in pallet direct access mode) 700000-7FFFFF VRAM area (SW2-1 = ON) 7F0000-7FFFFF Pallet memory area, (in pallet direct access mode) F20000-F3FFFF I/O area 000-0FF AGDC register area 100-10F MB82365-A register area 110-11F MB82365-B register area 140-14F CLNE (LCD Controller) register area 200-21F Pallet area in 16-color mode 200-3FF Pallet area in 256-color mode

9.3.2 Details of I/O map

Refer to each manual for AGDC register area and CLINE register area.

PIO bit map

100: Reading SW1 (input)

BIT 7 6 5 4 3 2 1 0

SW1-1 2 3 4 5 6 7 8

Input is H in SW ON, and L in SW OFF.

102: Reading SW2 (input) for RS232C control signal input

BIT 7 6 5 4 3 2

SW1-1 2 3 4 5 6

Input is H in SW ON, and L in SW OFF.

BIT1 CTS signal input

BITO DSR signal input

104: LED block (output) light

BIT 7 6 5 4 3 2 1 0

LED 1 2 3 4 5 6 7 8

LED is OFF in output H, and ON in output L.

110: Operation mode control (output)

BIT7 Setting of pallet memory direct access mode; Yes, or No

0 = Yes

1 = No (standard)

BIT6 Setting of EL memory direct access mode; Yes, or No

0 = Yes

1 = No (standard)

BIT5 Spare, output H

BIT4..... Setting of color mode

0 =Analog mode setting

1 = Digital mode setting (standard)

BIT3 Setting of color pallet mode

0 = 256-color mode setting

1 = 16-color mode setting (standard)

BIT2 Setting of color mode for EL

0 = Monochrome mode setting

1 = 16-color mode setting (standard)

BIT1 Setting of use of EL display; Yes, or No

0 = Yes

1 = No (standard)

BIT0 Setting of use of TFT LC display; Yes, or No

0 = Yes

1 = No (standard)

112: Pallet bank control (output), RS232C control

BIT7 Permission of use of RS232C control; Yes, or No

0 = Yes

1 = No (standard)

BIT6 Switching of RS232C port

0 = Port for EL display is used.

1 = Port for TFT LC display is used.

BIT5 RTS signal output

BIT4 DTS signal output

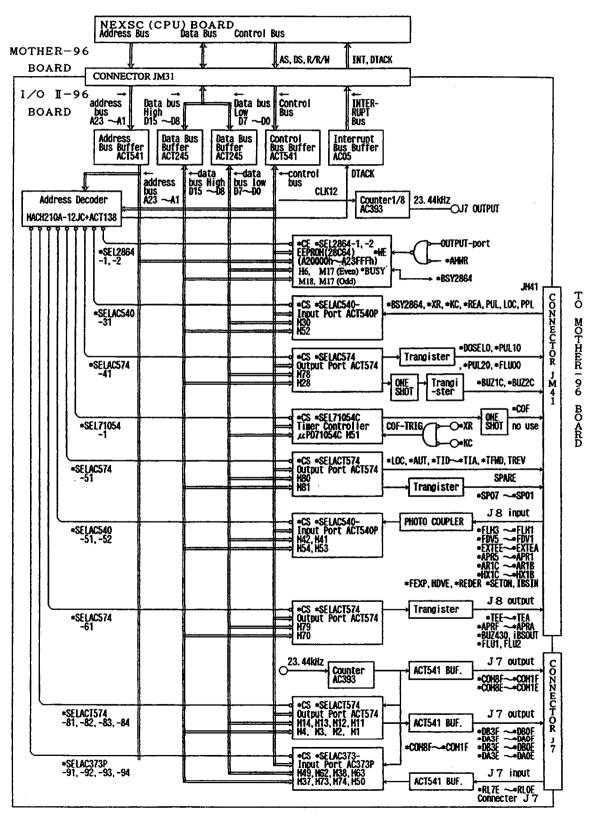
BIT3-0 Selection of pallet bank

3	2	1	0	Setting
OFF	OFF	OFF	OFF	Pallet bank 0 is used. (standard)
OFF	OFF	OFF	ON	Pallet bank 1 is used.
OFF	OFF	ON	OFF	Pallet bank 2 is used.
OFF	OFF	ON	ON	Pallet bank 3 is used.
OFF	ON	OFF	OFF	Pallet bank 4 is used.
OFF	ON	OFF	ON	Pallet bank 5 is used.
OFF	ON	ON	OFF	Pallet bank 6 is used.
OFF	ON	ON	ON	Pallet bank 7 is used.
ON	OFF	OFF	OFF	Pallet bank 8 is used.
ON	OFF	OFF	ON	Pallet bank 9 is used.
ON	OFF	ON	OFF	Pallet bank 10 is used.
ON	OFF	ON	ON	Pallet bank 11 is used.
ON	ON	OFF	OFF	Pallet bank 12 is used.
ON	ON	OFF	ON	Pallet bank 13 is used.
ON	ON	ON	OFF	Pallet bank 14 is used.
ON	ON	ON	ON	Pallet bank 15 is used.

10. I/O II -96 board

10.1 Schematic diagram of I/O II -96 board

This board comprises NEXSC(CPU) board, EEPROM(28C64), Timer IC (μ PD71054C), Input IC (ACT540, 373), Output IC (ACT574), connectors, buses, etc.



10.2 Input/output signals on I/O II -96 board

[1] Input/output signals on I/O II -96 board are as follows.

For circuit mark $r \sim w$, refer to 6.2 "Input/output signals on I/O CONT-96 board" [2] "Input/output circuit", for $k \sim p$, refer to 13.3 "EXT CONT-96 board" [2] "Input/output circuit", and for $a \sim j$, refer to 7.31 "Input/output signals on EMC-96 board" [2] "Input/output circuit".

Connector No	Connectio n diagram Page	Pin No	Designation	In / Out	Circuit	Significance	Destination
JM31	13/13	A-1 B-1 C-1 A-2 B-2 C-2	+5V	In		DC power supply +5 V	Mother-96
		A-3 B-3 C-3	+15V	In		+15 V input	
		A-4 B-4 C-4	-15V	În		-15 V input	
JM31	4/13	A-5	*AR1I	Out		READY operation output signal	→EMC-96
		B-5	*HX1I	Out		X-RAY operation output	
		C-5	(no use)	-	_		
		A-6 B-6	"	"	"		
ļ		C-6	"	"	"		
]		A-7	,,	"	"		ļ
ì	}	B-7	"	"	"		
1	ļ	C-7	"	"	"		
ļ		A-8	"	"	"		
1		B-8	"	"	"	•	
Ì		C-8] "	"	"		
1		A-9	"	"	"		
į.		B-9	"	"	"		
		C-9	"	"	"		
1		A-10	"	"	"		
	<u> </u>	B-10	, "	"	"		
l	[C-10	"	"	"		
1	i i	A-11 B-11	"	"	"		
1	i i	C-11	,,	"	"		
\		A-12	"	"	"		
1	[B-12	"	"	"		
1		C-12	"	"	"		
1		A-13	"	"	"		
1	1/13	B-13	O-GATE	In	a		NEXSC
1		C-13	OUT-FC2	"	"		(BASE)
		A-14	OUT-FC1	"	"		
1	1	B-14	OUT-FC0	"	"		}
1		C-14	*OUT-AS	"	"	Control Signals	
[A-15	*OUT-LDS	"	"		ŀ
		B-15	*OUT-UDS		"		1
1		C-15	OUT-R/*W		"	}	
L	<u> </u>	A-16	O-DTACK	Out	g		<u> </u>

Connector No	Connectio n diagram Page	Pin No	Designation	In / Out	Circuit	Significance	Destination
JM31	1/13	B-16	0D [15]	In	a		NEXSC
		C-16	" [14]	"	"		(BASE)
ļ		A-17	/ [13]	"	"		(DIED)
		B-17	/ [12]	"	"	[]	İ
		C-17	" [11]	"	"		
		A-18	/ [10]	"	"		
1		B-18	/ [9]	"	"		
ľ		C-18	/ [8]	"	"		
		A-19	"[7]	"	"	Data Bus	
		B-19	<i>"</i> [6]	"	"		
]]	C-19	<i>"</i> [5]	"	"		
ľ		A-20	<i>"</i> [4]	"	"		
	1 1	B-20	" [3]	"	"		l
	ì	C-20	" [2]	"	"		
]		A-21	" [1]	"	"		
		B-21	/ [0]	"	"		
ЈМ31	1/13	C-21	0A [23]	In	a	· · · · · · · · · · · · · · · · · · ·	NEXSC
		A-22	" [22]	"	"		(BASE)
ĺ		B-22	" [21]	"	"		
1		C-22	″ [20]	"	"		
ŀ		A-23	" [19]	"	"		
] [B-23	" [18]	"	"		
		C-23	″ [1 7]	"	"		
	1 1	A-24	″ [16]	"	"		
		B-24	" [15]	"	"		
	1	C-24	" [14]	"	"		
	i	A-25	" [13]	"	"		
		B-25	" [12]	"	"		ł
	1	C-25	" [11]	"	"	Adress Bus	
		A-26	" [10]	"	"		
		B-26	" [9]	"	"		
		C-26	″ [8]	"	"		
		A-27	" [7] " [6]	"	"		
		B-27 C-27	" [6] " [5]	"	"		
			" [5] ,	"	"		
		A-28 B-28	″ [4] ″ [3]	"	" "		
		C-28	" [3] " [2]	"	",		Ī
		A-29	" [2] " [1]	"	"		
ЛМ31	1/13	B-29	*O-RESET	In	a	RESET INPUT SIGNAL	
-		C-29	O-CLK12	"	"	CLOCK [12MHz] INPUT SIGNL	
Ì	5/12	A-30	*SP01	Out	g		
		B-30	*SP02	"	"	Spare output signal	ļ
ŀ		C-30	*SP03	"	"	[+15 V current-loop]	
Ţ	5/12	A-30	GND	In			Mother-96
1		B-31	"	"			2-104101-70
ł		C-31	"	"		GND input	ļ
İ		A-32	GND	In		21412 լանու	1
		B-32	"	"			ļ
		C-32	"	"			

Connector No	Connectio n diagram Page	Pin No	Designation	In / Out	Circuit	Significance	Destination
JM41	6/13	A-1	*APR1	In	t	APR key selection input signal	Mother-96
		B-1	EXPWC	In	"	Common power input from external devices (C)	J8 → JM41
		C-1	(N.C.)				
		A-2	*APR3	In	t	APR key selection input signal	Mother-96
{		B-2	*APR2	"	"	"	J8→JM41
	4/13	C-2	*PPL	In	а	Signal to move top panel of examination bed [TTL level]	EMC-96→
[6/13	A-3	*APR5	In	t	APR key selection input signal	Mother-96
		B-3	*APR4	"	"	"	J8→JM41
	4/13	C-3	*PUL	In	a	Pulse radiography selection signal (unused)	EMC-96→
	6/13	A-4	*HX1C	In	t	Radiographic operation input signal (C)	Mother-96
		B-4	*APR6	In	t	APR key selection input signal	J8 → JM41
	4/13	C-4	*SPI2	In	a	Spare input signal	Mother-96
	6/13	A-5	EXPWB	In	t	Common power input from external devices (B)	Mother-96
		B-5	*AR1C	In	"	Radiographic preparation start input signal (C)	J8 → JM41
	4/13	C-5	*SPI3	In	a	Spare input signal	Mother-96
	6/13	A-6	*EXTEB	In	t	Operation method selection input signal	Mother-96
						from external devices	J8 → JM41
		B-6	*EXTEA	"	"	"	
	4/13	C-6	*SPI4	In	а	Spare input signal	Mother-96
	6/13	A-7	*EXTED	In	t	Operation method selection input signal	Mother-96
						from external devices	J8 → JM41
		B-7	*EXTEC	"	"	"	
	4/13	C-7	*SPI5	In	a	Spare input signal	Mother-96
	6/13	A-8	*RDER	In	t	Leader radiography selection signal	Mother-96
		B-8	*EXTEE	"	"	Operation method selection input signal	J8→JM41
						from external devices	
	4/13	C-8	*KC	In	a	Radiographic preparation start input signal	EMC-96→
	6/13	A-9	*FEXP	In	t	First X-ray input signal from fluoroscopic	Mother-96
						operation bed to film	J8 → JM41
		B-9	*HDEV	"	"	Input signal for film division direction	
	4/13	C-9	*REA	In	a	Radiographic preparation finish input signal	EMC-96→
	6/13	A-10	EXPWA	In	t	Common power input from external devices	Mother-96
		B-10	"	"	"	"	J8→JM41
	4/13	C-10	*SPI1	In	а	Spare input signal	
]	6/13	A-11	*FDV2	In	t	Signal to select film division size (6 divisions)	Mother-96
		B-11	*FDV1	"	"	Signal to select film division size (9 divisions)	J8 → JM41
	4/13	C-11	*XR	In	a	Measured X-RAY signal [TTL level]	EMC-96→
	6/13	A-12	*FDV4	In	t	Signal to select film division size (3 divisions)	Mother-96
		B-12	*FDV3	"	"	Signal to select film division size (4 divisions)	J8→JM41
	4/13	C-12	(N.C.)	_			
	6/13	A-13	*FLM1	In	t	Signal to select film size (quarter size)	Mother-96
		B-13	*FDV5	In	"	Signal to select film division size (2 divisions)	
1	4/13	C-13	*BZ2C	Out	i	Buzzer output signal [for FLUO.PANEL]	JM41→MOTH
1	}						-ER-96 J10

Connector No	Connectio n diagram Page	Pin No	Designation	In / Out	Circuit	Significance	Destination
JM41		A-14	*FLM3	In	t	Signal to select film size (continent size)	Mother-96
		B-14	*FLM2	"	"	Signal to select film size (large size)	J8 → JM41
	4/13	C-14	*BZ1C	Out	i	Buzzer output signal [for FLUO.PANEL]	ЈМ41 → МОТН
				ì			-ER-96 J10
	6/13	A-15	*SETON	In	t	Input signal to reset 5-minute timer for fluoroscopy	Mother-96
		B-15	*IBSIN	"	"	IBS selection input signal	J8→JM41
	4/13	C-15	*LOCK	In	a	DSA selection signal (for IDR 700)	TERMINAL→
			·				J127
	6/13	A-16	*AR1B	In	t	READY operation input signal (B)	Mother-96
		B-16	*HX1B	In	"	Radiographic operation input signal (B)	J8→JM41
		C-16	(N.C.)				
	12/13	A-17	GND	Out	_	GND output	лм41→мотн
		B-17	"	"	"	•	-ER-96 J10
	4/13	C-17	*DOSELOO	Out	i	(Unused) [for FLUO.PANEL]	лм41→мотн
							-ER-96 J10
	12/13	A-18	GND	Out	_	GND output	лм41 → мотн
		B-18	"	"	"		-ER-96 J10
	4/13	C-18	*PUL10	Out	i	Pulse-rate selection output signal	JM41→MOTH
	"."]		-	[for FLUO.PANEL]	-ER-96 J10
		A-19	(N.C.)				
	6/13	B-19	*IBSOUT	Out	i	IBS selection intermediate output signal	ЈМ41 → МОТН
	0,13	D-17		"	"		-ER-96 J10
	4/13	C-19	*PUL20	Out	i	Pulse-rate selection intermediate output signal	JM41→MOTH
	7,13	C-17	10220		•	[for FLUO.PANEL]	-ER-96 J10
	6/13	A-20	*SPJ801	Out	i	Spare output signal [for J8]	JM41
	0,13	B-20	(N.C.)		÷	opas surpus again (100 so)	
	4/13	C-20	*PFLUOO	Out	i	Pulse fluoroscopy selection output signal	JM41→MOTH
	7/13	C-20	112000		•	[for FLUO.PANEL]	-ER-96 J10
	6/13	A-21	*APRB	Out	i	APR key selection output signal	JM41→MOTH
	0,13	B-21	*APRA	"	"	"	-ER-96 J8
	4/13	C-21	*PLFUOTTL	Out	g	Pulsed fluoroscopy selection output signal [TTL level]	→ EMC-96
	6/13	A-22	*APRD	Out		APR key selection output signal	JM41→MOTH
	0/13	B-22	*APRC	//	"	"	-ER-96 J8
	5/13	C-22	*COF	Out	g	X-ray cutoff signal from CINE 1 exposure	→EMC-96
	3,13	0-22			۶	timer (unused)	
1	6/13	A-23	*APRF	Out	i	APR key selection output signal	JM41→MOTH
•	0,13	B-23	*APRE	//	,	// // K KOJ SOICCHOII OULPUL SIGNAL	-ER-96 J8
1	5/13	C-23	*LOC	Out	 	Signal to fix radiographic conditions	→ EMC-96
ı	3/13	C-23	LOC	Out	g	(for CINE AUTO) (unused)	LIVIC-30
	6/12	A 24	*17 170	0.11	<u> </u>	 	JM41→MOTH
1	6/13	A-24	*FLU2	Out	i	APR key selection output signal	ì
	5/12	B-24	*FLU1	╄	├	 	-ER-96 J8 → EMC-96
	5/13	C-24	*AUT	Out	g	CINE AUTO selection signal [TTL level] (unused)	ENIC-90
	<u></u>	A-25	(N.C.)	 -	<u> </u>		
		B-25	*BZ430	Out	i	Signal output when 4 min. and 30 sec.	JM41→MOTH
			1	1		has passed with 5-minute fluoroscopic timer	-ER-96 J8

Connector No	Connectio n diagram Page	Pin No	Designation	In / Out	Circuit	Significance	Destination
JM41	5/13	C-25	(*TIA)	Out	g	X-ray cutoff signal from CINE 1 exposure	→ EMC-96
			*CUT			timer (unused)	
	6/13	A-26	*TEA	Out	i	Operation method selection output signal	ЛМ41 → МОТН
1		B-26	*AR1	"	"	<i>"</i>	-ER-96 J8
	5/13	C-26	*TIB	Out	g	Time selection signal for radiographic	→ EMC-96
			(no use)			backup timer (unused)	
}	6/13	A-27	*TEC	Out	i	Operation method selection output signal	ЈМ41 → МОТН
i		B-27	*TEB	"	"	"	-ER-96 J8
l	5/13	C-27	*TIC	Out	g	Time selection signal for radiographic	→ EMC-96
		· 	(no use)			backup timer (unused)	
	6/13	A-28	*TEE	Out	i	Operation method selection output signal	ЈМ41 → МОТН
		B-28	*TED	"	"	"	-ER-96 J8
	5/13	C-28	*TID	Out	g	X-ray cutoff signal from CINE 1 exposure	→ EMC-96
			(no use)			timer (unused)	
1	5/13	A-29	*SP04	Out	i	Spare output signal	Mother-96
ì		B-29	*SP06	"	"	"	
]	5/13	C-29	*TFWD	Out	g	Signal to move top-panel of examination	→ EMC-96
1						bed forward	
	5/13	A-30	*SP05	Out	i	Spare output signal	Mother-96
<u> </u>		B-30	*SP07	"	"	"	
	5/13	C-30	*TREV	Out	g	Signal to move top-panel of examination	→EMC-96
İ						bed backward	
		A-31	GND	In		l ¬	Mother-96
	}	B-31	"	"			
1	1	C-31	"	"		GND input	
1		A-32	GND	In		Same super	
		B-32	"	"			1
		C-32	"	"			

Connector No	Connectio n diagram Page	Pin No	Designation	In / Out	Circuit	Significance	Destination
J7	13/13	A-1	+5V	Out	_		
	1	B-1	"	"	"		
		A-2	"	"	"	+5 V output	
		B-2	"	"	"		
ļ	10/13	A-3	(LOF)			Power-off switch input signal	
Ì		B-3	(PGND)	"	"	Power-on switch GND output signal	
		A-4	(LN12)	"	"	Power-on switch power output signal	
		B-4	(LON)	"	"	Power-on switch input signal	
	10/13	A-5	(*RLIF)*RLIE	In	a		J7
		B-5	(*RL0F)*RL0E	"	"	İ	EXTENSION
]]	A-6	(*RL3F)*RL3E	"	11		_ →
]]]	B-6	(*RL2F)*RL2E	"	"	Towns size of the second bases	<u> </u>
	1 1	A-7	(*RL5F)*RL5E	"	"	Input signal to read keyboard keys	
1		B-7	(*RL4F)*RL4E	"	"		
J7		A-8	(*RL7F)*RL7E	"	"	·	
		B-8	(*RL6F)*RL6E	"	"		
	7/13	A-9	*COM7F	Out	g		→ J7
		B-9	*COM8F	"	"		EXTENSION
		A-10	*COM5F	"	"		
		B-10	*COM6F	"	"	Common output signal to read	
		A-11	*COM3F	"	"	keyboard keys	
		B-11	*COM4F	"	"		
		A-12	*COM1F	"	"		
Ј7	7/12	B-12	*COM2F	0	"		
J /	7/13	A-13 B-13	*DB1F	Out	g ″		→ J7
		A-14	*DB0F *DB3F	"	",		EXTENSION
		B-14	*DB3F	"	,,	Data output for keyboard LED	
		A-15	*DA1F	"	,,	dynamic display	
		B-15	*DAII	"	,,	dynamic display	
		A-16	*DA3F	"	,,		
		B-16	*DA2F	"	"		
	10/13	A-17	*RL1E	In	a		J7
	-	B-17	*RL0E	"	"		EXTENSION
ļ		A-18	*RL3E	"	"		→
		B-18	*RL2E	"	"		
		A-19	*RL5E	"	"	Input signal to read keyboard keys	
		B-19	*RL4E	"	"		
J7		A-20	*RL7E	"	v		
		B-20	*RL6E	"	"		
	7/13	A-21	*COM7E	Out	g		→ J7
		B-21	*COM8E	"	"		EXTENSION
		A-22	*COM5E	"	"		
	-	B-22	*COM6E	"	"	Common output signal to read	
		A-23	*COM3E	"	"	keyboard keys	
		B-23	*COM4E	"	"		
		A-24	*COM1E	"	v		·
		B-24	*COM2E	"	"		

Connector No	Connectio n diagram Page	Pin No	Designation	In / Out	Circuit	Significance	Destination
J 7	9/13	A-25	*DB1E	Out	g		→ 3 7
ļ	i l	B-25	*DB0E	"	"		EXTENSION
ľ		A-26	*DB3E	"	"		
		B-26	*DB2E	"	"	Data output for keyboard LED	
		A-27	*DA1E	"	"	dynamic display	
		B-27	*DA0E	"	"		i
<u> </u>		A-28	*DA3E	"	"		
ļ		B-28	*DA2E	"	"		
l		A-29	GND	In		7	
		B-29	"	"		GND input	
		A-30	"	"		OND input	ļ
		B-30	"	"			

11. PH POWER-96 board

11.1 Outline of functions of PH POWER-96 board

- (1) Photo-timer control in direct spot filming
- (2) High voltage output for photomultiplier in direct spot filming
- (3) Correction of long-time characteristics in direct spot filming
- (4) Correction of short-time characteristics in direct spot filming
- (5) Photo-timer control in I.I. in direct spot filming
- (6) High voltage output for photomultiplier in I.I. indirect spot filming
- (7) IBS control circuit of pulsed fluoroscopy for UD series
- (8) Circuit to correct covering ratio of contrast medium
- (9) Input circuit for the external set value of photomultiplier voltage when an optional I/O CONT-96 board is added.
- (10) High voltage output for photomultiplier for direct radiographic photo-timer (VR is used to adjust the voltage.)

This board controls the high voltage for photo-timer of I.I. light-receiving type and the high voltage for photomultiplier for direct photo-timer.

When an optional I/O CONT-96 board is added, the high voltage for photomultiplier for photo-timer of I.I. light-receiving type can be set from the control console panel.

11.2 Photomultiplier high-voltage setting circuit

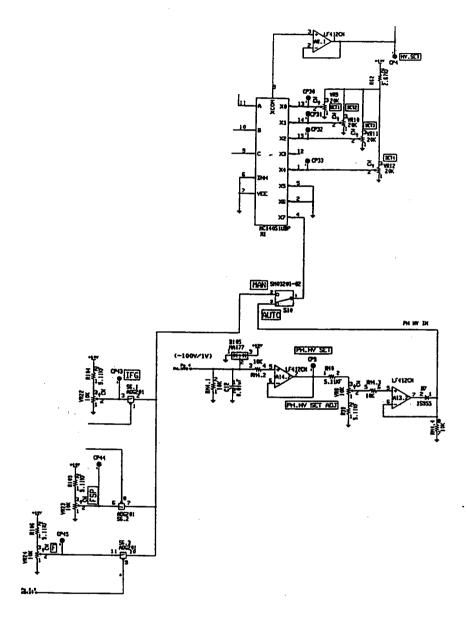


Fig. 11.1

This circuit sets the high-voltage for the photomultiplier of the photo-timer of I.I. light-receiving type.

When S10 is set to AUTO side, the value (PHOTO-S) at the console panel set by the added I/O CONT board is input from pin C5 of edge connector JM 46. This value is output to CP9 PH.HV SET. VR6 PH.HV SET ADJ adjusts the voltage at CP9 PH.HV SET ADJ so that it is related to the high-voltage output (CP17- HV) with a ratio 1 V: -100 V.

Without the optional I/O CONT-96 board, the high-voltage for the photomultiplier of the photo-timer of I.I. light receiving type is adjusted by VR22 $\overline{\text{FSP}}$, VR23 $\overline{\text{IFG}}$, and VR24 $\overline{\text{F}}$ with setting switch S10 to MAN side.

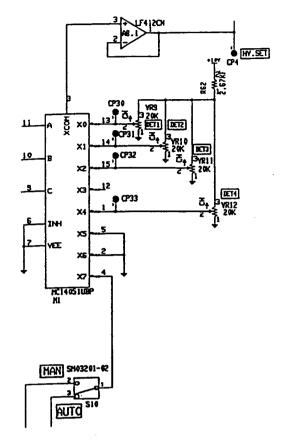


Fig. 11.2

This circuit sets the high voltage for the photomultiplier and adjusts the high voltage for the direct photo-timer.

The outputs of multiplexer M11 are supplied to the high-voltage power supply HV1 through a voltage follower A8-1, and the high voltage for the photomultiplier is output in accordance with the supplied voltage.

The high-voltage of the photomultiplier for each photocell is adjusted by VR9 DET1, VR10 DET2, VR11 DET3, and VR12 DET4 respectively.

11.3 Photomultiplier high-voltage switching circuit

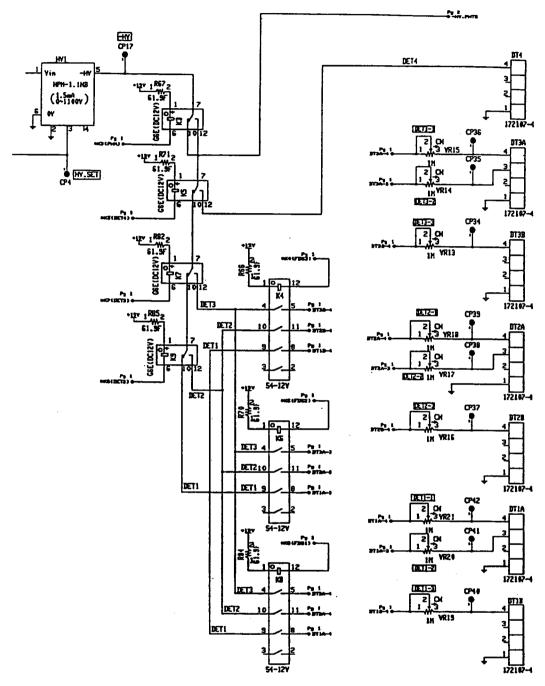


Fig. 11.3

This circuit switches the high-voltages of the photomultipliers for the direct phototimer.

The photomultiplier high-voltage for each photocell DET1, DET2, and DET3 is finely adjusted respectively by

VR13 DET3-1, VR14 DET3-2, VR15 DET3-3,

VR18 DET2-1, VR17 DET2-2, VR16 DET2-2,

VR21 DET1-1, VR20 DET1-2, VR19 DET2-3.

11.4 Photomultiplier high-voltage generating circuit

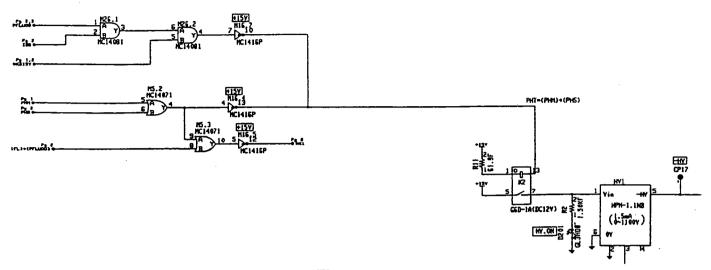


Fig. 11.4

This circuit switches on/off power to the high-voltage supply. When PHOTOMULTI, PHOTO SINGLE, PULSE FLUO., or FLUO. is selected, a relay K2 is turned ON and power is supplied to the high-voltage power supply HV1.

11.5 I.I. photo-input circuit

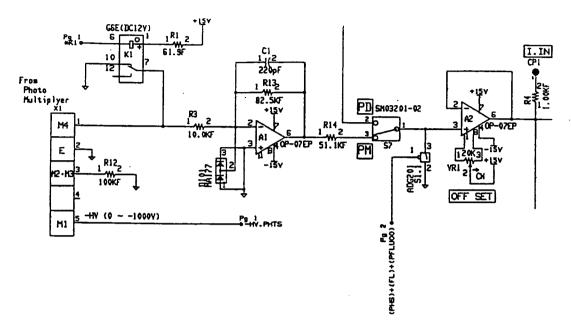


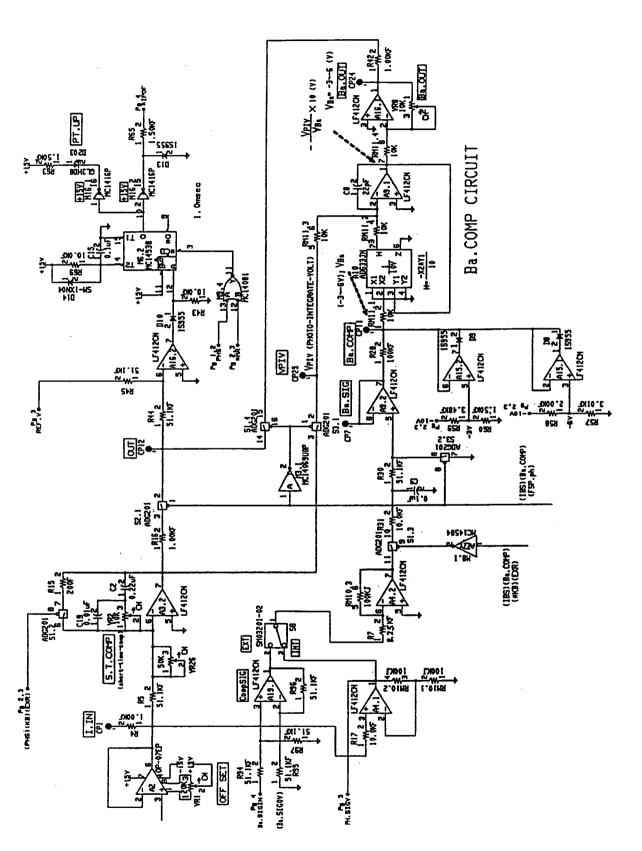
Fig. 11.5

Terminal stage X1 is used to input photo-currents from the photomultipliers. The current input to terminal M4 is subjected to a current-to-voltage conversion.

Switch S7 selects the input signal to PH POWER board from the photomultipliers or from the photocells. Usually the switch is set to PM side.

A2 is a buffer circuit for the input voltage from a differential amplifier or the voltage from the current-to-voltage conversion circuit. VR1 of the amplifier A2 adjust the off-set voltage of the input signal.

The output from this circuit I. IN is input to an integrating circuit to control the phototimer, and to a correction circuit of covering ratios and an automatic control circuit for pulsed fluoroscopy, as well.



11.6 Photo-timer of I.I. light receiving type circuit

The circuit including A3-2, VR2, C19, and C2 is an integrating circuit of the photo-current for the photo-timer control. VR2 is a VR for correcting the short-time characteristics.

An operational amplifier A16-2 compares the integrated value of the photo-current and the reference voltage REF.V. When the integrated value is larger than REF.V, the output of A16-2 becomes H.

A one-shot multivibrator M16-2 outputs the cutoff signal of the photo-timer. At the same time the output of A16-2 is turned to H, a signal IPOF is output and stops inverter operation. This circuit works only when PHS is selected.

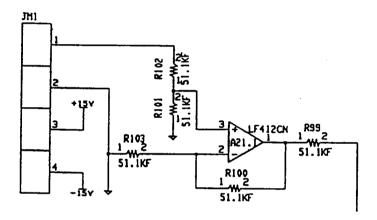


Fig. 11.7

When the photo-timer is controlled by the signal from photocell, the signal is input to JM1 and amplified by a differential amplifier A21-1. This circuit is not used now.

11.7 Circuit to correct covering ratio of contrast medium

When the photo-timer is used in fluoroscopic high-speed operation and the light detection field of the photo-timer is covered by a contrast medium such as Barium, the input current to the photo-timer is decreased to a smaller value than that when the field is not covered.

Then, the operation time is extended in accordance with the covering ratio, and the film density is increased.

The circuit corrects the effect of this phenomenon.

The signal to correct the covering ratio is input from I. IN through a non-converting amplifier A4-1 (123). The signal can be input from external devices through a differential amplifier A19-1.

Switch S8 can switch from internal signals to external signals and vice versa. However, S8 is set to INT side because external signals are not used now.

In fluoroscopic operation, when IBS has reached a stable state, the photomultiplier detects an output light from I.I., and the detected signal is sampled and held at C9. The voltage at C9 is output to CP7 Ba SIG.

The high-voltage of the photomultiplier is adjusted so that the voltage at CP7 is -6.0 V in a stable state of IBS when the covering ratio of contrast medium is 0%. Analog switch S1-3 is ON only when fluoroscopy is ON.

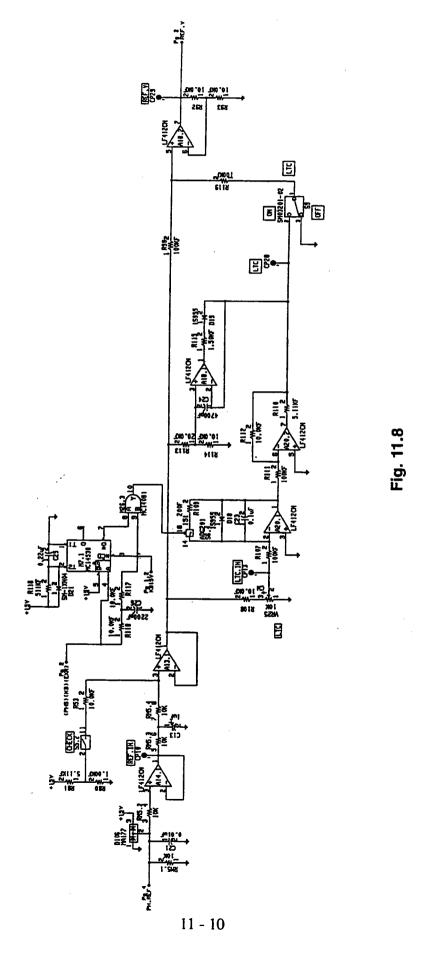
Ideally, the voltage at CP7 should be 0 V when the covering ratio is 100%. However, the operating range is limited to a covering ratio of $0 \sim 50\%$ in this circuit, because the larger the covering ratio, the larger the error of correction. The circuit comprising amplifiers A15-1 and A15-2 limits the signal of the covering ratio inputted to a divider to a range of -6V \sim -3V. Therefore, the voltage at CP11 is controlled in a range of -6V \sim -3V.

The circuit comprising IC's A10 and A9 is a divider. For correction of the covering ratio, the divider adjusts the voltage at pin 1 of A9 through the integrated signal at CP25 VPIV so that the voltage has a relation given by

$$-\frac{VPIV}{Vba} \times 10$$

Finally, with the covering ratio of 100%, VR8 Ba OUT is adjusted so that the film density when the correction circuit is operated becomes same as that when it is not operated.

11.8 Reference voltage circuit and long-time characteristic correction circuit



Reference voltage circuit

PH. REF signal is the comparison reference signal set by CPU for the photo-timer. The signal is input as an analog value from I/O CONT-96 board to edge-connector pin JM46-A5 and output to CP16 REF IN.

Change of the reference voltage, correction of tube voltage, and division correction in accordance with sensitivity of a sensitized film are controlled by CPU.

The voltage at CP10 REF IN is output to CP29 REF V through A13-1 (1)2(3) and A18-2 (5)6(7).

The voltage REF V is the reference which is to be compared to the integrated voltage of the photo-current of the photo-timer.

Circuit to correct the long-time characteristics (to correct reciprocity law failure of film)

This circuit corrects a characteristic that film density is not proportional to the amount of X-ray exposure in long-time radiography.

To compensate a reduced signal due to a lower density of the exposed film, an integrated current proportional to the reference voltage is added to the reference voltage later than 100 msec after the start of X-ray exposure. It corrects the signal so as to be exactly proportional to the amount of X-ray exposure.

ON and OFF of LTC switch S3 determine whether the correction is done or not.

VR25 LTC adjusts the degree of correction of the long-time characteristic. The amount of correction is limited up to one third of an initially set density.

11.9 Pulsed fluoroscopy IBS circuit

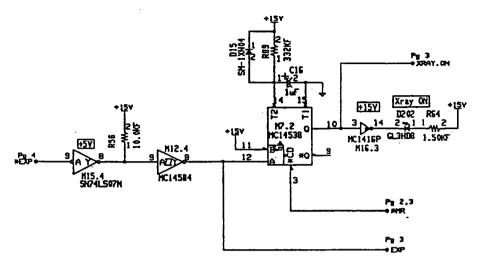


Fig. 11.9

The circuit comprising M7-2 generates a continuous X-RAY ON signal from a real exposure signal EXP of pulsed fluoroscopy. The EXP signal is a pulse signal, which is converted to a continuous signal necessary for continuous controls. The EXP signal with a pulse rate up to 3.75 FPS is converted to a continuous signal by triggering a one-shot multivibrator. (the pulse rate in pulse fluoroscopy is 3.75 FPS ~ 30 FPS.)

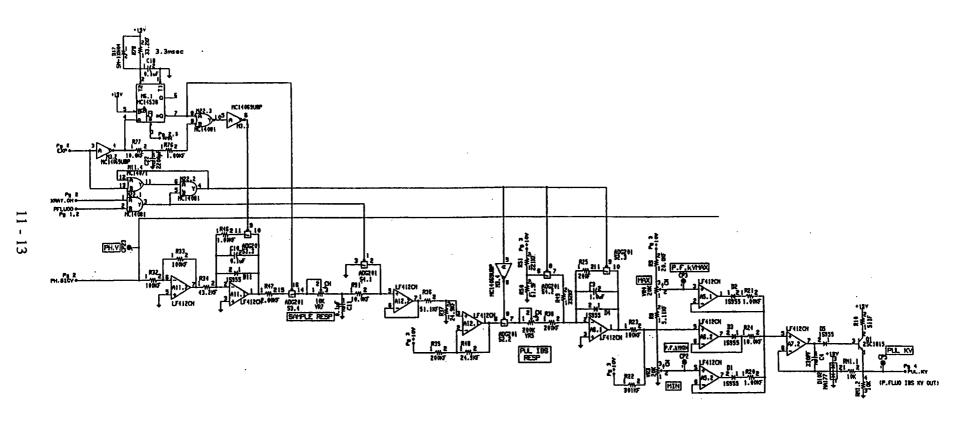


Fig. 11.10

Pulsed fluoroscopy IBS control circuit

This circuit automatically controls (IBS) a tube voltage in pulsed fluoroscopy.

Light generated by I.I. is detected by photomultiplier. The detected photo-current is subjected to a current-to-voltage conversion, and the converted voltage signal PH.V is input to the pulsed fluoroscopy IBS control circuit.

The circuit comprising M6-1, M22-3, and M3-2 generates a timing pulse to peak-hold the signal for 3 msec after an exposure time.

The signal PH. V at CP23 is inverted by A11-2 (123) and integrated for a real exposure time + 3 msec by A11-1 (123).

The integrated value is peak-held for 3 msec after the end of a real exposure pulse by the circuit comprising S3-4 (4) (5) (6), VR7, and C11.

The peak-held voltage is compared to a reference voltage in A12-1 (123) and the derived difference signal controls IBS by a circuit of VR5, R38, and A6-1 (123).

VR4 MAX and VR3 MIN set a maximum and minimum tube voltage in pulse fluoroscopic IBS, respectively.

The IBS-controlled output voltage at CP5 PUL KV is input to ANOLOG-96 board through an edge connector.

The relation between the voltage $\boxed{\text{PUL KV}}$ and the pulsed fluoroscopic tube output voltage is given by 1 V = 20 KV.

12. PH CONT-96 board

12.1 Outline of PH CONT-96 board

(1) Signal input circuit for direct photo-timer

Number of connectable photo-receptors

3 pickups \times 3 photo-receptors

1 pickup \times 1 photo-receptors

- (2) Photomultipliers and semiconductor photo-receptors (Tweem, Comet, etc.) are connectable.
- (3) AND circuit and average value circuit (for semiconductor photo-receptors) are switchable.
- (4) Short-time characteristic correction circuit (by CR circuit)
- (5) Long-time characteristic correction circuit (adjusted by VR in accordance with set value of REF. V)

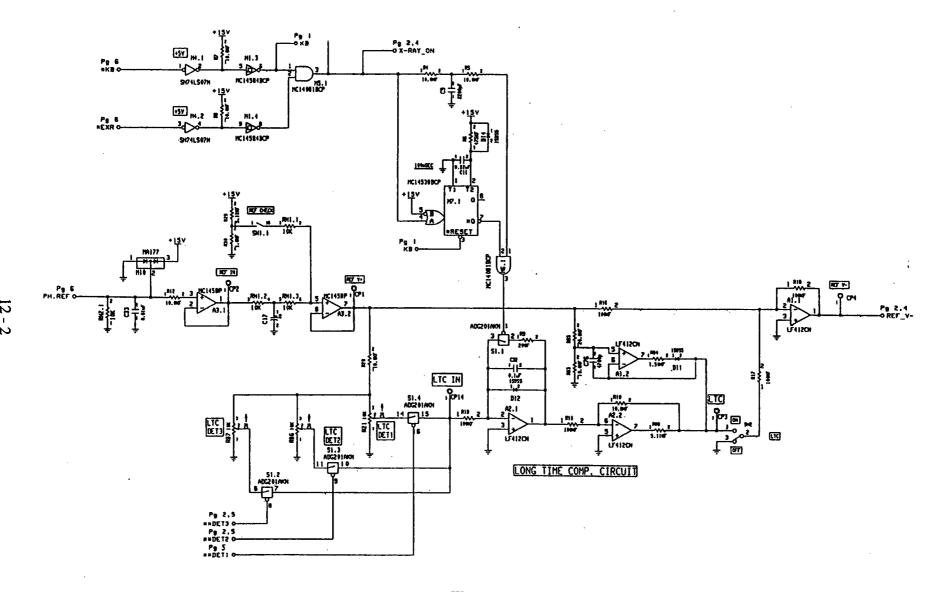


Fig. 12.1

12.2 Reference voltage circuit

PH. REF signal is the comparison reference signal set by CPU for the photo-timer. The signal is output as an analog value from I/O CONT-96 board to edge-connector pin JM45-A5 and output to CP REF IN.

Change of the reference voltage, correction of tube voltage, and division correction in accordance with sensitivity of a sensitized film are controlled by CPU.

The voltage at CP2 REF IN is output to CP4 REF V- through A3-2 (1)23) and A1-1 (1)23).

The voltage REF V- is the reference which is to be compared to the integrated voltage of the photo-current of the photo-timer.

12.3 Circuit to correct the long-time characteristics (to correct reciprocity law failure of film)

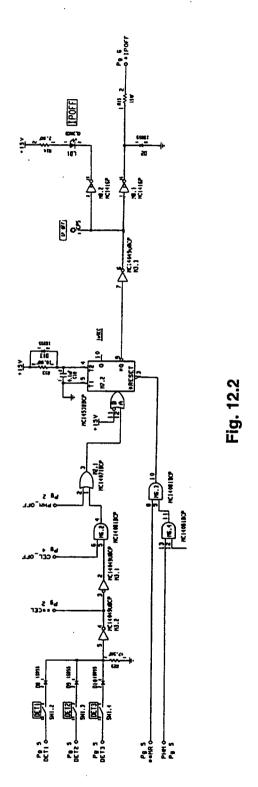
This circuit corrects a characteristic that film density is not proportional to the amount of X-ray exposure in long-time radiography.

To compensate a reduced signal due to a lower density of the exposed film, an integrated current proportional to the reference voltage is added to the reference voltage later than 100 msec after the start of X-ray exposure. It corrects the signal so as to be exactly proportional to the amount of X-ray exposure.

ON and OFF of LTC switch S2 determine whether the correction is done or not.

R21 LTC DET 1, R86 LTC DET 2, and R87 LTC DET 3 adjust the degree of correction of the long-time characteristic of each photo-receptor. The degree of correction is limited up to one third of an initially set density.

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This circuit receives signals from the comparison circuits and outputs X-ray cutoff signal IP. OFF.

SW1.2 DET 1, SW1.3 DET 2, and SW1.4 DET 3 select to control each photo-receptor signal by an average value circuit or by an OR circuit.

Usually, the switches are OFF because the OR circuit is used.

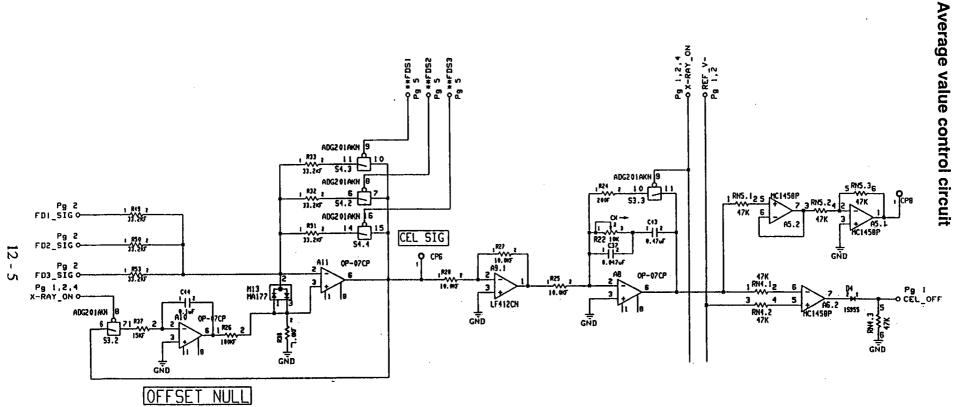


Fig. 12.3

Average value control circuit

The outputs from light-receiving fields are converted from currents to voltages and input to this circuit as signals FC1_SIG, FD2_SIG, and FD3_SIG.

The gain of an amplifier A11 is switched in accordance with a selected light-receiving field, and the output of A11 is reduced to an average value of the three signals at CP6 CEL SIG.

An integrating circuit of A8 integrates the average output voltage, and the integrated value is compared to REF V- by A6-2 (567) and outputs OFF signals.

A circuit comprising A10, C44, and S3-2 (678) is OFFSET NULL circuit and automatically cancels the offset voltage of A11.

12 - 7

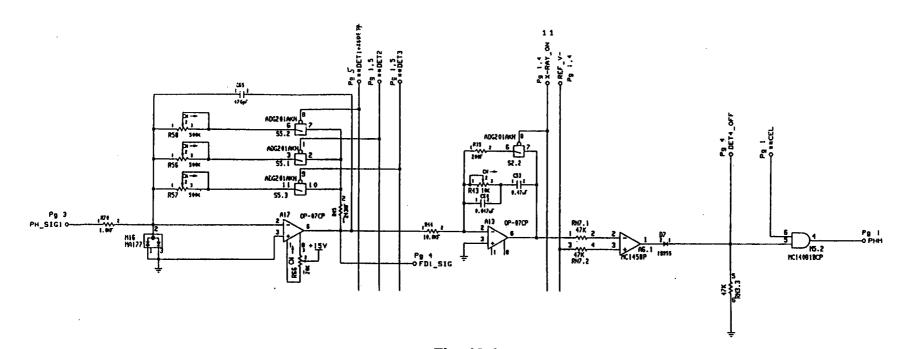


Fig. 12.4

PH_SIG1 is a photo-current input from the first light-receiving field of the photo-timer.

A circuit comprising R45, R56, R57, R58, and A17 is a current-to-voltage conversion circuit. R56, R57, and R58 are variable resistors to adjust gains for each light-receiving field when photo-receptors of foreign manufacturers are assembled.

When a photo-timer of photomultiplier type is used, the variable resistors are extremely turned counterclockwise, because the photomultiplier high-voltage generating circuit adjusts the GAIN of each light-receiving field.

A13 is an integrating circuit which integrates the signal converted from current to voltage by A17.

R43 is a variable resistor to correct a short-time characteristic. Turning it clockwise reduces the cutoff time, correcting a delay in cutoff of the system.

The output voltage integrated by A13 is compared to the reference voltage by A6-1 (123) and outputs OFF signal.

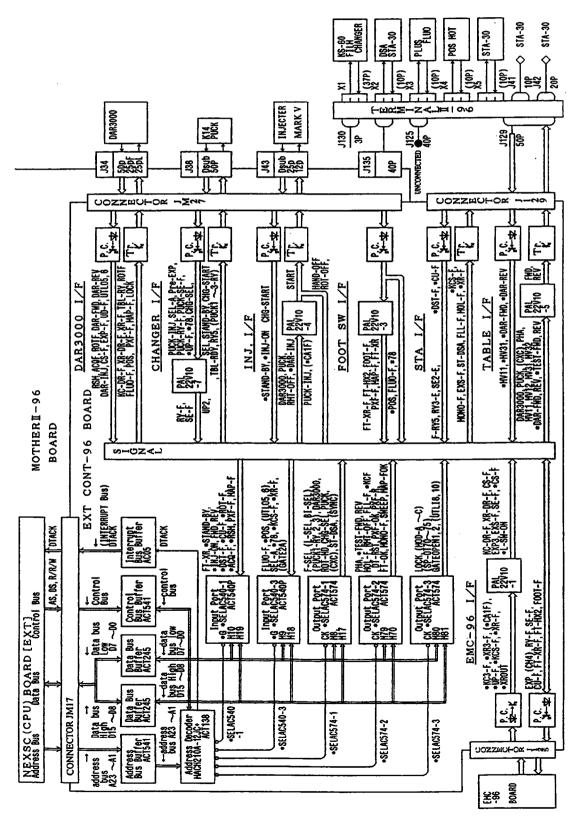
This OFF signal is invalid when the average value control is set.

The second to fourth light-receiving fields work in the same way as the first one.

13. EXT CONT-96 board

13.1 Schematic block diagram of EXT CONT-96 board

The block diagram includes NEXSC (CPU) BOARD [EXT], PAL (22V10), INPUT-IC (ACT540), OUTPUT-IC (ACT574), and connectors and data buses, etc.



13.2 EXT CONT-96 board LED display

[1] List of LED displays

LED displays of EXT CONT-96 board are listed below.

LED No.	Color	Connection diagram Page	Connector Pin No	Signal	Significance	Destination
LD1	RED	3/5	J125 B- 9	*XRIN	X-RAY real exposure input signal	
LD2	"	3/5	" B-11	*KCS2	Radiography preparation signal input	→STA-30
					to STA-30 device (KC input signal)	
LD3	"	3/5	″ B-13	*EPS2	X-ray radiation signal input to	→STA-30
					STA-30 device (EXR input signal)	
LD4	11	3/5		*SMALL	Small focus selection signal input to	→STA-30
			_		STA-30 device (SM input signal) (unused)	
LD5	GREEN	3/5	″ B-4	*EXP1	- X-RAY OK signal output from	
			″ A-5	*EXP2	DSA device	
LD6.	"	3/5	″ A-17	*CM4	CINE camera exposure signal (unused)	
			″ B-17	0V	0 V for CM4 (unused)	
LD7	"	3/5	″ A-11	*RY3	READY operation signal output	PUCK→
					from film-changer device	
LD8	"	3/5	″ A-13	*SE2	X-RAY operation signal output	PUCK→
•					from film-changer device	
LD9	RED	3/5	" B-12	*UP2	READY UP signal input to	→PUCK
					film-changer device	
LD10	"	3/5	″ B-15	*CA2	X-RAY ON signal input to	→ CINE
					CINE camera device	
LD11	'n	3/5	″ A-9	*XROB	X-RAY ON input signal	
LD12	".	3/5	″ A-15	*KCB	Radiography preparation input	TERMINAL I
					signal (KC input signal)	
LD13	GREEN	5/5	J129 A-22	*FLL	Sub-focus fluoroscopy selection	→STA-30
					signal output to STA-30 device	
LD14	"	5/5	″ B-22	*MOL	Sub-focus selection signal output	→STA-30
					to STA-30 device (in adjustment)	
LD15	"	5/5	″ B-20	EXS-1F	X-RAY ON signal output to STA-30 device	→STA-30
LD16	"	5/5	" B-18	*EIN	Stereo DSA selection signal output to	→STA-30
					STA-30 device (ST-DSA output signal)	
LD17	"	3/5	J125 A-12	CU2	Acknowledge signal of heating	→EMC-96
					from STA-30 device	
LD18	"	3/5	″ B-5	*AR2I	READY operation second output signal	→EMC-96
LD19	"	3/5	″ A-6	*HX2I	X-RAY operation second output signal	→EMC-96
LD20	"	3/5	″ A-18	FOOT2	Foot-switch output signal	EMC-96
LD21	"	3/5	JM27 A- 5	*KCF	Hand-switch ON status	→DAR3000
LD22	"	"	″ B-5	*XRF	X-RAY switch ON status	→DAR3000
LD23	"	"	″ B-8	*CKTB	Bed move finish status	→DAR3000

LD33	LED No.	Color	Connection diagram Page	Connector Pin No	Signal	Significance	Destination
LD26	LD24	GREEN	3/5	JM27 C- 5	*SOKF	- 1	
LD27	LD25	RED	3/5	JM27 C- 1	*EXPF	X-ray exposure command	DAR3000 →
LD28	LD26	"	3/5	" A- 2	*VDF	VD command for CINE camera	"
LD29 GREEN S/5 J129 B-19 *MON Monaural radiography selection signal output to STA-30 device	LD27	"	3/5	″ B-4	*UTL052F	Spare input signal	"
LD30	LD28	"	3/5	″ C-4	*UTL062F	Spare input signal	"
LD30	LD29	GREEN	5/5	J129 B-19	*MON	Monaural radiography selection	→STA-30
LD32						signal output to STA-30 device	
LD32	LD30	"	3/5	″ A-18	*ROT	Mechanism rotation command	→MH
LD31						output from DSA device	
LD31	LD32	"	"	JM27 A- 6	*FLUOF	Fluoroscopy ON status	→DAR3000
LD33		"	"	JM27 C- 7	*PREEXPF	Television blanking command	→DAR3000
LD33						before exposure	
LD34	LD33	<u>"</u>	"	″ A-8	*POOTSWONF		"
LD35		"	"				"
LD36 RED 3/5		"	"				"
LD37	-	RED	3/5				DAR3000 →
LD38							"
LD39	-	·	3/5				DAR3000→
LD40 GREEN 5/5 J129 B-13 EPS02-F X-ray radiation signal output to STA-30 STA-30 STA-30 device (XR output signal)		"			*CSF		"
STA-30 device (XR output signal)	 	GREEN	5/5		ļ <u>.</u>		→STA-30
LD41		O.C.D.]			•	
LD42	T D41		5/5	// R-11	*KCS		→STA-30
LD42	LD41] 5/15			* • • •	
LD42	I DA2		"	// R- 8	M34-F		→ TERMINAL
LD43 " " A-8 M36-E Top-panel backward-move signal to drive TERMINAL2-96 board relay II -96 LD44 " 3/5 " B-3 *KC14 Radiographic preparation output signal II -96 LD45 " 3/5 " A-4 *KC14 Radiographic X-RAY output signal II -96 LD46 " 5/5 " B-23 *UNSHI2 RSM-DSA selection output signal II -96 LD47 " 3/5 JM27 C-6 *PULFLUOF Pulse fluoroscopy ON status → DAR3000 Status II -96 LD48 " 3/5 JM27 A-7 *ROT-POS Mechanism position confirmation → DAR3000 Status in rotary DSA	LD42			D -0	1,13-12		
drive TERMINAL2-96 board relay II -96	I DA3	"	"	// A-8	M36-E		→ TERMINAL
LD44 " 3/5 " B- 3 *KC14 Radiographic preparation output signal [DSA device] (KC output signal) →TERMINA II -96 LD45 " 3/5 " A- 4 *KC14 Radiographic X-RAY output signal [DSA device] (KC output signal) →TERMINA II -96 LD46 " 5/5 " B-23 *UNSHI2 A-23 RSM-DSA selection output signal II -96 LD47 " 3/5 JM27 C- 6 *PUL-FLUOF Pulse fluoroscopy ON status →DAR3000 DAR3000 DAR3000 DAR3000 Status LD48 " 3/5 JM27 A- 7 *ROT-POS Mechanism position confirmation status in rotary DSA	LD43		İ		1.250 2	• •	
[DSA device] (KC output signal)	I D44	"	3/5	// R- 3	*KC14		→TERMINAL
LD45 " 3/5 " A-4 *KC14 Radiographic X-RAY output signal →TERMINA [DSA device] (KC output signal) II -96 LD46 " 5/5 " B-23 *UNSHI2 RSM-DSA selection output signal →TERMINA II -96 LD47 " 3/5 JM27 C-6 *PUL-FLUOF Pulse fluoroscopy ON status →DAR3000 LD48 " 3/5 WTL18 Spare output signal DAR3000 Status in rotary DSA	ויייטט		3/3			0	
IDSA device] (KC output signal) II -96	I D45	"	3/5	" A-4	*KC14		→ TERMINAL
LD46 " 5/5 " B-23 *UNSHI2 RSM-DSA selection output signal → TERMINA II -96 LD47 " 3/5 JM27 C-6 *PUL-FLUOF Pulse fluoroscopy ON status → DAR3000 LD48 " 3/5 — *UTLI8 Spare output signal LD49 " 3/5 JM27 A-7 *ROT-POS Mechanism position confirmation → DAR3000 status in rotary DSA			3/3	1	nor-	·	
A-23	I D46	,,	5/5	// R-23	*IINSHI2		
LD47 " 3/5 JM27 C- 6 *PULFLUOF Pulse fluoroscopy ON status →DAR3000 LD48 " 3/5 — *UTLI8 Spare output signal LD49 " 3/5 JM27 A- 7 *ROT-POS Mechanism position confirmation status in rotary DSA	LD40	,	3/3				
LD48 " 3/5 — *UTLI8 Spare output signal LD49 " 3/5 JM27 A- 7 *ROT-POS Mechanism position confirmation → DAR3000 status in rotary DSA	I D47	"	2/5		 		
LD49 " 3/5 JM27 A-7 *ROT-POS Mechanism position confirmation → DAR3000 status in rotary DSA			 	JIV127 C- 0			2711.3000
status in rotary DSA			ļ	IM27 A- 7			→DAR3000
	وجريا),,,	JANE / PAT /	101105	_	
LD50 " 3/5 - *UTLI10 Spare output signal	LD50	"	3/5		*[][] 110		
			 	JM27 C- 2	 		DAR3000→

LED No.	Color	Connection diagram Page	Connector Pin No	Signal	Significance	Destination
LD52	RED	3/5	JM27 B- 3	*ACQF	Active in assembly	DAR3000→
					(for VTR remote operation)	
LD53	"	"	" B-2	*ROTATEF	Mechanism rotation command (F side)	"
LD54	"	"	_	*ROTATEL	Mechanism rotation command (L side)	"
					(unused)	
LD55	GREEN	4/5	JM27 C-23	TBL-RY2	Table READY signal output to PUCK	→PUCK
LD56	"	"	" C-21	UP2	READY UP signal output to PUCK device	→PUCK
LD57	"	"	″ A-24	PUCK1-RY2	(Unused)	"
LD58	"	"	" B-22	SEL-OKA2	X-ray controller selection	"
					acknowledge signal to PUCK device	
LD59	"	"	" B-24	PUCK2-RY2	(Unused)	"
LD60	"	"	″ A-23	INJ-RY2	Injector READY signal to PUCK	→PUCK
LD61	"	"	" C-24	PUCK3-RY2	(Unused)	"
LD62	"	"	″ B-23	START2	START signal from injector to	→J38
					PUCK	→PUCK
LD63	RED	4/5	J129 A-13	SE2-E	X-ray operation signal input from	PUCK等→
					film changer device	
LD64	RED	4/5	J129 A-11	RY3-E	READY operation signal input	"
. [from film changer device	
LD65	RED	4/5	J129 B-10	F-RY5	READY operation signal input	TERMINAL
					from film changer device	II -96→
LD66	RED	5/5	JM27 B-11	POS2	Mechanism position confirmation	TERMINAL
					status	Ⅱ -96→
LD67	RED	4/5	J129 B- 9	MAP-F2	Foot-switch for MAP ON input signal	"
LD68	"	"	″ A-9	PXF-F2	Pulse radiography ON input signal	"
LD69	RED	5/5	ЛМ27 A-10	FT-XR2	Foot-switch for radiography ON status	"
LD70	"	4/5	J129 A-12	CU2-E	Acknowledge signal of heating	STA-30→
					from STA-30 device	
LD71	"	"	J129 A-21	DST2-F	Stereo acknowledge signal input	STA-30→
				ļ	from STA-30 device	
LD72	11	"	JM27 C-20	CH-EXP2	X-ray exposure request signal input	PUCK →
					to X-ray controller from PUCK device	
LD73	"	4/5	JM27B-20	START-2	READY request signal input to	PUCK→
					X-ray controller from PUCK device	
LD74	GREEN	5/5	JM27 A-28	HAND-OFF2	Output signal to select invalid	,
		<u> </u>	B-28	HAND-OFF1	injector hand-switch (unused)	
LD75	"	5/5	JM27 C-28	RMT-OFF2	Output signal to select invalid	
		_			injector remote control (unused)	
LD76	RED	"	J129 B-7	MV3-E	Signal to move top-panel of examination bed	
					backward (output from film-changer device)	
LD77	"	"	J129 A- 7	MV1-E	Signal to move top-panel of examination bed	
					forward (output from film-changer device)	<u></u>

LED No.	Color	Connection diagram Page	Connector Pin No	Signal	Significance	Destination
LD78	RED	5/5	JM27 B-25	MV3-P	Signal to move top-panel of examination bed backward (output from PUCK device)	PUCK→
LD79	RED	"	JM27 A-25	MV1-P	Signal to move top-panel of examination bed forward (output from PUCK device)	PUCK→
LD80	RED	5/5	JM27 C-29	XR-ST2	Changer start signal from injector	INJ→
LD81	RED	5/5	JM27 B-27	INJ-CN2	Signal during injection from injector	INJ→
LD82	RED	5/5	JM27 C-27	STAND-BY2	Standby signal from injector	INJ→
LD83	RED	4/5	JM27 C-25	PRE-F2	Advanced X-ray exposure request signal input from PUCK device	PUCK→
LD84	"	"	JM27 C-19	SELA2	X-ray controller selection signal from PUCK device (F)	PUCK→
LD85	"	"	JM27 B-19	INJ2	Injector start signal from PUCK device	PUCK→
LD86	GREEN	5/5	JM27 A-29 B-29	INJ-ST2 INJ-ST1	Start signal to injector	→INJ

13.3 Input/output signals of EXT CONT-96 board

[1] Table of input/output signals

Input/output signals of EXT CONT-96 board are as follows.

Refer to "[2] Input/output circuit" for circuit mark $k \sim p$, and refer to "7.31 Input/output signals of EMC-96 board, [2] Input/output circuit" for mark $a \sim j$.

't' indicates that connectors J125 and J129 are only connected and there is no circuit between them.

Connector No	Connectio n diagram Page	Pin No	Designation	In / Out	Circuit	Significance	Destination
JM17	1/5	A- 1	+5VM	In			Mother II -96
		B- 1	"	"			
1		C - 1	"	"			
i		A- 2	+5VM	In		+5 V input	
		B- 2	"	"			
		C- 2	"	"			
	1/5	A- 3	+15VM	In			1
1		B- 3	"	"		+15 V input	
		C- 3	"	"			
	1/5	A- 4	+12Vin	In			
.		B- 4	. "	"		+12 V input	
	·	C- 4	"	"			
	1/5	A- 5	+24Vin	In			
] [B- 5	"	"		+24 V input	
]		C- 5	"	"	•		
		A- 6	(no use)				
ŀ		B- 6	"	"			
		C- 6	"	"			
	1/5	A- 7	OUT0B	_		(no use)	
1		B- 7	OUTIB	"		"	
		C- 7	OUT2B	"		"	
		A- 8	OUT3B	"		"	
		B- 8	IN0A	"		"	
		C- 8	IN1A	"		"	
,		A- 9	IN2A	"		"	
		B- 9	IN3A	"		"	
]		C- 9	IN4A	"		"	
		A-10	IN5A	"		"	
		B-10	IN6A	"		"	
		C-10	IN7A	"	İ	"	
		A-11	(no use)	-			
		B-11	"	"			
		C-11	"	"			
		A-12	"	"		·	
<u> </u>		B-12	"	"			.
		C-12	"	"			
]]		A-13	"	"			

	Connector	Connectio n diagram Page	Pin No	Designation	In / Out	Circuit		Significance	Destination
1						Ü			
١	JM17	2/5	B-13	O-GATE	In	a			NEXSC (EXT)
١			C-13	OUT-FC2	"	"			
1			A-14	OUT-FC1	"	"			
1			B-14	OUT-FC0	"	"		Control Signal	
۱			C-14	OUT-*AS	"	"			
ı			A-15	OUT-*LDS	"	"			
ı			B-15	OUT-*UDS	"	"	1		
١		ĺ	C-15	OUT-R/*W	"	"		•	
			A-16	*O-DTACK		g	<u> </u>		
١		2/5	B-16	OD [15]	In	a			NEXSC (EXT)
			C-16	<i>"</i> [14]	"	"			
١			A-17	<i>"</i> [13]	"	"			
			B-17	" [12]	"	"		j	
			C-17	<i>"</i> [11]	"	"			
1			A-18	<i>"</i> [10]	"	"			
			B-18	<i>"</i> [9]	"	"			
			C-18	<i>"</i> [8]	"	"	İ		
١			A-19	<i>"</i> [7]	"	"	I	Data Bus	
l			B-19	<i>"</i> [6]	"	"			
۱			C-19	<i>"</i> [5]	"	"			
١			A-20	<i>"</i> [4]	"	"			
			B-20	<i>"</i> [3]	"	"			
		İ	C-20	<i>"</i> [2]	"	"			
			A-21	" [1]	"	"			
١		215	B-21	<i>"</i> [0]	"	"			
		2/5	C-21	OA [23]	In	а		i	NEXSC (EXT)
ĺ			A-22 B-22	[22][21]	"	"		·	
			C-22	" [21] " [20]	",	"			
ļ	•		A-23	" [20] " [19]	"	",			
l		l	B-23	" [18]	"	,,	j		
ı			C-23	" [17]	"	"			
l			A-24	" [16]	"	"			
l			B-24	" [15]	"	"			
ı			C-24	» [14]	"	"			
ŀ		ļ	A-25	" [13]	,,	"		·	:
l		ł	B-25	" [12]	,,	"			
			C-25	" [11]	"	"	A	dressBus	
ı	İ	ļ	A-26	<i>"</i> [10]	"	"			
١		.	B-26	" [9]	"	"	İ		
	ĺ		C-26	<i>"</i> [8]	"	"			
			A-27	<i>"</i> [7]	"	"			
			B-27	<i>"</i> [6]	"	"			
			C-27	~ [5]	"	"			
			A-28	<i>"</i> [4]	"	"			İ
			B-28	<i>"</i> [3]	"	"			l
			C-28	<i>"</i> [2]	"	"			
L			A-29	" [1]	"	″			

Connector	Connectio n diagram Page	Pin No	Designation	In / Out	Circuit	Significance	Destination
1	2/5	B-29	*O-RESET	In	a		NEXSC (EXT)
ļ		C-29	O-CLK12	"	"		,,
		A-30	(no use)				
		B-30	"	"			
		C-30	"	"			
j i	1/5	A-31	GND	In			Mother II -96
] ,	-	B-31	"	"			
	•	C-31	"	"			
	i	A-32	GND	In		GND input	
	ĺ	B-32	"	"	ļ		1
		C-32	` //	"			

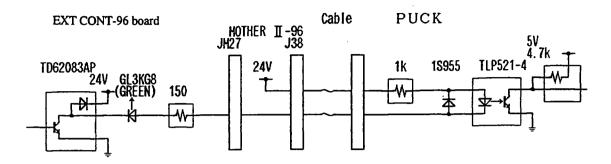
Connector No	Connectio n diagram Page	Pin No	LED No.	Designation	In / Out	Circuit	Significance	Destination
JM27	3/5	A- 1	LD38	*INJ	In	k	Injector START command	DAR3000
		B- 1	LD39	*CSF	"	"	CINE camera START command	→ Cable
]		C- 1	LD25	*EXPF	"	"	X-ray exposure command	→Mother
i		A- 2	LD26	*VDF	"	"	VD command for CINE camera	II -96
		B- 2	LD53	*ROTATEF	"	"	Mechanism rotation command	J34
		C- 2	LD51	*RSMR	"	"	I.I. defocus command in RSM-DSA	→JM27
]		A- 3						
		B- 3	LD52	*ACQF	In	k	Active in assembly	
1	i	,					(for VTR remote control)	
		C- 3	LD36	*FWD	"	"	Bed forward-move command	•
		A- 4	LD37	*BWD	"	"	Bed backward-move command	
]		B- 4	LD27	*UTL052F	"	"	Spare input signal	
]		C- 4	LD28	*UTL062F	"	"	"	
[3/5	A- 5	LD21	*KC-F	Out	m	Hand-switch ON status	→JM27
f		B- 5	LD22	*XRF	"	"	X-RAY switch ON status	→ Mother
		C- 5	LD24	*SOKF	"	"	CINE camera synchronization OK status	II -96
		A- 6	LD32	*FLUOF	"	"	Fluoroscopy ON status	J34
		B- 6	LD34	*LOCK	"	"	X-ray radiographic condition lock OK status	→Cable
,		C-6	LD47	*PUL-FLUOF	"	"	Pulsed fluoroscopy ON status	
]		A- 7	LD49	*ROT-POS	"	"	Mechanism position confirmation	DAR3000
	ĺ	** /	2043	MO1-1 00			status in rotary DSA	DAKSOOO
	1	B- 7	LD35	*MAPF	"	"	Foot-switch for MAP ON status	
	1	C-7	LD31	*PREEXPF	"	"	Television blanking command	
							before exposure	
	ļ	A- 8	LD33	*FOOTSWONE	"	"	Foot-switch for fluoroscopy ON status	
		B- 8	LD23	*CKTB	"	"	Bed move finish status	
		C- 8		(no use)		_		
		A- 9	"	"	"	"	l	
	į	B- 9	"	"	"	"	·	
		C-9	"	"	"	"		
	5/5	A-10	LD69	FT-XR2	In	1	Foot-switch for radiography ON status	
[[B-10		(no use)	_	_		
		C-10	"	"	"	"		
		A-11	"	"	"	"		
	5/5	B-11	LD66	POS2	In	1	Mechanism position confirmation status	TERMINAL II -96→
	ł	C-11	-	TRY-I	l		ļ	-
Ī		A-12		(no use)	_	=	***	
]	B-12	"	"	"	"	Ì	
	-	C-12	"	"	"	"		
ĺ		A-13	"	"	"	"		
1	}	B-13	"	"	"	"	Į	l
l l		C-13	"	"	"	"	}	·
}	J	A-14	"	"	"	"	j	
		B-14	"	"	"	"		ĺ
		C-14	"	"	"	"		

Connector	Connectio n diagram Page	Pin No	LED No.	Designation	In / Out	Circuit	Significance	Destination
JM27		A-26	_	(no use)	—	-		
		B-26	"	"	"	"		
		C-26	"	"	"	"		
ļ		A-27		"	_			
į	5/5	B-27	LD81	INJ-CN2	In	ь	Signal during injection from injector	INJ→
į	'	C-27	LD82	STAND-BY2	"	"	Standby signal from injector	
l	5/5	A-28	LD74	HAND-OFF2	Out	р	Output signal to select invalid	→INI
		B-28		HAND-OFF1	"	"	injector hand-switch (unused)	
ł		C-28	LD75	RMT-OFF2	Out	"	Output signal to select invalid	→INJ
							injector remote control (unused)	
		A-29	LD86	INJ-ST2	Out	P	Start signal to injector	→INl
		B-29		INJ-ST1	"	"		
1		C-29	LD80	XR-ST2	In	ь	Changer start signal from injector	INJ→
		A-30	—	(no use)		—		
1		B-30	"	"	"	"		
		C-30	"	"	"	"		
	ļ	A-31	_	GND	In			
		B-31	"	"	"	"		
		C-31	"	"	"	"	GND input	
		A-32	"	"	"	"	or to imput	
		B-32	"	"	"	"		
		C-32	"	"	"	"		-

Connector	Connectio n diagram Page	Pin No	LED No.	Designation	In / Out	Circuit	Significance	Destination
J125	3/5	B-15	LD10	*CA2	In	1	X-RAY ON input signal to CINE camera device	→CINE
	1/5	A-16	<u> </u>	*XR8	"	t	"	"
		B-16		(no use)	_			
	3/5	A-17	LD6	*CM4	Out	n	CINE camera exposure signal (unused)	
		B-17		0V	"	"	0 V for CM4 (unused)	
		A-18	LD20	FOOT2	Out	n	Foot-switch output signal	EMC-96
		B-18		(no use)				
		A-19		GND	In			
		B-19		"	"		GND input	
		A-20		"	"			i
		B-20		"	"			

Connector	Connectio n diagram Page	Pin No	LED No.	Designation	In / Out	Circuit	Significance	Destination
J129	1/5	A-16		*XR8	Out	t	X-RAY ON output signal to CINE	→CINE
							camera device	
		B-16	"	*XR10		"	"	
		A-17	_	(no use)	-			
		B-17	"	"	"			
	3/5	A-18	LD30	*ROT	Out	m	Mechanism rotation command	→MH
							output from DSA device	
	5/5	B-18	LD16	*EIN	Out	m	Stereo DSA selection signal output to	→STA-30
							STA-30 device (ST-DSA output signal)	
	1/5	A-19	<u> </u>	(*RMT)			(Unused)	→STA-30
	5/5	B-19	LD29	*MON	Out	m	Monaural radiography selection	→STA-30
							signal output to STA-30 device	
		A-20	_	EXS-2F	Out	m	X-RAY ON signal output to	→STA-30
						'	STA-30 device	
		B-20	LD15	EXS-1F	"	"		
	4/5	A-21	LD71	DST2-F	In	1	Stereo acknowledge signal input	STA-30→
		D 01		(CITOE)			from STA-30 device	0774 00
		B-21		(CU2F)	_		(Unused)	STA-30→
	5/5	A-22	LD13	*FLL	Out	m	Sub-focus fluoroscopy selection signal output to STA-30 device	→STA-30
		B-22	LD14	*MOL	"	"	Sub-focus fluoroscopy selection	→STA-30
							signal output to STA-30 device	
				T 7 7 7 7 7 1		ļ	(in adjustment)	
		A-23		UNSH1	Out	m	RSM-DSA selection output signal	
		B-23	LD46	UNSH2	0	"	<u> </u>	
		A-24		GND	Out			→
	ļ	B-24		"	"		GND output	TERMINAL II -96
	İ	A-25		"	"			и-90
<u> </u>		B-25	L	"	"			

(o) Output circuit [No. 7] {transistor to current-loop (24 V) drive output circuit}



(p) Output circuit [No. 8] {PHOTO-MOS relay drive output circuit}

